

# MKW36A/35A/34A Data Sheet

An ultra low power, highly integrated Bluetooth® Low Energy 5.0 wireless microcontroller

**MKW36A512VHT4**  
**MKW36A512VFP4**  
**MKW36A512VFT4**  
**MKW35A512VFP4**  
**MKW35A512VFT4**  
**MKW34A512VFT4**



48 LQFN  
7x7 mm Pitch 0.5 mm



48 "Wettable" HVQFN  
7x7 mm Pitch 0.5 mm



40 "Wettable" HVQFN  
6x6 mm Pitch 0.5 mm

## Multi-Standard Radio

- 2.4 GHz Bluetooth Low Energy (Bluetooth LE) version 5.0 compliant supporting up to 8 simultaneous hardware connections
- Generic FSK modulation
  - Data Rate: 250, 500 and 1000 kbps
  - Modulations: GFSK BT = 0.3, 0.5, and 0.7; FSK/MSK
  - Modulation Index: 0.32, 0.5, 0.7, and 1.0
- Typical Receiver Sensitivity (Bluetooth LE 1 Mbps) = -95 dBm
- Typical Receiver Sensitivity (250 kbps GFSK-BT=0.5, h=0.5) = -99 dBm
- Programmable Transmitter Output Power: -30 dBm to 5 dBm
- Low external component counts for low cost application
- On-chip balun with single ended bidirectional RF port

## MCU and Memories

- 256 KB program flash memory plus 256 KB FlexNVM on KW36A/34A
- 8 KB FlexRAM supporting EEPROM emulation on KW36A/34A
- 512 KB program flash memory on KW35A
- Up to 48 MHz Arm® Cortex®-M0+ core
- On-chip 64 KB SRAM

## System peripherals

- Nine MCU low-power modes to provide power optimization based on application requirements
- DC-DC Converter supporting Buck and Bypass operating modes
- Direct memory access (DMA) Controller
- Computer operating properly (COP) watchdog
- Serial wire debug (SWD) Interface and Micro Trace buffer
- Bit Manipulation Engine (BME)

## Analog Modules

- 16-bit Analog-to-Digital Converter (ADC)
- 6-bit High Speed Analog Comparator (CMP)
- 1.2 V voltage reference (VREF)

## Timers

- 16-bit low-power timer (LPTMR)
- 3 Timer/PWM Modules (TPM): One 4 channel TPM and two 2 channel TPMs
- Programmable Interrupt Timer (PIT)
- Real-Time Clock (RTC)

## Communication interfaces

- 2 serial peripheral interface (SPI) modules
- 2 inter-integrated circuit (I2C) modules

### Low Power Consumption

- Transceiver current (DC-DC buck mode, 3.6 V supply)
  - Typical Rx Current: 6.3 mA
  - Typical Tx current: 5.7 mA (0 dBm output)
- Low Power Mode (VLLS0) Current: 258 nA

### Clocks

- 26 and 32 MHz supported for Bluetooth LE and Generic FSK modes
- 32.768 kHz Crystal Oscillator

### Operating Characteristics

- Voltage range: 1.71 V to 3.6 V
- Ambient temperature range: -40 to 105 °C
- AEC Q100 Grade 2 Automotive Qualification

### Human-machine interface

- General-purpose input/output

- Low Power UART (LPUART) module with LIN support (2x LPUART on KW36A)
- Carrier Modulator Timer (CMT)
- FlexCAN module (with CAN FD support up to 3.2 Mbps baudrate) on KW36A

### Security

- AES-128 Hardware Accelerator (AESA)
- True Random Number Generator (TRNG)
- Advanced flash security on Program Flash
- 80-bit unique identification number per chip
- 40-bit unique media access control (MAC) sub-address
- LE Secure Connections

### Orderable parts details

| Device        | Top Line Marking | Qualification | CAN FD | 2 <sup>nd</sup> UART with LIN | FlexRAM | Package                        |
|---------------|------------------|---------------|--------|-------------------------------|---------|--------------------------------|
| MKW36A512VHT4 | (F)M36A          | Auto          | Y      | Y                             | Y       | 7X7 mm 48-pin LQFN             |
| MKW36A512VFT4 | MW36A512V4       | Auto          | Y      | Y                             | Y       | 7X7 mm 48-pin "Wettable" HVQFN |
| MKW36A512VFP4 | M36A9V4          | Auto          | Y      | Y                             | Y       | 6X6 mm 40-pin "Wettable" HVQFN |
| MKW35A512VFT4 | MW35A512V4       | Auto          | N      | N                             | N       | 7X7 mm 48-pin "Wettable" HVQFN |
| MKW35A512VFP4 | M35A9V4          | Auto          | N      | N                             | N       | 6X6 mm 40-pin "Wettable" HVQFN |
| MKW34A512VFT4 | MW34A512V4       | Auto          | N      | N                             | Y       | 7X7 mm 48-pin "Wettable" HVQFN |

### Related Resources

| Type             | Description  | Resource                                  |
|------------------|--|---|
| Product Selector | The Product Selector lets you find the right Kinetis part for your design.                                       | <a href="#">W-Series Product Selector</a> |
| Fact Sheet       | The Fact Sheet gives overview of the product key features and its uses.  | <a href="#">KW36-35-34 Fact Sheet</a>     |
| Reference Manual | The Reference Manual contains a comprehensive description of the structure and function (operation) of a device. | MKW36A512RM <sup>1</sup>                  |
| Data Sheet       | The Data Sheet includes electrical characteristics and signal connections.                                       | This document.                            |
| Chip Errata      | The chip mask set Errata provides additional or corrective information for a particular device mask set.         | KINETIS_W_1N41U <sup>1</sup>              |

Table continues on the next page...

### Related Resources (continued)

| Type            | Description  | Resource   |
|-----------------|--|--|
| Package drawing | Package dimensions are provided in package drawings. | <ul style="list-style-type: none"><li>• 40-pin "Wettable" HVQFN (6x6): 98ASA01025D<sup>1</sup></li><li>• 48-pin LQFN (7x7): 98ASA00694D<sup>1</sup></li><li>• 48-pin "Wettable" HVQFN (7x7): 98ASA01307D<sup>1</sup></li></ul> |

1. To find the associated resource, go to <http://www.nxp.com> and perform a search using this term.

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# 1 Introduction

The KW36A/35A/34A wireless microcontrollers (MCU), which includes the KW36A, KW35A, and KW34A families of devices, are highly integrated single-chip devices that enable Bluetooth Low Energy (Bluetooth LE) and Generic FSK connectivity for automotive embedded systems. To meet the stringent requirements of automotive applications, the KW36A/35A/34A is fully AEC Q100 Grade 2 Automotive Qualified. The target applications center on wirelessly bridging the embedded world with mobile devices to enhance the human interface experience, share embedded data between devices and the cloud and enable wireless firmware updates. Leading the automotive applications is the Digital Key, where a smartphone can be used by the owner as an alternative to the key FOB for unlocking and personalizing the driving experience. For a car sharing experience, the owner can provide selective, temporary authorization for access to the car allowing the authorized person to unlock, start and operate the car using their mobile device using Bluetooth LE.

The KW36A/35A/34A Wireless MCU integrates an Arm® Cortex®-M0+ CPU with up to 512 KB flash and 64 KB SRAM and a 2.4 GHz radio that supports Bluetooth LE 5.0 and Generic FSK modulations. The Bluetooth LE radio supports up to 8 simultaneous connections in any master/slave combination. The Medical Body Area Network (MBAN) frequencies from 2.36 to 2.4 GHz are also supported enabling wearable or implantable wireless medical devices.

The KW36A includes an integrated FlexCAN module enabling seamless integration into a car's in-vehicle CAN communication network. The FlexCAN module can support CAN's flexible data-rate (CAN FD) protocol for increased bandwidth and lower latency required by many automotive applications.

The KW36A/35A/34A devices can be used as a "BlackBox" modem in order to add Bluetooth LE or Generic FSK connectivity to an existing host MCU or MPU (microprocessor), or may be used as a standalone smart wireless sensor with embedded application where no host controller is required.

The RF circuit of the KW36A/35A/34A is optimized to require very few external components, achieving the smallest RF footprint possible on a printed circuit board. Extremely long battery life is achieved through the efficiency of code execution in the Cortex-M0+ CPU core and the multiple low power operating modes of the KW36A/35A/34A. For power critical applications, an integrated DC-DC converter enables operation from a single coin cell or Li-ion battery with a significant reduction of peak receive and transmit current consumption.

## 2 Feature Descriptions

This section provides a simplified block diagram and highlights the KW36A/35A/34A features.

### 2.1 Block Diagram

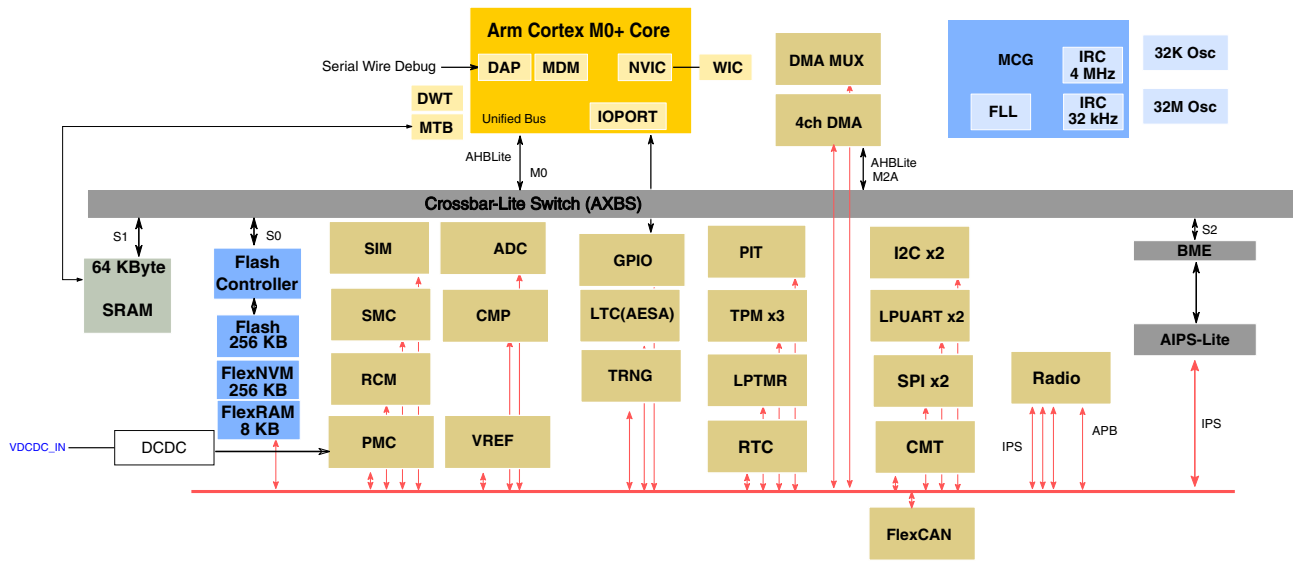


Figure 1. KW36 Detailed Block Diagram

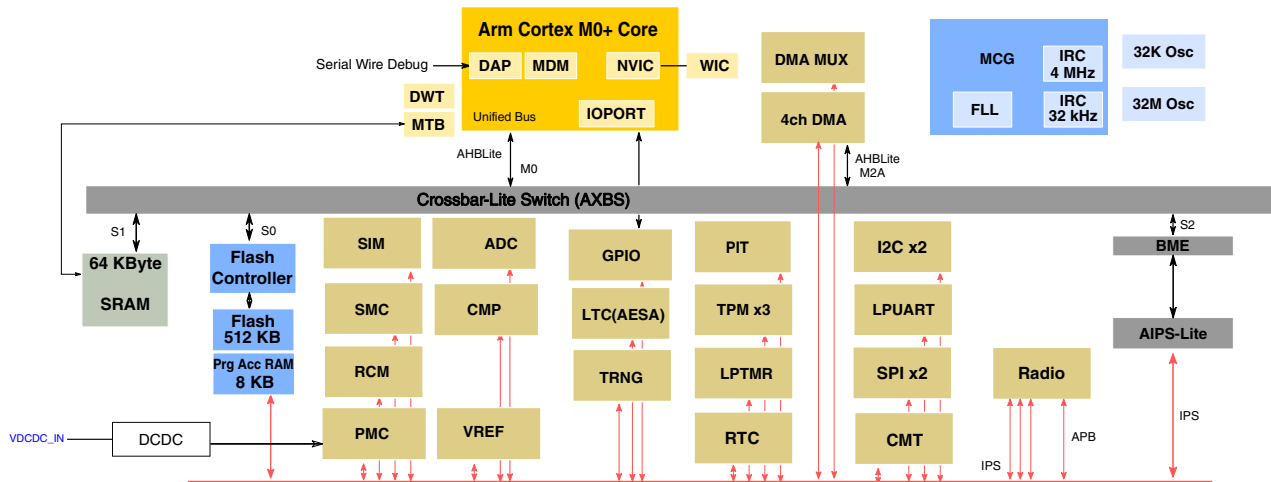


Figure 2. KW35 Detailed Block Diagram

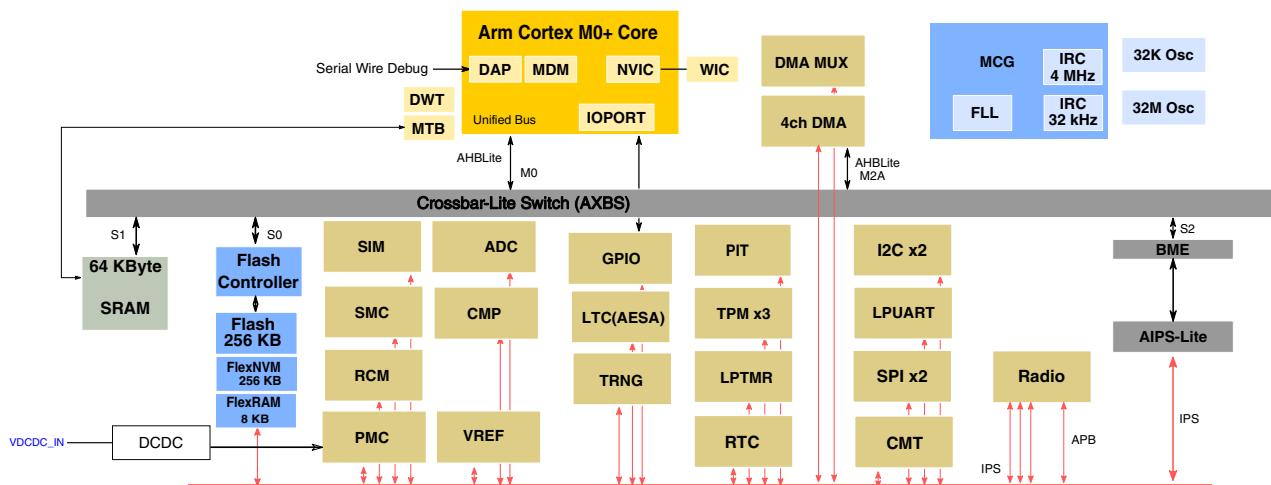


Figure 3. KW34 Detailed Block Diagram

## 2.2 Radio features

### Operating frequencies:

- 2.4 GHz ISM band (2400-2483.5 MHz)
- Medical Body Area Network (MBAN) 2360-2400 MHz

### Supported standards:

## Feature Descriptions

- Bluetooth Low Energy Version 5.0 compliant radio
- Generic FSK modulation supporting data rates up to 1 Mbit/s
- Support for up to 8 simultaneous Bluetooth LE hardware connections in any master, slave combination
- Bluetooth LE Application Profiles

### Receiver performance:

- Receive sensitivity of up to  $-95$  dBm for Bluetooth LE
- Receive sensitivity of up to  $-99$  dBm for a 250 kbit/s GFSK mode with a modulation index of 0.5. Receive sensitivity in Generic FSK modes depends on mode selection and data rate.

### Other features:

- Programmable transmit output power from  $-30$  dBm to  $+5$  dBm
- 26 MHz and 32 MHz crystals supported for Bluetooth LE and Generic FSK modes
- Bluetooth Low Energy version 5.0 Link Layer hardware with 1 Mbit/s PHY support
- Hardware acceleration for Generic FSK packet processing
- Generic FSK modulation at 250, 500 and 1000 kbit/s
- Supports 8 simultaneous Bluetooth LE connections in any master/slave combination
- Enhanced Bluetooth LE automatic deep sleep modes (DSM) supporting Slave Latency
- Up to 26 devices supported by whitelist in hardware
- Up to 8 private resolvable addresses supported in hardware
- Supports DMA capture of IQ data with sampling rate of up to 2 MHz, when using a 32 MHz crystal
- Integrated on-chip balun
- Single ended bidirectional RF port shared by transmit and receive
- Low external component count
- Supports transceiver range extension using external PA and/or LNA

## 2.3 Microcontroller features

### Arm Cortex-M0+ CPU

- Up to 48 MHz CPU



- As compared to Cortex-M0, the Cortex-M0+ uses an optimized 2-stage pipeline microarchitecture for reduced power consumption and improved architectural performance (cycles per instruction)
- Supports up to 32 interrupt request sources
- Binary compatible instruction set architecture with the Cortex-M0 core
- Thumb instruction set combines high code density with 32-bit performance
- Serial Wire Debug (SWD) reduces the number of pins required for debugging
- Micro Trace Buffer (MTB) provides lightweight program trace capabilities using system RAM as the destination memory

### **Nested Vectored Interrupt Controller (NVIC)**

- 32 vectored interrupts, 4 programmable priority levels
- Includes a single non-maskable interrupt

### **Wake-up Interrupt Controller (WIC)**

- Supports interrupt handling when system clocking is disabled in low-power modes
- Takes over and emulates the NVIC behavior when correctly primed by the NVIC on entry to very-deep-sleep
- A rudimentary interrupt masking system with no prioritization logic signals for wake-up as soon as a non-masked interrupt is detected

### **Debug Controller**

- Two-wire Serial Wire Debug (SWD) interface
- Hardware breakpoint unit for 2 code addresses
- Hardware watchpoint unit for 2 data items
- Micro Trace Buffer for program tracing

### **On-Chip Memory**

- Up to 512 KB Flash
  - KW36A/34A contains 256 KB program flash with ECC and 256 KB FlexNVM.
  - KW35A contains 512 KB program flash with ECC.
  - Flash implemented as two equal blocks each of 256 KB block. Code can execute or read from one block while the other block is being erased or programmed on KW35A only.
  - Firmware distribution protection. Program flash can be marked execute-only on a per-sector (8 KB) basis to prevent firmware contents from being read by third parties.

- 64 KB SRAM
- KW36A/34A contains 8 KB FlexRAM.
- KW35A contains 8 KB program acceleration RAM.
- Security circuitry to prevent unauthorized access to RAM and flash contents through the debugger

## 2.4 System features

### Power Management Control Unit (PMC)

- Programmable power saving modes
- Available wake-up from power saving modes via internal and external sources
- Integrated Power-on Reset (POR)
- Integrated Low Voltage Detect (LVD) with reset (brownout) capability
- Selectable LVD trip points
- Programmable Low Voltage Warning (LVW) interrupt capability
- Individual peripheral clocks can be gated off to reduce current consumption
- Internal Buffered bandgap reference voltage
- Factory programmed trim for bandgap and LVD
- 1 kHz Low-power Oscillator (LPO)

### DC-DC Converters

- Internal switched mode power supply supporting Buck and Bypass operating modes
- Buck operation supports external voltage sources of 2.1 V to 3.6 V
- When DC-DC is not used, the device supports an external voltage range of 1.5 V to 3.6 V (1.5 - 3.6 V on VDD\_RF1, VDD\_RF2, VDD\_RF3 and VDD\_1P5OUT\_PMCIN pins. 1.71 - 3.6 V on VDD\_0, VDD\_1, and VDDA pins)
- An external inductor is required to support the Buck mode

### Direct Memory Access (DMA) Controller

- All data movement via dual-address transfers: read from source, write to destination
- Programmable source and destination addresses and transfer size
- Support for enhanced addressing modes
- 4-channel implementation that performs complex data transfers with minimal intervention from a host processor
- Internal data buffer, used as temporary storage to support 16- and 32-byte transfers
- Connections to the crossbar switch for bus mastering the data movement

- Transfer Control Descriptor (TCD) organized to support two-deep, nested transfer operations
- 32-byte TCD stored in local memory for each channel
- An inner data transfer loop defined by a minor byte transfer count
- An outer data transfer loop defined by a major iteration count
- Channel activation via one of three methods:
  - Explicit software initiation
  - Initiation via a channel-to-channel linking mechanism for continuous transfers
  - Peripheral-paced hardware requests, one per channel
- Fixed-priority and round-robin channel arbitration
- Channel completion reported via optional interrupt requests
- One interrupt per channel, optionally asserted at completion of major iteration count
- Optional error terminations per channel and logically summed together to form one error interrupt to the interrupt controller
- Optional support for scatter/gather DMA processing
- Support for complex data structures

### **DMA Channel Multiplexer (DMA MUX)**

- 4 independently selectable DMA channel routers
- 2 periodic trigger sources available
- Each channel router can be assigned to 1 of the peripheral DMA sources

### **COP Watchdog Module**

- Independent clock source input (independent from CPU/bus clock)
- Choice between two clock sources
  - LPO oscillator
  - Bus clock

### **System Clocks**

- Both 26 MHz and 32 MHz crystal reference oscillator supported for Bluetooth LE and Generic FSK modes
- MCU can derive its clock either from the crystal reference oscillator or the Frequency-locked Loop (FLL)<sup>1</sup>
- 32.768 kHz crystal reference oscillator used to maintain precise Bluetooth Low Energy timing in low-power modes
- Multipurpose Clock Generator (MCG)

1. Clock options can have restrictions based on the chosen SoC configuration.

## Feature Descriptions

- Internal reference clocks — Can be used as a clock source for other on-chip peripherals
  - On-chip RC oscillator range of 31.25 kHz to 39.0625 kHz with 2% accuracy across full temperature range
  - On-chip 4 MHz oscillator with 5% accuracy across full temperature range
- Frequency-locked Loop (FLL) controlled by internal or external reference
  - 20 MHz to 48 MHz FLL output

## Unique Identifiers

- 80-bit Unique ID represents a unique identifier for each chip
- 40-bit unique Media Access Control (MAC) address, which can be used to build a unique 48-bit Bluetooth Low Energy MAC address

## 2.5 Peripheral features

### 16-bit Analog-to-Digital Converter (ADC)

- Linear successive approximation algorithm with 16-bit resolution
- Output formatted in differential-ended 16-, 13-, 11-, and 9-bit mode
- Output formatted in single-ended 16-, 12-, 10-, and 8-bit mode
- Single or continuous conversion
- Configurable sample time and conversion speed/power
- Conversion rates in 16-bit mode with no averaging up to ~500Ksamples/sec
- Input clock selection
- Operation in low-power modes for lower noise operation
- Asynchronous clock source for lower noise operation
- Selectable asynchronous hardware conversion trigger
- Automatic compare with interrupt for less-than, or greater than, or equal to programmable value
- Temperature sensor
- Battery voltage measurement
- Hardware average function
- Selectable voltage reference
- Self-calibration mode

### High-Speed Analog Comparator (CMP)

- 6-bit DAC programmable reference generator output
- Up to eight selectable comparator inputs; each input can be compared with any input by any polarity sequence

- Selectable interrupt on rising edge, falling edge, or either rising or falling edges of comparator output
- Two performance modes:
  - Shorter propagation delay at the expense of higher power
  - Low-power, with longer propagation delay
- Operational in all MCU power modes except VLLS0 mode

### **Voltage Reference(VREF1)**

- Programmable trim register with 0.5 mV steps, automatically loaded with factory trimmed value upon reset
- Programmable buffer mode selection:
  - Off
  - Bandgap enabled/standby (output buffer disabled)
  - High-power buffer mode (output buffer enabled)
- 1.2 V output at room temperature
- VREF\_OUT output signal

### **Low-power Timer (LPTMR)**

- One channel
- Operation as timer or pulse counter
- Selectable clock for prescaler/glitch filter
  - 1 kHz internal LPO
  - External low-power crystal oscillator
  - Internal reference clock
- Configurable glitch filter or prescaler
- Interrupt generated on timer compare
- Hardware trigger generated on timer compare
- Functional in all power modes

### **Timer/PWM (TPM)**

- TPM0: 4 channels, TPM1 and TPM2: 2 channels each
- Selectable source clock
- Programmable prescaler
- 16-bit counter supporting free-running or initial/final value, and counting is up or up-down
- Input capture, output compare, and edge-aligned and center-aligned PWM modes
- Input capture and output compare modes
- Generation of hardware triggers
- TPM1 and TPM2: Quadrature decoder with input filters
- Global time base mode shares single time base across multiple TPM instances

## Programmable Interrupt Timer (PIT)

- Up to 2 interrupt timers for triggering ADC conversions
- 32-bit counter resolution
- Clocked by bus clock frequency

## Real-Time Clock (RTC)

- 32-bit seconds counter with 32-bit alarm
  - Can be invalidated on detection of tamper detect
- 16-bit prescaler with compensation
- Register write protection
  - Hard Lock requires MCU POR to enable write access
  - Soft lock requires POR or software reset to enable write/read access
- Capable of waking up the system from low-power modes

## Inter-Integrated Circuit (I<sup>2</sup>C)

- Two channels
- Compatible with I2C bus standard and SMBus Specification Version 2 features
- Up to 400 kHz operation
- Multi-master operation
- Software programmable for one of 64 different serial clock frequencies
- Programmable slave address and glitch input filter
- Interrupt driven byte-by-byte data transfer
- Arbitration lost interrupt with automatic mode switching from master to slave
- Calling address identification interrupt
- Bus busy detection broadcast and 10-bit address extension
- Address matching causes wake-up when processor is in low-power mode

## LPUART

- One channel (2 channels on KW36A)
- Full-duplex operation
- Standard mark/space Non-return-to-zero (NRZ) format
- 13-bit baud rate selection with fractional divide of 32
- Programmable 8-bit or 9-bit data format
- Programmable 1 or 2 stop bits
- Separately enabled transmitter and receiver
- Programmable transmitter output polarity
- Programmable receive input polarity
- 13-bit break character option
- 11-bit break character detection option

- Two receiver wake-up methods:
  - Idle line wake-up
  - Address mark wake-up
- Address match feature in receiver to reduce address mark wake-up ISR overhead
- Interrupt or DMA driven operation
- Receiver framing error detection
- Hardware parity generation and checking
- Configurable oversampling ratio to support from 1/4 to 1/32 bit-time noise detection
- Operation in low-power modes
- Hardware Flow Control RTS\CTS
- Functional in Stop/VLPS modes
- Break detect supporting LIN

### **Serial Peripheral Interface (SPI)**

- Two independent SPI channels
- Master and slave mode
- Full-duplex, three-wire synchronous transfers
- Programmable transmit bit rate
- Double-buffered transmit and receive data registers
- Serial clock phase and polarity options
- Slave select output
- Control of SPI operation during wait mode
- Selectable MSB-first or LSB-first shifting
- Support for both transmit and receive by DMA

### **Carrier Modulator Timer (CMT)**

- Four modes of operation
  - Time; with independent control of high and low times
  - Baseband
  - Frequency shift key (FSK)
  - Direct software control of CMT\_IRO signal
- Extended space operation in time, baseband, and FSK modes
- Selectable input clock divider
- Interrupt on end of cycle
- Ability to disable CMT\_IRO signal and use as timer interrupt

### **General Purpose Input/Output (GPIO)**

- Hysteresis and configurable pull up device on all input pins
- Independent pin value register to read logic level on digital pin

## Feature Descriptions

- All GPIO pins can generate IRQ and wake-up events
- Configurable drive strength on some output pins
- GPIO can be configured to function as a interrupt driven keyboard scanning matrix
  - In the 48-pin package there are a total of 25 digital pins
  - In the 40-pin package there are a total of 18 digital pins

### FlexCAN (for KW36A only)

- Full implementation of the CAN with Flexible Data Rate (CAN FD) protocol specification and CAN protocol specification, Version 2.0 B
- Flexible Message Buffers (MBs); there are total 32 MBs of 8 bytes data length each, configurable as Rx or Tx, all supporting standard and extended messages
- Programmable clock source to the CAN Protocol Interface, either peripheral clock or oscillator clock
- Capability to select priority between mailboxes and Rx FIFO during matching process
- Powerful Rx FIFO ID filtering, capable of matching incoming IDs against either 128 extended, 256 standard, or 512 partial (8 bit) IDs, with up to 32 individual masking capability

## 2.6 Security Features

### Advanced Encryption Standard Accelerator(AES-128 Accelerator)

The Advanced Encryption Standard Accelerator (AESA) module is a standalone hardware coprocessor capable of accelerating the 128-bit advanced encryption standard (AES) cryptographic algorithms.

The AESA engine supports the following cryptographic features.

LTC includes the following features:

- Cryptographic authentication
  - Message Authentication Codes (MAC)
    - Cipher-based MAC (AES-CMAC)
    - Extended cipher block chaining message authentication code (AES-XCBC-MAC)
  - Auto padding
  - Integrity Check Value(ICV) checking
- Authenticated encryption algorithms
  - Counter with CBC-MAC (AES-CCM)
- Symmetric key block ciphers



- AES (128-bit keys)
- Cipher modes:
  - AES-128 modes
    - Electronic Codebook (ECB)
    - Cipher Block Chaining (CBC)
    - Counter (CTR)
- Secure scan

### **True Random Number Generator (TRNG)**

True Random Number Generator (TRNG) is a hardware accelerator module that constitutes a high-quality entropy source.

- TRNG generates a 512-bit (4x 128-bit) entropy as needed by an entropy-consuming module, such as a deterministic random number generator.
- TRNG output can be read and used by a deterministic pseudo-random number generator (PRNG) implemented in software.
- TRNG-PRNG combination achieves NIST-compliant true randomness and cryptographic-strength random numbers using the TRNG output as the entropy source.
- A fully FIPS 180 compliant solution can be realized using the TRNG together with a FIPS-compliant deterministic random number generator and the SoC-level security.

### **Flash Memory Protection**

The on-chip flash memory controller enables the following useful features:

- Program flash protection scheme prevents accidental program or erase of stored data.
- Automated, built-in, program and erase algorithms with verify.
- Read access to one program flash block is possible while programming or erasing data in the other program flash block.

## **3 Transceiver Description**

- Direct Conversion Receiver (Zero IF)
- Constant Envelope Transmitter
- 2.36 GHz to 2.483 GHz PLL Range
- Low Transmit and Receive Current Consumption
- Low BOM

### 3.1 Key Specifications

KW36A/35A/34A meets or exceeds all Bluetooth Low Energy version 5.0 performance specifications. The key specifications for the KW36A/35A/34A are:

#### Frequency Band:

- ISM Band: 2400 to 2483.5 MHz
- MBAN Band: 2360 to 2400 MHz

#### Bluetooth Low Energy version 5.0 modulation scheme:

- Symbol rate: 1000 kbit/s
- Modulation: GFSK
- Receiver sensitivity: -95 dBm, typical
- Programmable transmitter output power: -30 dBm to +5 dBm

#### Generic FSK modulation scheme:

- Symbol rate: 250, 500 and 1000 kbit/s
- Modulation(s): GFSK (modulation index = 0.32, 0.5, 0.7 and 1.0, BT = 0.3, 0.5, and 0.7), FSK and MSK
- Receiver Sensitivity: Mode and data rate dependent. -99 dBm typical for GFSK (r=250 kbit/s, BT = 0.5, h = 0.5)

### 3.2 Channel Map Frequency Plans

#### 3.2.1 Channel Plan for Bluetooth Low Energy

This section describes the frequency plan / channels associated with 2.4 GHz ISM and MBAN bands for Bluetooth Low Energy.

#### 2.4 GHz ISM Channel numbering:

- $F_c = 2402 + k * 2 \text{ MHz}$ ,  $k=0, \dots, 39$ .

#### MBAN Channel numbering:

- $F_c = 2360 + k \text{ in MHz}$ , for  $k=0, \dots, 39$

where k is the channel number.

**Table 1. 2.4 GHz ISM and MBAN frequency plan and channel designations**

| 2.4 GHz ISM <sup>1</sup> |            | MBAN <sup>2</sup> |            | 2.4GHz ISM + MBAN |            |
|--------------------------|------------|-------------------|------------|-------------------|------------|
| Channel                  | Freq (MHz) | Channel           | Freq (MHz) | Channel           | Freq (MHz) |
| 0                        | 2402       | 0                 | 2360       | 28                | 2390       |
| 1                        | 2404       | 1                 | 2361       | 29                | 2391       |
| 2                        | 2406       | 2                 | 2362       | 30                | 2392       |
| 3                        | 2408       | 3                 | 2363       | 31                | 2393       |
| 4                        | 2410       | 4                 | 2364       | 32                | 2394       |
| 5                        | 2412       | 5                 | 2365       | 33                | 2395       |
| 6                        | 2414       | 6                 | 2366       | 34                | 2396       |
| 7                        | 2416       | 7                 | 2367       | 35                | 2397       |
| 8                        | 2418       | 8                 | 2368       | 36                | 2398       |
| 9                        | 2420       | 9                 | 2369       | 0                 | 2402       |
| 10                       | 2422       | 10                | 2370       | 1                 | 2404       |
| 11                       | 2424       | 11                | 2371       | 2                 | 2406       |
| 12                       | 2426       | 12                | 2372       | 3                 | 2408       |
| 13                       | 2428       | 13                | 2373       | 4                 | 2410       |
| 14                       | 2430       | 14                | 2374       | 5                 | 2412       |
| 15                       | 2432       | 15                | 2375       | 6                 | 2414       |
| 16                       | 2434       | 16                | 2376       | 7                 | 2416       |
| 17                       | 2436       | 17                | 2377       | 8                 | 2418       |
| 18                       | 2438       | 18                | 2378       | 9                 | 2420       |
| 19                       | 2440       | 19                | 2379       | 10                | 2422       |
| 20                       | 2442       | 20                | 2380       | 11                | 2424       |
| 21                       | 2444       | 21                | 2381       | 12                | 2426       |
| 22                       | 2446       | 22                | 2382       | 13                | 2428       |
| 23                       | 2448       | 23                | 2383       | 14                | 2430       |
| 24                       | 2450       | 24                | 2384       | 15                | 2432       |
| 25                       | 2452       | 25                | 2385       | 16                | 2434       |
| 26                       | 2454       | 26                | 2386       | 17                | 2436       |
| 27                       | 2456       | 27                | 2387       | 18                | 2438       |
| 28                       | 2458       | 28                | 2388       | 19                | 2440       |
| 29                       | 2460       | 29                | 2389       | 20                | 2442       |
| 30                       | 2462       | 30                | 2390       | 21                | 2444       |
| 31                       | 2464       | 31                | 2391       | 22                | 2446       |
| 32                       | 2466       | 32                | 2392       | 23                | 2448       |
| 33                       | 2468       | 33                | 2393       | 24                | 2450       |
| 34                       | 2470       | 34                | 2394       | 25                | 2452       |

*Table continues on the next page...*

**Table 1. 2.4 GHz ISM and MBAN frequency plan and channel designations (continued)**

| 2.4 GHz ISM <sup>1</sup> |            | MBAN <sup>2</sup> |            | 2.4GHz ISM + MBAN |            |
|--------------------------|------------|-------------------|------------|-------------------|------------|
| Channel                  | Freq (MHz) | Channel           | Freq (MHz) | Channel           | Freq (MHz) |
| 35                       | 2472       | 35                | 2395       | 26                | 2454       |
| 36                       | 2474       | 36                | 2396       | 27                | 2456       |
| 37                       | 2476       | 37                | 2397       | 37                | 2476       |
| 38                       | 2478       | 38                | 2398       | 38                | 2478       |
| 39                       | 2480       | 39                | 2399       | 39                | 2480       |

1. ISM frequency of operation spans from 2400.0 MHz to 2483.5 MHz

2. Per FCC guideline rules, Bluetooth Low Energy single mode operation is allowed in these channels.

### 3.2.2 Other Channel Plans

The RF synthesizer can be configured to use any channel frequency between 2.36 and 2.487 GHz.

## 3.3 Transceiver Functions

### Receive

The receiver architecture is Zero IF (ZIF) where the received signal after passing through RF front end is down-converted to a baseband signal. The signal is filtered and amplified before it is fed to analog-to-digital converter. The digital signal then decimates to a baseband clock frequency before it digitally processes, demodulates and passes on to packet processing/link-layer processing.

### Transmit

The transmitter transmits GFSK/FSK modulation having power and channel selection adjustment per user application. After the channel of operation is determined, coarse and fine-tuning is executed within the Frac-N PLL to engage signal lock. After signal lock is established, the modulated buffered signal is routed to a multi-stage amplifier for transmission..

## 4 Transceiver Electrical Characteristics

## 4.1 Radio operating conditions

**Table 2. Radio operating conditions**

| Characteristic   | Symbol    | Min              | Typ | Max   | Unit |
|--|-----------|------------------|-----|-------|------|
| Input Frequency  | $f_{in}$  | 2.360            | —   | 2.480 | GHz  |
| Ambient Temperature Range                              | $T_A$     | -40              | 25  | 105   | °C   |
| Maximum RF Input Power                                 | $P_{max}$ | —                | —   | 10    | dBm  |
| Crystal Reference Oscillator Frequency<br><sup>1</sup> | $f_{ref}$ | 26 MHz or 32 MHz |     |       |      |

1. The recommended crystal accuracy is  $\pm 40$  ppm including initial accuracy, mechanical, temperature, and aging factors.

## 4.2 Receiver Feature Summary

**Table 3. Top-Level Receiver Specifications (TA=25 °C, nominal process unless otherwise noted)**

| Characteristic <sup>1</sup>  | Symbol                    | Min.  | Typ. | Max.           | Unit |
|--|---------------------------|-------|------|----------------|------|
| Supply current power down on VDD_RFX supplies  | $I_{pdn}$                 | —     | 200  | 1000           | nA   |
| Supply current Rx On with DC-DC converter enable (Buck; $V_{DCDC\_IN} = 3.6$ V, $VDD\_1P5\_buck = 1.5$ V) . <sup>2</sup> | $I_{Rxon}$                | —     | 6.3  | —              | mA   |
| Supply current Rx On with DC-DC converter disabled (Bypass) <sup>2</sup>   | $I_{Rxon}$                | —     | 17.2 | —              | mA   |
| Input RF Frequency   | $f_{in}$                  | 2.360 | —    | 2.4835         | GHz  |
| GFSK Rx Sensitivity(250 kbit/s GFSK-BT=0.5, h=0.5)   | $SENS_{GFSK}$             | —     | -99  | —              | dBm  |
| Bluetooth LE Rx Sensitivity <sup>3</sup>   | $SENS_{BLE}$              | —     | -95  | —              | dBm  |
| Noise Figure for maximum gain mode @ typical sensitivity   | $NF_{HG}$                 | —     | 7.5  | —              | dB   |
| Receiver Signal Strength Indicator Range <sup>4</sup>  | $RSSI_{Range}$            | -100  | —    | 5 <sup>5</sup> | dBm  |
| Receiver Signal Strength Indicator Resolution  | $RSSI_{Res}$              | —     | 1    | —              | dB   |
| Typical RSSI variation over frequency  |                           | -2    | —    | 2              | dB   |
| Typical RSSI variation over temperature  |                           | -2    | —    | 2              | dB   |
| Narrowband RSSI accuracy <sup>6</sup>  | $RSSI_{Acc}$              | -3    | —    | 3              | dB   |
| Bluetooth LE Co-channel Interference (Wanted signal at -67 dBm, BER <0.1%. Measurement resolution 1 MHz).                |                           |       | -7   |                | dB   |
| <i>Adjacent/Alternate Channel Performance<sup>7</sup></i>  |                           |       |      |                |      |
| Bluetooth LE Adjacent +/-1 MHz Interference offset (Wanted signal at -67 dBm, BER <0.1%. Measurement resolution 1 MHz.)  | $SEL_{BLE, 1\text{ MHz}}$ | —     | 2    | —              | dB   |

Table continues on the next page...

**Table 3. Top-Level Receiver Specifications (TA=25 °C, nominal process unless otherwise noted) (continued)**

| Characteristic <sup>1</sup>  | Symbol                     | Min. | Typ. | Max. | Unit |
|--|----------------------------|------|------|------|------|
| Bluetooth LE Adjacent +/-2 MHz Interference offset (Wanted signal at -67 dBm, BER <0.1%. Measurement resolution 1 MHz.)  | SEL <sub>BLE, 2 MHz</sub>  | —    | 43   | —    | dB   |
| Bluetooth LE Alternate +/-3 MHz Interference offset (Wanted signal at -67 dBm, BER <0.1%. Measurement resolution 1 MHz.)   | SEL <sub>BLE, 3 MHz</sub>  | —    | 50   | —    | dB   |
| Bluetooth LE Alternate ≥ +/-4 MHz Interference offset (Wanted signal at -67 dBm, BER <0.1%. Measurement resolution 1 MHz.)   | SEL <sub>BLE, 4+ MHz</sub> | —    | 50   | —    | dB   |
| <i>Intermodulation Performance</i>   |                            |      |      |      |      |
| Bluetooth LE Intermodulation with continuous wave interferer at ± 3 MHz and modulated interferer is at ± 6 MHz (Wanted signal at -67 dBm, BER<0.1%.)   |                            | —    | -23  | —    | dBm  |
| Bluetooth LE Intermodulation with continuous wave interferer at ±5 MHz and modulated interferer is at ±10 MHz (Wanted signal at -67 dBm, BER<0.1%.)  |                            | —    | -24  | —    | dBm  |
| <i>Blocking Performance</i>  |                            |      |      |      |      |
| Bluetooth LE Out of band blocking from 30 MHz to 1000 MHz and 4000 MHz to 5000 MHz (Wanted signal at -67 dBm, BER<0.1%. Interferer continuous wave signal.) <sup>8</sup>   | —                          | -2   | —    | —    | dBm  |
| Bluetooth LE Out of band blocking from 1000 MHz to 2000 MHz and 3000 MHz to 4000 MHz (Wanted signal at -67 dBm, BER<0.1%. Interferer continuous wave signal.)  | —                          | -8.4 | —    | —    | dBm  |
| Bluetooth LE Out of band blocking from 2001 MHz to 2339 MHz and 2484 MHz to 2999 MHz (Wanted signal at -67 dBm, BER<0.1%. Interferer continuous wave signal.) <sup>9</sup>   | —                          | -17  | —    | —    | dBm  |
| Bluetooth LE Out of band blocking from 5000 MHz to 12750 MHz (Wanted signal at -67 dBm, BER<0.1%. Interferer continuous wave signal.) <sup>9</sup>   | —                          | —    | 10   | —    | dBm  |
| Spurious Emission < 1.6 MHz offset (Measured with 100 kHz resolution and average detector. Device transmit on RF channel with center frequency f <sub>c</sub> and spurious power measured in 1 MHz at RF frequency f), where  f-f <sub>c</sub>   < 1.6 MHz               | —                          | —    | -54  | —    | dBc  |
| Spurious Emission > 2.5 MHz offset (Measured with 100 kHz resolution and average detector. Device transmit on RF channel with center frequency f <sub>c</sub> and spurious power measured in 1 MHz at RF frequency f), where  f-f <sub>c</sub>   > 2.5 MHz <sup>10</sup> | —                          | —    | -70  | —    | dBc  |

1. All the Rx parameters are measured at the KW36A/35A/34A RF pins.
2. Transceiver power consumption.
3. Measured at 0.1% BER using 37 byte long packets in maximum gain mode and nominal conditions.
4. Narrow-band RSSI mode.
5. With RSSI\_CTRL\_0.RSSI\_ADJ field calibrated to account for antenna to RF input losses.
6. With one point calibration over frequency and temperature.

7. Bluetooth LE adjacent and alternate selectivity performance is measured with modulated interference signals.
8. Exceptions allowed for carrier frequency sub harmonics.
9. Exceptions allowed for carrier frequency harmonics.
10. Exceptions allowed for twice the reference clock frequency( $f_{ref}$ ) multiples.

**Table 4. Receiver Specifications with Generic FSK Modulations**

| Modulation Type       | Data Rate (kbit/s) | Channel BW (kHz) | Typical Sensitivity (dBm) | Adjacent/Alternate Channel Selectivity (dB) <sup>1</sup> |  |  |  |  | Co-channel |
|-----------------------|--------------------|------------------|---------------------------|--|--|--|--|--|------------|
|                       |                    |                  |                           | Desired signal level (dBm)                               | Interferer at $-/+1^*$ channel BW offset | Interferer at $-/+2^*$ channel BW offset | Interferer at $-/+3^*$ channel BW offset | Interferer at $-/+4^*$ channel BW offset |            |
| GFSK BT = 0.5, h=0.5  | 1000               | 2000             | -95                       | -67  | 43                                       | 50                                       | 55                                       | 50                                       | -7         |
|                       | 500                | 1000             | -97                       | -85  | 40                                       | 50                                       | 55                                       | 55                                       | -7         |
|                       | 250                | 500              | -99                       | -85  | 30                                       | 40                                       | 50                                       | 50                                       | -7         |
| GFSK, BT = 0.5, h=0.3 | 1000               | 1000             | -89                       | -67  | 10                                       | 38                                       | 42                                       | 47                                       | -10        |
|                       | 500                | 800              | -92                       | -85  | 22                                       | 31                                       | 37                                       | 42                                       | -10        |
|                       | 250                | 500              | -93                       | -85  | 20                                       | 25                                       | 30                                       | 34                                       | -13        |
| GFSK, BT = 0.5, h=0.7 | 1000               | 2000             | -97                       | -85  | 45                                       | 50                                       | 57                                       | 60                                       | -7         |
|                       | 500                | 1000             | -98                       | -85  | 40                                       | 50                                       | 55                                       | 55                                       | -7         |
|                       | 250                | 600              | -99                       | -85  | 30                                       | 40                                       | 50                                       | 50                                       | -7         |
| GMSK BT=0.3           | 1000               | 1600             | -91                       | -85  | 40                                       | 46                                       | 53                                       | 55                                       | -8         |
|                       | 500                | 800              | -93                       | -85  | 35                                       | 46                                       | 50                                       | 53                                       | -7         |
|                       | 250                | 500              | -95                       | -85  | 30                                       | 40                                       | 40                                       | 50                                       | -7         |
| GMSK, BT = 0.7        | 1000               | 2000             | -96                       | -85  | 44                                       | 53                                       | 57                                       | 60                                       | -7         |
|                       | 500                | 1000             | -97                       | -85  | 40                                       | 50                                       | 55                                       | 55                                       | -7         |
|                       | 250                | 600              | -99                       | -85  | 30                                       | 40                                       | 50                                       | 50                                       | -7         |
| Generic MSK           | 1000               | 3000             | -96                       | -85  | 43                                       | 53                                       | 60                                       | 63                                       | -7         |
|                       | 500                | 1600             | -97                       | -85  | 43                                       | 50                                       | 60                                       | 60                                       | -8         |
|                       | 250                | 800              | -99                       | -85  | 35                                       | 45                                       | 55                                       | 55                                       | -7         |
| GFSK BT=0.5, h=1      | 1000               | 3000             | -96                       | -85  | 45                                       | 55                                       | 55                                       | 59                                       | -8         |
|                       | 500                | 1400             | -97                       | -85  | 40                                       | 45                                       | 50                                       | 50                                       | -8         |
|                       | 250                | 800              | -98                       | -85  | 35                                       | 45                                       | 45                                       | 50                                       | -8         |

1. Selectivity measured with an unmodulated blocker except for GFSK BT=0.5, h=0.5 1 Mbit/s and GFSK BT=0.5, h=0.32 1 Mbit/s. The desired signal is set at -85 dBm.

### 4.3 Transmit and PLL Feature Summary

- Supports constant envelope modulation of 2.4 GHz ISM and 2.36 GHz MBAN frequency bands
- Fast PLL Lock time: < 25  $\mu$ s
- Reference Frequency:

## Transceiver Electrical Characteristics

- 26 MHz and 32 MHz crystals supported for Bluetooth LE and Generic FSK modes

**Table 5. Top-Level Transmitter Specifications (TA=25 °C, nominal process unless otherwise noted)**

| Characteristic <sup>1</sup>   | Symbol                 | Min.  | Typ. | Max.   | Unit    |
|---|------------------------|-------|------|--------|---------|
| Supply current power down on VDD_RFX supplies   | $I_{pdn}$              | —     | 200  | —      | nA      |
| Supply current Tx On with $P_{RF} = 0$ dBm and DC-DC converter enabled (Buck; $VDD_{DCDC\_in} = 3.6$ V, $VDD_{1P5\_buck} = 1.5$ V) <sup>2</sup>                     | $I_{Txone}$            | —     | 5.7  | —      | mA      |
| Supply current Tx On with $P_{RF} = 0$ dBm and DC-DC converter disabled (Bypass) <sup>2</sup>   | $I_{Txond}$            | —     | 16   | —      | mA      |
| Supply current Tx On with $P_{RF} = +3.5$ dBm and DC-DC converter enabled (Buck; $VDD_{DCDC\_in} = 3.6$ V, $VDD_{1P5\_buck} = 1.5$ V) <sup>2</sup>                  | $I_{TX3.5dBm}$         | —     | 6.9  | —      | mA      |
| Supply current Tx On with $P_{RF} = +3.5$ dBm and DC-DC converter disabled (Bypass) <sup>2</sup>  | $I_{TX3.5dBmb}$        | —     | 19   | —      | mA      |
| Supply current Tx On with $P_{RF} = +5$ dBm and DC-DC converter enabled (Buck; $VDD_{DCDC\_in} = 3.6$ V, $VDD_{1P5\_buck} = 1.55$ V, LDO-HF bumped) <sup>2, 3</sup> | $I_{TX5dBm}$           | —     | 8.0  | —      | mA      |
| Supply current Tx On with $P_{RF} = +5$ dBm and DC-DC converter disabled (Bypass, LDO-HF bumped) <sup>2, 3</sup>  | $I_{TX5dBmb}$          | —     | 21   | —      | mA      |
| Output RF Frequency   | $f_{RFout}$            | 2.360 | —    | 2.4835 | GHz     |
| Maximum RF Output Power; LDO-HF bumped <sup>4</sup>   | $P_{RF,maxV}$          | —     | +5   | —      | dBm     |
| Maximum RF Output power, nominal power supply <sup>5</sup>  | $P_{RF,maxn}$          | —     | +3.5 | —      | dBm     |
| Minimum RF Output power, nominal power supply <sup>5</sup>  | $P_{RF,minn}$          | —     | -30  | —      | dBm     |
| RF Output power control range   | $P_{RF,CR}$            | —     | 34   | —      | dB      |
| Bluetooth LE Tx Output Spectrum 20dB BW   | $TXBW_{BLE}$           | 1.0   | —    | —      | MHz     |
| Bluetooth LE average frequency deviation using a 00001111 modulation sequence   | $\Delta f_{1,avg,BLE}$ | —     | 250  | —      | kHz     |
| Bluetooth LE average frequency deviation using a 01010101 modulation sequence   | $\Delta f_{2,avg,BLE}$ | —     | 220  | —      | kHz     |
| Bluetooth LE RMS FSK Error  | $FSK_{err,BLE}$        | —     | 3%   | —      | —       |
| Bluetooth LE Maximum Deviation of the Center Frequency <sup>6</sup>   | $F_{cdev,BLE}$         | —     | ±3   | —      | kHz     |
| Bluetooth LE Adjacent Channel Transmit Power at 2 MHz offset <sup>7</sup>   | $P_{RF2MHz,BLE}$       | —     | —    | -55    | dBm     |
| Bluetooth LE Adjacent Channel Transmit Power at ≥ 3 MHz offset <sup>7</sup>   | $P_{RF3MHz,BLE}$       | —     | —    | -59    | dBm     |
| Bluetooth LE Frequency Hopping Support  |                        |       | YES  |        |         |
| Second Harmonic of Transmit Carrier Frequency ( $P_{out} = P_{RF,max}$ ) <sup>8</sup>   | $TXH2$                 | —     | -46  | —      | dBm/MHz |
| Third Harmonic of Transmit Carrier Frequency ( $P_{out} = P_{RF,max}$ ) <sup>8</sup>  | $TXH3$                 | —     | -58  | —      | dBm/MHz |

1. All the Tx parameters are measured at test hardware SMA connector.
2. Transceiver power consumption.



3. VDD\_RFX shall be equal to or higher than 1.55 V to support a TX Pout of +5 dBm.
4. Measured at KW36A/35A/34A RF pins, with BB\_LDO\_HF\_TRIM=1.44 V.
5. Measured at the KW36A/35A/34A RF pins.
6. Maximum drift of carrier frequency of the PLL during a Bluetooth LE packet with a nominal 32 MHz reference crystal.
7. Measured at P<sub>out</sub> = +5 dBm and recommended Tx match.
8. Harmonic levels based on recommended 2 component match. Transmit harmonic levels depend on the quality of matching components. Additional harmonic margin using a third matching component (1x shunt capacitor) is possible.

Transmit PA driver output as a function of the PA\_POWER[5:0] field when measured at the IC pins is as follows:

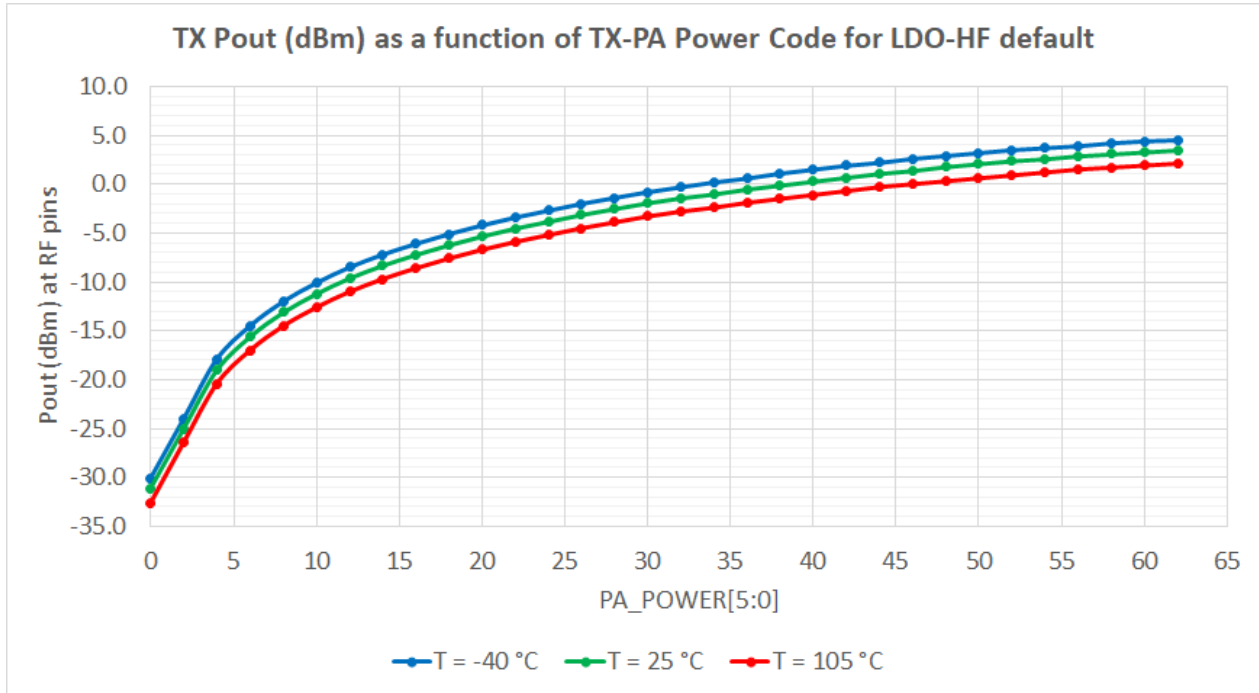


Figure 4. TX Pout (dBm) as function TX-PA Power Code for default LDO-HF

Table 6. Transmit Output Power as a function of PA\_POWER[5:0] with default LDO-HF

| PA_POWER[5:0] | TX Pout (dBm) <sup>1</sup> |           |            |
|---------------|----------------------------|-----------|------------|
|               | T = -40 °C                 | T = 25 °C | T = 105 °C |
| 1             | -30.1                      | -31.1     | -32.6      |
| 2             | -24.0                      | -25.0     | -26.4      |
| 4             | -17.9                      | -19.0     | -20.4      |
| 6             | -14.5                      | -15.6     | -17.0      |
| 8             | -12.0                      | -13.1     | -14.5      |
| 10            | -10.1                      | -11.2     | -12.6      |
| 12            | -8.5                       | -9.6      | -11.0      |
| 14            | -7.2                       | -8.3      | -9.7       |
| 16            | -6.1                       | -7.2      | -8.6       |

Table continues on the next page...

**Table 6. Transmit Output Power as a function of PA\_POWER[5:0] with default LDO-HF (continued)**

| PA_POWER[5:0] | TX Pout (dBm) <sup>1</sup> |           |            |
|---------------|----------------------------|-----------|------------|
|               | T = -40 °C                 | T = 25 °C | T = 105 °C |
| 18            | -5.1                       | -6.2      | -7.6       |
| 20            | -4.2                       | -5.3      | -6.7       |
| 22            | -3.4                       | -4.5      | -5.9       |
| 24            | -2.7                       | -3.8      | -5.2       |
| 26            | -2.0                       | -3.1      | -4.5       |
| 28            | -1.4                       | -2.5      | -3.9       |
| 30            | -0.8                       | -1.9      | -3.3       |
| 32            | -0.3                       | -1.4      | -2.8       |
| 34            | 0.2                        | -1.0      | -2.4       |
| 36            | 0.6                        | -0.5      | -1.9       |
| 38            | 1.1                        | -0.1      | -1.5       |
| 40            | 1.5                        | 0.3       | -1.1       |
| 42            | 1.9                        | 0.7       | -0.7       |
| 44            | 2.2                        | 1.1       | -0.3       |
| 46            | 2.6                        | 1.4       | 0.0        |
| 48            | 2.9                        | 1.8       | 0.3        |
| 50            | 3.2                        | 2.1       | 0.6        |
| 52            | 3.5                        | 2.4       | 0.9        |
| 54            | 3.7                        | 2.6       | 1.2        |
| 56            | 3.9                        | 2.9       | 1.5        |
| 58            | 4.2                        | 3.1       | 1.7        |
| 60            | 4.4                        | 3.3       | 1.9        |
| 62            | 4.5                        | 3.5       | 2.1        |

1. Tx continuous wave power output at the RF pins with the recommended matching components mounted on PCB.

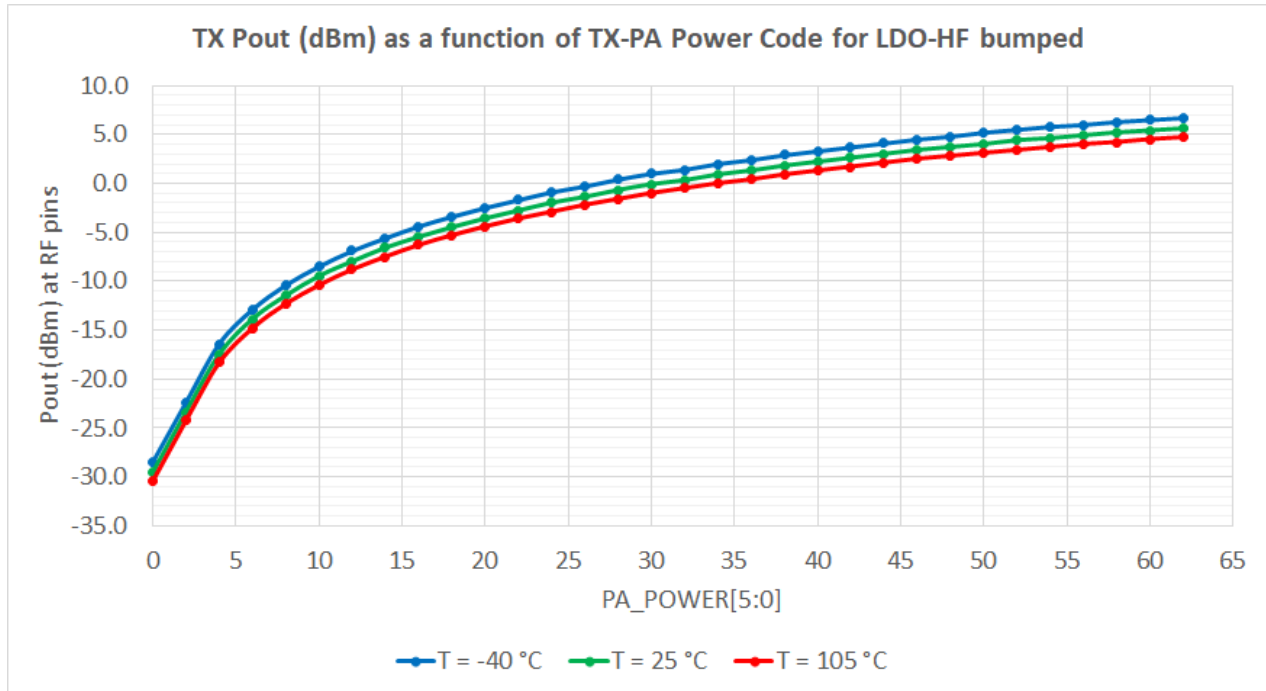


Figure 5. TX Pout (dBm) as a function of TX-PA Power Code for LDO-HF bumped

Table 7. Transmit Output Power as a function of PA\_POWER[5:0] with LDO-HF Bumped

| PA_POWER[5:0] | TX Pout (dBm) <sup>1</sup> |           |            |
|---------------|----------------------------|-----------|------------|
|               | T = -40 °C                 | T = 25 °C | T = 105 °C |
| 1             | -28.5                      | -29.6     | -30.4      |
| 2             | -22.4                      | -23.4     | -24.2      |
| 4             | -16.4                      | -17.5     | -18.3      |
| 6             | -12.9                      | -13.9     | -14.8      |
| 8             | -10.4                      | -11.5     | -12.3      |
| 10            | -8.5                       | -9.5      | -10.4      |
| 12            | -6.9                       | -8.0      | -8.8       |
| 14            | -5.6                       | -6.6      | -7.5       |
| 16            | -4.4                       | -5.5      | -6.3       |
| 18            | -3.4                       | -4.5      | -5.3       |
| 20            | -2.5                       | -3.6      | -4.4       |
| 22            | -1.7                       | -2.8      | -3.6       |
| 24            | -0.9                       | -2.0      | -2.9       |
| 26            | -0.3                       | -1.4      | -2.2       |
| 28            | 0.4                        | -0.7      | -1.6       |
| 30            | 1.0                        | -0.1      | -1.0       |
| 32            | 1.4                        | 0.3       | -0.5       |

Table continues on the next page...

**Table 7. Transmit Output Power as a function of PA\_POWER[5:0] with LDO-HF Bumped (continued)**

| PA_POWER[5:0] | TX Pout (dBm) <sup>1</sup> |           |            |
|---------------|----------------------------|-----------|------------|
|               | T = -40 °C                 | T = 25 °C | T = 105 °C |
| 34            | 2.0                        | 0.9       | 0.0        |
| 36            | 2.4                        | 1.3       | 0.4        |
| 38            | 2.9                        | 1.8       | 0.9        |
| 40            | 3.3                        | 2.2       | 1.3        |
| 42            | 3.7                        | 2.6       | 1.7        |
| 44            | 4.1                        | 3.0       | 2.1        |
| 46            | 4.5                        | 3.4       | 2.5        |
| 48            | 4.8                        | 3.7       | 2.8        |
| 50            | 5.2                        | 4.0       | 3.1        |
| 52            | 5.5                        | 4.4       | 3.4        |
| 54            | 5.8                        | 4.6       | 3.7        |
| 56            | 6.0                        | 4.9       | 4.0        |
| 58            | 6.3                        | 5.2       | 4.2        |
| 60            | 6.5                        | 5.4       | 4.5        |
| 62            | 6.7                        | 5.6       | 4.7        |

1. Tx continuous wave power output at the RF pins with the recommended matching components mounted on PCB.

## 5 System and Power Management

### 5.1 Power Management

The KW36A/35A/34A includes internal power management features that can be used to control the power usage. The power management of the KW36A/35A/34A includes Power Management Controller (PMC) and a DC-DC converter which can operate in a buck or bypass configuration. The PMC is designed such that the RF radio remains in state-retention while the core is in various stop modes. It makes sure that the device can stay in low current consumption mode while the RF radio can wake-up quick enough for communication.

#### 5.1.1 DC-DC Converter

The features of the DC-DC converter include the following:

- Single inductor, multiple outputs.
- Buck mode (pin selectable; CFG=VDCDC\_IN).
- Continuous or pulsed operation (hardware/software configurable).
- Power switch input to allow external control of power up, and to select DC-DC bypass mode in which all the SoC power supplies (see [Table 3](#)) are externally provided.
- Output signal to indicate power stable. Purpose is for the rest of the chip to be used as a POR.
- Scaled battery output voltage suitable for SAR ADC utilization.
- Internal oscillator for support when the reference oscillator is not present.

## 5.2 Modes of Operation

The Arm Cortex-M0+ core in the KW36A/35A/34A has three primary modes of operation: Run, Wait, and Stop modes. For each run mode, there is a corresponding wait and stop mode. Wait modes are similar to Arm sleep modes. Stop modes are similar to Arm deep sleep modes. The very low-power run (VLPR) operation mode can drastically reduce runtime power when the maximum bus frequency is not required to handle the application needs.

The WFI instruction invokes both wait and stop modes. The primary modes are augmented in a number of ways to provide lower power based on application needs.

### 5.2.1 Power modes

The power management controller (PMC) provides multiple power options to allow the user to optimize power consumption for the level of functionality needed.

Depending on the stop requirements of the user application, various stop modes are available that provide state retention, partial power down, or full power down of certain logic and/or memory. I/O states are held in all modes of operation. The following table compares the various power modes available.

For each run mode, there is a corresponding wait and stop mode. Wait modes are similar to Arm sleep modes. Stop modes (VLPS, STOP) are similar to Arm sleep deep mode. The very-low-power run (VLPR) operating mode can drastically reduce runtime power when the maximum bus frequency is not required to handle the application needs.

The three primary modes of operation are run, wait, and stop. The WFI instruction invokes either wait or stop depending on the SLEEPDEEP bit in Cortex-M0+ System Control Register. The primary modes are augmented in a number of ways to provide lower power based on application needs.

**Table 8. Power modes (At 25 deg C)**

| Power mode   | Description  | CPU recovery method | Radio   |
|--|--|---------------------|---|
| Normal Run (all peripherals clock off)                     | Allows maximum performance of chip.  | —                   | Radio can be active   |
| Normal Wait - via WFI                                      | Allows peripherals to function, while allowing CPU to go to sleep reducing power.  | Interrupt           |   |
| Normal Stop - via WFI                                      | Places chip in static state. Lowest power mode that retains all registers while maintaining LVD protection.  | Interrupt           |   |
| PStop2 (Partial Stop 2)                                    | Core and system clocks are gated. Bus clock remains active. Masters and slaves clocked by bus clock remain in Run or VLPRun mode. The clock generators in MCG and the on-chip regulator in the PMC also remain in Run or VLPRun mode.  | Interrupt           |   |
| PStop1 (Partial Stop 1)                                    | Core, system clocks, and bus clock are gated. All bus masters and slaves enter Stop mode. The clock generators in MCG and the on-chip regulator in the PMC also remain in Run or VLPRun mode.  | Interrupt           |   |
| VLPR (Very Low-power Run) (all peripherals off)            | Reduced frequency (1 MHz) Flash access mode, regulator in low-power mode, LVD off. Internal oscillator can provide low-power 4 MHz source for core. (Values @2 MHz core/ 1 MHz bus and flash, module off, execution from flash).<br><br>Biasing is disabled when DC-DC is configured for continuous mode in VLPR/W | —                   | Radio operation is possible only when DC-DC is configured for continuous mode. <sup>1</sup> However, there may be insufficient MIPS with a 4 MHz MCU to support much in the way of radio operation. |
| VLPW (Very Low-power Wait) - via WFI (all peripherals off) | Similar to VLPR, with CPU in sleep to further reduce power. (Values @4 MHz core/ 1 MHz bus, module off)<br><br>Biasing is disabled when DC-DC is configured for continuous mode in VLPR/W  | Interrupt           |   |
| VLPS (Very Low-power Stop) via WFI                         | Places MCU in static state with LVD operation off. Lowest power mode with ADC and all pin interrupts functional. LPTMR, RTC, CMP can be operational.<br><br>Biasing is disabled when DC-DC is configured for continuous mode in VLPS.  | Interrupt           |   |
| LLS3 (Low Leakage Stop)                                    | State retention power mode. LLWU, LPTMR, RTC, CMP can be operational. All of the radio Sea of Gates(SOG) logic is in state retention.  | Wake-up Interrupt   | Radio SOG is in state retention in LLSx. The Bluetooth LE/Generic FSK DSM <sup>2</sup> logic can be active using the 32 kHz clock   |
| LLS2 (Low Leakage Stop)                                    | State retention power mode. LLWU, LPTMR, RTC, CMP can be operational. 16 KB or 32 KB of programmable RAM can be powered on. All of the radio SOG logic is in state retention.  | Wake-up Interrupt   |   |

Table continues on the next page...

**Table 8. Power modes (At 25 deg C) (continued)**

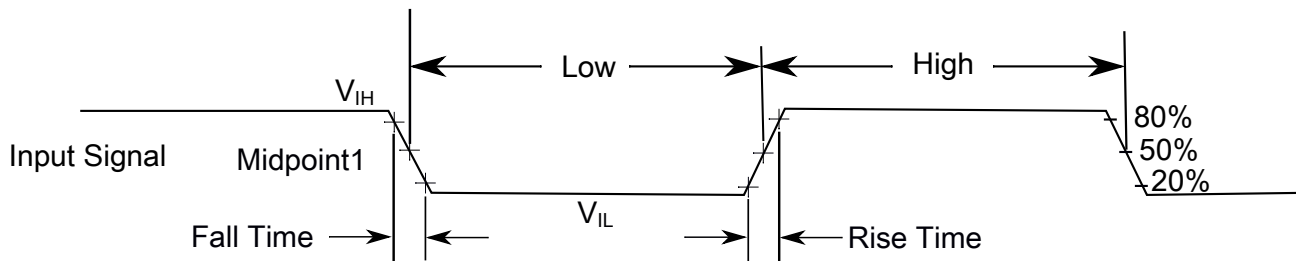
| Power mode   | Description   | CPU recovery method | Radio  |
|--|---|---------------------|--|
| VLLS3 (Very Low Leakage Stop3)                             | Full SRAM retention. LLWU, LPTMR, RTC, CMP can be operational. All of the radio SOG logic is in state retention.  | Wake-up<br>Reset    | Radio SOG is in state retention in VLLS3/2. The Bluetooth LE/Generic FSK DSM logic can be active using the 32 kHz clock.   |
| VLLS2 (Very Low Leakage Stop2)                             | Partial SRAM retention. 16 KB or 32 KB of programmable RAM can be powered on. LLWU, LPTMR, RTC, CMP can be operational. All of the radio SOG logic is in state retention.   | Wake-up<br>Reset    |  |
| VLLS1 (Very Low Leakage Stop1) with RTC + 32 kHz OSC       | All SRAM powered off. The 32-byte system register file remains powered for customer-critical data. LLWU, LPTMR, RTC, CMP can be operational. Radio logic is power gated.  | Wake-up<br>Reset    | Radio operation not supported. The Radio SOG is power-gated in VLLS1. Radio state is lost at VLLS1 and lower power states. |
| VLLS1 (Very Low Leakage Stop1) with LPTMR + LPO            | All SRAM powered off. The 32-byte system register file remains powered for customer-critical data. LLWU, LPTMR, RTC, CMP can be operational.  | Wake-up<br>Reset    |  |
| VLLS0 (Very Low Leakage Stop0) with Brown-out Detection    | VLLS0 is not supported with DC-DC.<br><br>The 32-byte system register file remains powered for customer-critical data. Disable all analog modules in PMC and retains I/O state and DGO state. LPO disabled, POR brown-out detection enabled, Pin interrupt only. Radio logic is power gated.  | Wake-up<br>Reset    | Radio operation not supported. The Radio digital is power-gated in VLLS0.  |
| VLLS0 (Very Low Leakage Stop0) without Brown-out Detection | VLLS0 is not supported with DC-DC buck configuration but is supported with bypass configuration.<br><br>The 32-byte system register file remains powered for customer-critical data. Disable all analog modules in PMC and retains I/O state and DGO state. LPO disabled, POR brown-out detection disabled, Pin interrupt only. Radio logic is power gated. | Wake-up<br>Reset    |  |

1. Biasing is disabled, but the Flash is in a low-power mode for VLPx, so this configuration can realize some power savings over use of Run/Wait/Stop.
2. DSM refers to Radio's deep sleep mode. DSM does not refer to the Arm sleep deep mode.

## 6 KW36A/35A/34A Electrical Characteristics

### 6.1 AC electrical characteristics

Unless otherwise specified, propagation delays are measured from the 50% to the 50% point, and rise and fall times are measured at the 20% and 80% points, as shown in the following figure.



The midpoint is  $V_{IL} + (V_{IH} - V_{IL}) / 2$

**Figure 6. Input signal measurement reference**

All digital I/O switching characteristics, unless otherwise specified, assume that the output pins have the following characteristics.

- $C_L=30$  pF loads
- Slew rate disabled
- Normal drive strength

## 6.2 Nonswitching electrical specifications

### 6.2.1 Voltage and current operating requirements

**Table 9. Voltage and current operating requirements**

| Symbol             | Description   | Min.  | Max.  | Unit   | Notes |
|--------------------|---|---|---|--------|-------|
| $V_{DD}$           | Supply voltage  | 1.71  | 3.6   | V      |       |
| $V_{DD\_1P5}$      | DCDC $V_{DD\_1P5}$ output pin   | 1.425                                       | 3.6   | V      | 1     |
| $V_{DDA}$          | Analog supply voltage   | 1.71  | 3.6   | V      |       |
| $V_{DD} - V_{DDA}$ | $V_{DD}$ -to- $V_{DDA}$ differential voltage  | -0.1  | 0.1   | V      |       |
| $V_{SS} - V_{SSA}$ | $V_{SS}$ -to- $V_{SSA}$ differential voltage  | -0.1  | 0.1   | V      |       |
| $V_{IH}$           | Input high voltage <ul style="list-style-type: none"> <li>• <math>2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}</math></li> <li>• <math>1.7\text{ V} \leq V_{DD} \leq 2.7\text{ V}</math></li> </ul> | $0.7 \times V_{DD}$<br>$0.75 \times V_{DD}$ | —<br>—                                      | V<br>V |       |
| $V_{IL}$           | Input low voltage <ul style="list-style-type: none"> <li>• <math>2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}</math></li> <li>• <math>1.7\text{ V} \leq V_{DD} \leq 2.7\text{ V}</math></li> </ul>  | —<br>—                                      | $0.35 \times V_{DD}$<br>$0.3 \times V_{DD}$ | V<br>V |       |
| $V_{HYS}$          | Input hysteresis  | $0.06 \times V_{DD}$                        | —   | V      |       |
| $I_{ICIO}$         | IO pin negative DC injection current — single pin <ul style="list-style-type: none"> <li>• <math>V_{IN} &lt; V_{SS}-0.3\text{V}</math></li> </ul>   | -3  | —   | mA     | 2     |

Table continues on the next page...



**Table 9. Voltage and current operating requirements (continued)**

| Symbol       | Description   | Min.     | Max.     | Unit | Notes |
|--------------|---|----------|----------|------|-------|
| $I_{ICcont}$ | Contiguous pin DC injection current —regional limit, includes sum of negative injection currents of 16 contiguous pins <ul style="list-style-type: none"> <li>Negative current injection</li> </ul> | -25      | —        | mA   |       |
| $V_{ODPU}$   | Open drain pullup voltage level   | $V_{DD}$ | $V_{DD}$ | V    | 3     |
| $V_{RAM}$    | $V_{DD}$ voltage required to retain RAM   | 1.2      | —        | V    |       |

- This limit applies in any DCDC mode.
- All I/O pins are internally clamped to  $V_{SS}$  through an ESD protection diode. There is no diode connection to  $V_{DD}$ . If  $V_{IN}$  greater than  $V_{IO\_MIN}$  ( $= V_{SS} - 0.3$  V) is observed, then there is no need to provide current limiting resistors at the pads. If this limit cannot be observed then a current limiting resistor is required. The negative DC injection current limiting resistor is calculated as  $R = (V_{IO\_MIN} - V_{IN}) / |I_{ICIO}|$ .
- Open drain outputs must be pulled to  $V_{DD}$ .

## 6.2.2 LVD and POR operating requirements

**Table 10.  $V_{DD}$  supply LVD and POR operating requirements**

| Symbol              | Description   | Min. | Typ. | Max. | Unit | Notes |
|---------------------|---|------|------|------|------|-------|
| $V_{POR}$           | Falling $V_{DD}$ POR detect voltage   | 0.8  | 1.1  | 1.5  | V    |       |
| $V_{POR\_VDD\_1P5}$ | $V_{DD\_1P5}$ POR threshold   | 1.25 | 1.31 | 1.37 | V    |       |
| $V_{LVDH}$          | Falling low-voltage detect threshold — high range (LVDV = 01)   | 2.48 | 2.56 | 2.64 | V    |       |
| $V_{LVW1H}$         | Low-voltage warning thresholds — high range <ul style="list-style-type: none"> <li>Level 1 falling (LVWV = 00)</li> </ul> | 2.62 | 2.70 | 2.78 | V    | 1     |
| $V_{LVW2H}$         | <ul style="list-style-type: none"> <li>Level 2 falling (LVWV = 01)</li> </ul>   | 2.72 | 2.80 | 2.88 | V    |       |
| $V_{LVW3H}$         | <ul style="list-style-type: none"> <li>Level 3 falling (LVWV = 10)</li> </ul>   | 2.82 | 2.90 | 2.98 | V    |       |
| $V_{LVW4H}$         | <ul style="list-style-type: none"> <li>Level 4 falling (LVWV = 11)</li> </ul>   | 2.92 | 3.00 | 3.08 | V    |       |
| $V_{HYSH}$          | Low-voltage inhibit reset/recover hysteresis — high range   | —    | ±60  | —    | mV   |       |
| $V_{LVDL}$          | Falling low-voltage detect threshold — low range (LVDV=00)  | 1.54 | 1.60 | 1.66 | V    |       |
| $V_{LVW1L}$         | Low-voltage warning thresholds — low range <ul style="list-style-type: none"> <li>Level 1 falling (LVWV = 00)</li> </ul>  | 1.74 | 1.80 | 1.86 | V    | 1     |
| $V_{LVW2L}$         | <ul style="list-style-type: none"> <li>Level 2 falling (LVWV = 01)</li> </ul>   | 1.84 | 1.90 | 1.96 | V    |       |
| $V_{LVW3L}$         | <ul style="list-style-type: none"> <li>Level 3 falling (LVWV = 10)</li> </ul>   | 1.94 | 2.00 | 2.06 | V    |       |
| $V_{LVW4L}$         | <ul style="list-style-type: none"> <li>Level 4 falling (LVWV = 11)</li> </ul>   | 2.04 | 2.10 | 2.16 | V    |       |
| $V_{HYSL}$          | Low-voltage inhibit reset/recover hysteresis — low range  | —    | ±40  | —    | mV   |       |

Table continues on the next page...

**Table 10.  $V_{DD}$  supply LVD and POR operating requirements (continued)**

| Symbol    | Description  | Min. | Typ. | Max. | Unit    | Notes |
|-----------|--|------|------|------|---------|-------|
| $V_{BG}$  | Bandgap voltage reference                              | 0.97 | 1.00 | 1.03 | V       |       |
| $t_{LPO}$ | Internal low-power oscillator period — factory trimmed | 900  | 1000 | 1100 | $\mu$ s |       |

1. Rising thresholds are falling threshold + hysteresis voltage

## 6.2.3 Voltage and current operating behaviors

**Table 11. Voltage and current operating behaviors**

| Symbol    | Description   | Min.           | Max.  | Unit       | Notes |
|-----------|---|----------------|-------|------------|-------|
| $V_{OH}$  | Output high voltage — Normal drive pad (except RESET_b) <ul style="list-style-type: none"> <li>• <math>2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}</math>, <math>I_{OH} = -5\text{ mA}</math></li> <li>• <math>1.71\text{ V} \leq V_{DD} \leq 2.7\text{ V}</math>, <math>I_{OH} = -2.5\text{ mA}</math></li> <li>• <math>1.71\text{ V} \leq V_{DD} \leq 2.7\text{ V}</math>, <math>I_{OH} = -1\text{ mA}</math></li> </ul> | $V_{DD} - 0.5$ | —     | V          | 1, 2  |
| $V_{OH}$  | Output high voltage — High drive pad (except RESET_b) <ul style="list-style-type: none"> <li>• <math>2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}</math>, <math>I_{OH} = -20\text{ mA}</math></li> <li>• <math>1.71\text{ V} \leq V_{DD} \leq 2.7\text{ V}</math>, <math>I_{OH} = -10\text{ mA}</math></li> </ul>   | $V_{DD} - 0.5$ | —     | V          | 1, 2  |
| $I_{OHT}$ | Output high current total for all ports   | —              | 100   | mA         |       |
| $V_{OL}$  | Output low voltage — Normal drive pad <ul style="list-style-type: none"> <li>• <math>2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}</math>, <math>I_{OL} = 5\text{ mA}</math></li> <li>• <math>1.71\text{ V} \leq V_{DD} \leq 2.7\text{ V}</math>, <math>I_{OL} = 2.5\text{ mA}</math></li> </ul>   | —              | 0.5   | V          | 1     |
| $V_{OL}$  | Output low voltage — High drive pad <ul style="list-style-type: none"> <li>• <math>2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}</math>, <math>I_{OL} = 20\text{ mA}</math></li> <li>• <math>1.71\text{ V} \leq V_{DD} \leq 2.7\text{ V}</math>, <math>I_{OL} = 10\text{ mA}</math></li> </ul>   | —              | 0.5   | V          | 1     |
| $I_{OLT}$ | Output low current total for all ports  | —              | 100   | mA         |       |
| $I_{IN}$  | Input leakage current (per pin) for full temperature range  | —              | 500   | nA         | 3     |
| $I_{IN}$  | Input leakage current (per pin) at 25 °C  | —              | 0.025 | $\mu$ A    | 3     |
| $I_{IN}$  | Input leakage current (total all pins) for full temperature range   | —              | 5     | $\mu$ A    | 3     |
| $R_{PU}$  | Internal pullup resistors   | 20             | 50    | k $\Omega$ | 4     |

1. PTB0-1 and PTC0-3, PTC6, PTC7, PTC17, PTC18 I/O have both high drive and normal drive capability selected by the associated PTx\_PCRn[DSE] control bit. All other GPIOs are normal drive only.
2. The reset pin only contains an active pull-up device when configured as the RESET signal or as a GPIO. When configured as a GPIO output, it acts as a pseudo open drain output.
3. Measured at  $V_{DD} = 3.6\text{ V}$ .

4. Measured at  $V_{DD}$  supply voltage =  $V_{DD}$  min and  $V_{input} = V_{SS}$ .

## 6.2.4 Power mode transition operating behaviors

All specifications except  $t_{POR}$  and  $VLLSx \rightarrow RUN$  recovery times in the following table assume this clock configuration:

- CPU and system clocks = 48 MHz
- Bus and flash clock = 24 MHz
- FEI clock mode

POR and  $VLLSx \rightarrow RUN$  recovery use FEI clock mode at the default CPU and system frequency of 21 MHz, and a bus and flash clock frequency of 10.5 MHz.

**Table 12. Power mode transition operating behaviors**

| Symbol    | Description   | Max.  | Unit    | Notes |
|-----------|---|-------|---------|-------|
| $t_{POR}$ | After a POR event, amount of time from the point $V_{DD}$ reaches 1.8 V to execution of the first instruction across the operating temperature range of the chip. | 300   | $\mu s$ | 1     |
|           | • $VLLS0 \rightarrow RUN$   | 169.0 | $\mu s$ |       |
|           | • $VLLS1 \rightarrow RUN$   | 168.9 | $\mu s$ |       |
|           | • $VLLS2 \rightarrow RUN$   | 97.3  | $\mu s$ |       |
|           | • $VLLS3 \rightarrow RUN$   | 97.3  | $\mu s$ |       |
|           | • $LLS \rightarrow RUN$   | 6.3   | $\mu s$ |       |
|           | • $VLPS \rightarrow RUN$  | 6.2   | $\mu s$ |       |
|           | • $STOP \rightarrow RUN$  | 6.2   | $\mu s$ |       |

1. Normal boot (FTFA\_FOPT[LPBOOT]=11). When the DC-DC converter is in bypass mode, TPOR will not meet the 300  $\mu s$  spec when 1)  $VDD\_1P5 < 1.6$  V at 25 °C and 125 °C. 2)  $1.5V \leq VDD\_1P5 \leq 1.8$  V. For the bypass mode special case where  $VDD\_1P5 = VDD\_1P8$ , TPOR did not meet the 300  $\mu s$  maximum spec when the supply slew rate  $\leq 100$  V/s.

## 6.2.5 Power consumption operating behaviors

**Table 13. Power consumption operating behaviors - Bypass Mode**

| Symbol                         | Description   | Typ.   | Max.     | Unit | Notes   |
|--------------------------------|---|--------|----------|------|---------|
| I <sub>DDA</sub>               | Analog supply current   | —      | See note | mA   | 1       |
| I <sub>DD_RUNCO_C<br/>M</sub>  | Run mode current in compute operation - 48 MHz core / 24 MHz flash / bus disabled, LPTMR running using LPO clock at 1kHz, CoreMark benchmark code executing from flash at 3.0 V                                       | 6.80   | 8.41     | mA   | 2, 3    |
| I <sub>DD_RUNCO</sub>          | Run mode current in compute operation - 48 MHz core / 24 MHz flash / bus clock disabled, code of while(1) loop executing from flash at 3.0 V  | 4.05   | 4.98     | mA   | 3, 4    |
| I <sub>DD_RUN</sub>            | Run mode current - 48 MHz core / 24 MHz bus and flash, all peripheral clocks disabled, code of while(1) loop executing from flash at 3.0 V  | 5.00   | 6.01     | mA   | 3, 4    |
| I <sub>DD_RUN</sub>            | Run mode current - 48 MHz core / 24 MHz bus and flash, all peripheral clocks enabled, code of while(1) loop executing from flash at 3.0 V   |        |          |      | 3, 4, 5 |
|                                | at 25 °C  | 6.48   | 6.70     | mA   |         |
|                                | at 70 °C  | 6.77   | 6.96     | mA   |         |
|                                | at 105 °C   | 7.13   | 7.90     | mA   |         |
| I <sub>DD_WAIT</sub>           | Wait mode current - core disabled / 48 MHz system / 24 MHz bus / flash disabled (flash doze enabled), all peripheral clocks disabled at 3.0 V   | 3.07   | 4.31     | mA   | 4       |
| I <sub>DD_WAIT</sub>           | Wait mode current - core disabled / 24 MHz system / 24 MHz bus / flash disabled (flash doze enabled), all peripheral clocks disabled at 3.0 V   | 2.29   | 3.15     | mA   | 4       |
| I <sub>DD_PSTOP2</sub>         | Stop mode current with partial stop 2 clocking option - core and system disabled / 10.5 MHz bus at 3.0 V  | 2.32   | 3.11     | mA   | 4       |
| I <sub>DD_VLPRCO_<br/>CM</sub> | Very-low-power run mode current in compute operation - 4 MHz core / 0.8 MHz flash / bus clock disabled, LPTMR running using LPO clock at 1 kHz reference clock, CoreMark benchmark code executing from flash at 3.0 V | 766.9  | 1538     | μA   | 6       |
| I <sub>DD_VLPRCO</sub>         | Very-low-power run mode current in compute operation - 4 MHz core / 0.8 MHz flash / bus clock disabled, code of while(1) loop executing from flash at 3.0 V   | 158.45 | 377      | μA   | 7       |
| I <sub>DD_VLPR</sub>           | Very-low-power run mode current - 4 MHz core / 0.8 MHz bus and flash, all peripheral clocks disabled, code of while(1) loop executing from flash at 3.0 V   | 185.26 | 410      | μA   | 7       |
| I <sub>DD_VLPR</sub>           | Very-low-power run mode current - 4 MHz core / 0.8 MHz bus and flash, all peripheral clocks enabled, code of while(1) loop executing from flash at 3.0 V  | 240.96 | 805.3    | μA   | 5, 7    |
| I <sub>DD_VLPW</sub>           | Very-low-power wait mode current - core disabled / 4 MHz system / 0.8 MHz bus / flash disabled (flash doze enabled), all peripheral clocks disabled at 3.0 V  | 133.95 | 552.8    | μA   | 7       |
| I <sub>DD_STOP</sub>           | Stop mode current at 3.0 V  |        |          |      |         |

Table continues on the next page...

**Table 13. Power consumption operating behaviors - Bypass Mode (continued)**

| Symbol                | Description  | Typ.                       | Max.                    | Unit           | Notes |
|-----------------------|--|----------------------------|-------------------------|----------------|-------|
|                       | at 25 °C<br>at 70 °C<br>at 105 °C  | 204.98<br>291.89<br>599.46 | 308.3<br>872.5<br>1662  | μA<br>μA<br>μA |       |
| I <sub>DD_VLPS</sub>  | Very-low-power stop mode current at Bypass mode(3.0 V),<br>at 25 °C<br>at 70 °C<br>at 105 °C                 | 6.4<br>30.64<br>157        | 18<br>76.6<br>328       | μA<br>μA<br>μA |       |
| I <sub>DD_LLS3</sub>  | Low-leakage stop mode 3 current at Bypass mode(3.0 V),<br>at 25 °C<br>at 70 °C<br>at 105 °C                  | 2.57<br>11.76<br>50.92     | 4.31<br>26.07<br>105.4  | μA<br>μA<br>μA |       |
| I <sub>DD_LLS2</sub>  | Low-leakage stop mode 2 current at Bypass mode(3.0 V),<br>at 25 °C<br>at 70 °C<br>at 105 °C                  | 2.35<br>9.74<br>42.34      | 3.30<br>21.40<br>80.23  | μA<br>μA<br>μA |       |
| I <sub>DD_VLLS3</sub> | Very-low-leakage stop mode 3 current at Bypass mode(3.0 V),<br>at 25 °C<br>at 70 °C<br>at 105 °C             | 2.13<br>10.78<br>46.70     | 3.3<br>22.97<br>83.54   | μA<br>μA<br>μA |       |
| I <sub>DD_VLLS2</sub> | Very-low-leakage stop mode 2 current at Bypass mode(3.0 V),<br>at 25 °C<br>at 70 °C<br>at 105 °C             | 1.84<br>7.88<br>34.76      | 2.40<br>15.19<br>57.85  | μA<br>μA<br>μA |       |
| I <sub>DD_VLLS1</sub> | Very-low-leakage stop mode 1 current at Bypass mode(3.0 V),<br>at 25°C<br>at 70°C<br>at 105°C                | 851.45<br>3.57<br>17.62    | 1027.8<br>6.28<br>23.06 | nA<br>μA<br>μA |       |
| I <sub>DD_VLLS0</sub> | Very-low-leakage stop mode 0 current (SMC_STOPCTRL[PORPO] = 0) at 3.0 V<br>at 25 °C<br>at 70 °C<br>at 105 °C | 433.00<br>3.15<br>17.2     | 720.3<br>6.14<br>23.2   | nA<br>μA<br>μA |       |

Table continues on the next page...

**Table 13. Power consumption operating behaviors - Bypass Mode (continued)**

| Symbol                | Description   | Typ.   | Max.   | Unit | Notes |
|-----------------------|---|--------|--------|------|-------|
| I <sub>DD_VLLS0</sub> | Very-low-leakage stop mode 0 current (SMC_STOPCTRL[PORPO] = 1) at 3.0 V |        |        |      | 8     |
|                       | at 25 °C  | 258.12 | 516.43 | nA   |       |
|                       | at 70 °C  | 2.97   | 5.81   | μA   |       |
|                       | at 105 °C   | 16.9   | 22.4   | μA   |       |

1. The analog supply current is the sum of the active or disabled current for each of the analog modules on the device. See each module's specification for its supply current.
2. MCG configured for FEI mode. CoreMark benchmark compiled using IAR 7.70 with optimization level high, optimized for balanced.
3. Radio is off.
4. MCG configured for FEI mode.
5. Incremental current consumption from peripheral activity is not included.
6. MCG configured for BLPI mode. CoreMark benchmark compiled using IAR 7.70 with optimization level high, optimized for balanced.
7. MCG configured for BLPI mode.
8. No brownout.

**Table 14. Power consumption operating behaviors - Buck Mode<sup>1</sup>**

| Symbol                 | Description   | Typ.      | Max.     | Unit | Notes   |    |
|------------------------|---|-----------|----------|------|---------|----|
| I <sub>DDA</sub>       | Analog supply current   | —         | See note | mA   | 2       |    |
| I <sub>DD_RUNCO</sub>  | Run mode current in compute operation - 48 MHz core / 24 MHz flash / bus clock disabled, code of while(1) loop executing from flash at 3.0 V                | 3.51      | —        | mA   | 3, 4    |    |
| I <sub>DD_RUN</sub>    | Run mode current - 48 MHz core / 24 MHz bus and flash, all peripheral clocks disabled, code of while(1) loop executing from flash at 3.0 V                  | 4.00      | —        | mA   | 3, 4    |    |
| I <sub>DD_RUN</sub>    | Run mode current - 48 MHz core / 24 MHz bus and flash, all peripheral clocks enabled, code of while(1) loop executing from flash at 3.0 V                   |           |          |      | 3, 4, 5 |    |
|                        |   | at 25 °C  | 5.81     | —    |         | mA |
|                        |   | at 70 °C  | 5.92     | —    |         | mA |
|                        |   | at 105 °C | 6.36     | —    |         | mA |
| I <sub>DD_WAIT</sub>   | Wait mode current - core disabled / 48 MHz system / 24 MHz bus / flash disabled (flash doze enabled), all peripheral clocks disabled at 3.0 V               | 2.97      | —        | mA   | 3       |    |
| I <sub>DD_WAIT</sub>   | Wait mode current - core disabled / 24 MHz system / 24 MHz bus / flash disabled (flash doze enabled), all peripheral clocks disabled at 3.0 V               | 2.51      | —        | mA   | 3       |    |
| I <sub>DD_PSTOP2</sub> | Stop mode current with partial stop 2 clocking option - core and system disabled / 10.5 MHz bus at 3.0 V  | 2.33      | —        | mA   | 3       |    |
| I <sub>DD_VLPRCO</sub> | Very-low-power run mode current in compute operation - 4 MHz core / 0.8 MHz flash / bus clock disabled, code of while(1) loop executing from flash at 3.0 V | 101.75    | —        | μA   | 6       |    |

Table continues on the next page...

Table 14. Power consumption operating behaviors - Buck Mode1 (continued)

| Symbol                | Description  | Typ.   | Max.   | Unit | Notes |
|-----------------------|--|--------|--------|------|-------|
| I <sub>DD_VLPR</sub>  | Very-low-power run mode current - 4 MHz core / 0.8 MHz bus and flash, all peripheral clocks disabled, code of while(1) loop executing from flash at 3.0 V    | 132.17 | —      | μA   | 6     |
| I <sub>DD_VLPR</sub>  | Very-low-power run mode current - 4 MHz core / 0.8 MHz bus and flash, all peripheral clocks enabled, code of while(1) loop executing from flash at 3.0 V     | 167.65 | —      | μA   | 5, 6  |
| I <sub>DD_VLPW</sub>  | Very-low-power wait mode current - core disabled / 4 MHz system / 0.8 MHz bus / flash disabled (flash doze enabled), all peripheral clocks disabled at 3.0 V | 105.72 | —      | μA   | 6     |
| I <sub>DD_STOP</sub>  | Stop mode current at 3.0 V   |        |        |      |       |
|                       | at 25 °C   | 1.43   | 2.32   | mA   |       |
|                       | at 70 °C   | 1.56   | 4.35   | mA   |       |
|                       | at 105 °C  | 1.99   | 4.68   | mA   |       |
| I <sub>DD_VLPS</sub>  | Very-low-power stop mode current at Buck mode(3.0 V),  |        |        |      | 7     |
|                       | at 25 °C   | 4.18   | 14.98  | μA   |       |
|                       | at 70 °C   | 44.30  | 110    | μA   |       |
|                       | at 105 °C  | 218.64 | 446    | μA   |       |
| I <sub>DD_LLS3</sub>  | Low-leakage stop mode 3 current at Buck mode(3.0 V),   |        |        |      | 7     |
|                       | at 25 °C   | 2.64   | 4.89   | μA   |       |
|                       | at 70 °C   | 15.27  | 25.51  | μA   |       |
|                       | at 105 °C  | 81.93  | 104.35 | μA   |       |
| I <sub>DD_LLS2</sub>  | Low-leakage stop mode 2 current at Buck mode(3.0 V),   |        |        |      | 7     |
|                       | at 25 °C   | 2.46   | 3.80   | μA   |       |
|                       | at 70 °C   | 10.14  | 21.14  | μA   |       |
|                       | at 105 °C  | 63.49  | 80.21  | μA   |       |
| I <sub>DD_VLLS3</sub> | Very-low-leakage stop mode 3 current at Buck mode(3.0 V),  |        |        |      | 7     |
|                       | at 25 °C   | 2.03   | 3.28   | μA   |       |
|                       | at 70 °C   | 12.44  | 23.8   | μA   |       |
|                       | at 105 °C  | 62.23  | 83.9   | μA   |       |
| I <sub>DD_VLLS2</sub> | Very-low-leakage stop mode 2 current at Buck mode(3.0 V),  |        |        |      | 7     |
|                       | at 25 °C   | 1.79   | 2.43   | μA   |       |
|                       | at 70 °C   | 8.87   | 16.7   | μA   |       |
|                       | at 105 °C  | 49.39  | 62.94  | μA   |       |
| I <sub>DD_VLLS1</sub> | Very-low-leakage stop mode 1 current at Buck mode(3.0 V),  |        |        |      | 7     |

**Table 14. Power consumption operating behaviors - Buck Mode1**

| Symbol | Description | Typ.  | Max.  | Unit | Notes |
|--------|-------------|-------|-------|------|-------|
|        | at 25 °C    | 0.830 | 1.07  | μA   |       |
|        | at 70 °C    | 4.95  | 10.67 | μA   |       |
|        | at 105 °C   | 27.51 | 36.14 | μA   |       |

1. The device was configured in buck mode auto-start to perform the measurements. The DCDC\_IN was powered with 3.0 V. VDD\_1P8OUT was configured to output 1.8 V and VDD\_1P5OUT\_PMCIN was configured to output 1.5 V.
2. The analog supply current is the sum of the active or disabled current for each of the analog modules on the device. See each module's specification for its supply current.
3. MCG configured for FEI mode.
4. Radio is off.
5. Incremental current consumption from peripheral activity is not included.
6. MCG configured for BLPI mode.
7. DCDC configured in pulsed mode.

**Table 15. Low power mode peripheral adders — typical value (Bypass Mode)**

| Symbol                    | Description  | Temperature (°C) |     |     |     |      | Unit |
|---------------------------|--|------------------|-----|-----|-----|------|------|
|                           |  | -40              | 25  | 50  | 70  | 85   |      |
| I <sub>REFSTEN4MHZ</sub>  | 4 MHz internal reference clock (IRC) adder. Measured by entering STOP or VLPS mode with 4 MHz IRC enabled.   | 46               | 46  | 47  | 47  | 47   | μA   |
| I <sub>REFSTEN32KHz</sub> | 32 kHz internal reference clock (IRC) adder. Measured by entering STOP mode with the 32 kHz IRC enabled.   | 88               | 91  | 90  | 89  | 88   | μA   |
| I <sub>REFSTEN32KHz</sub> | External 32 kHz crystal clock adder by means of the RTC bits. Measured by entering all modes with the crystal enabled.   |                  |     |     |     |      |      |
|                           | VLLS1  | 1.4              | 1.3 | 1.6 | 2.4 | 4.1  | μA   |
|                           | VLLS2  | 1.6              | 1.5 | 1.9 | 4.2 | 7.7  |      |
|                           | VLLS3  | 2.7              | 1.9 | 2.9 | 7.7 | 15   |      |
|                           | LLS2   | 1.8              | 1.4 | 1.7 | 4.1 | 8    |      |
|                           | LLS3   | 2.6              | 1.7 | 2.8 | 7.6 | 15.2 |      |
| I <sub>CMP</sub>          | CMP peripheral adder measured by placing the device in VLLS1 mode with CMP enabled using the 6-bit DAC and a single external input for compare. Includes 6-bit DAC power consumption.  | 22               | 19  | 20  | 21  | 21   | μA   |
| I <sub>RTC</sub>          | RTC peripheral adder measured by placing the device in VLLS1 mode with external 32 kHz crystal enabled by means of the RTC_CR[OSCE] bit and the RTC ALARM set for 1 minute. Includes ERCLK32K (32 kHz external crystal) power consumption. | 1.4              | 1.3 | 1.6 | 2.4 | 4.3  | μA   |
| I <sub>LPUART</sub>       | LPUART peripheral adder measured by placing the device in STOP or VLPS mode  |                  |     |     |     |      |      |

Table continues on the next page...



**Table 15. Low power mode peripheral adders — typical value (Bypass Mode) (continued)**

| Symbol      | Description   | Temperature (°C) |     |     |     |     | Unit |
|-------------|---|------------------|-----|-----|-----|-----|------|
|             |   | -40              | 25  | 50  | 70  | 85  |      |
|             | with selected clock source waiting for RX data at 115200 baud rate. Includes selected clock source power consumption.<br>MCGIRCLK (4 MHz internal reference clock)  | 53               | 54  | 54  | 54  | 54  | μA   |
| $I_{LPTMR}$ | LPTMR peripheral adder measured by placing the device in VLLS1 mode with LPTMR enabled using LPO.   | 30               | 30  | 30  | 85  | 100 | nA   |
| $I_{TPM}$   | TPM peripheral adder measured by placing the device in STOP or VLPS mode with selected clock source configured for output compare generating 100 Hz clock signal. No load is placed on the I/O generating the clock signal. Includes selected clock source and I/O switching currents.<br>MCGIRCLK (4 MHz internal reference clock) | 58               | 59  | 59  | 59  | 59  | μA   |
| $I_{BG}$    | Bandgap adder when BGEN bit is set and device is placed in VLPx, LLS, or VLLSx mode.  | 76               | 82  | 85  | 87  | 87  | μA   |
| $I_{ADC}$   | ADC peripheral adder combining the measured values at $V_{DD}$ and $V_{DDA}$ by placing the device in STOP or VLPS mode. ADC is configured for low-power mode using the internal clock and continuous conversions.  | 331              | 327 | 327 | 327 | 328 | μA   |

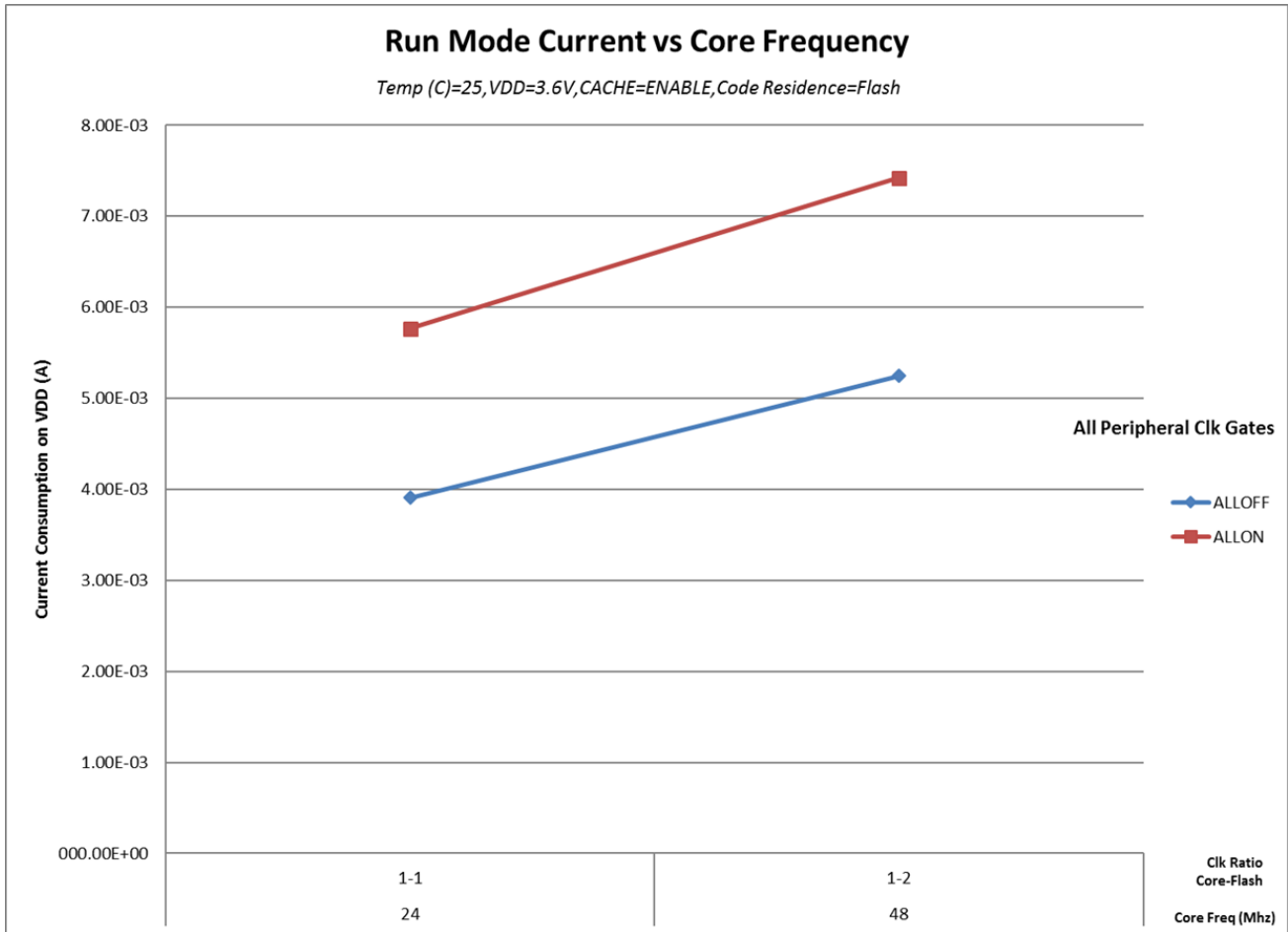
## 6.2.6 Diagram: Typical $I_{DD\_RUN}$ operating behavior

The following data is measured from previous devices with same MCU core (Arm® Cortex-M0+) under these conditions:

- No GPIOs toggled
- Code execution from flash with cache enabled
- For the ALLOFF curve, all peripheral clocks are disabled except FTFA

**NOTE**

The results in the following graphs are obtained using the device in Bypass mode.



**Figure 7. Run mode supply current vs. core frequency**

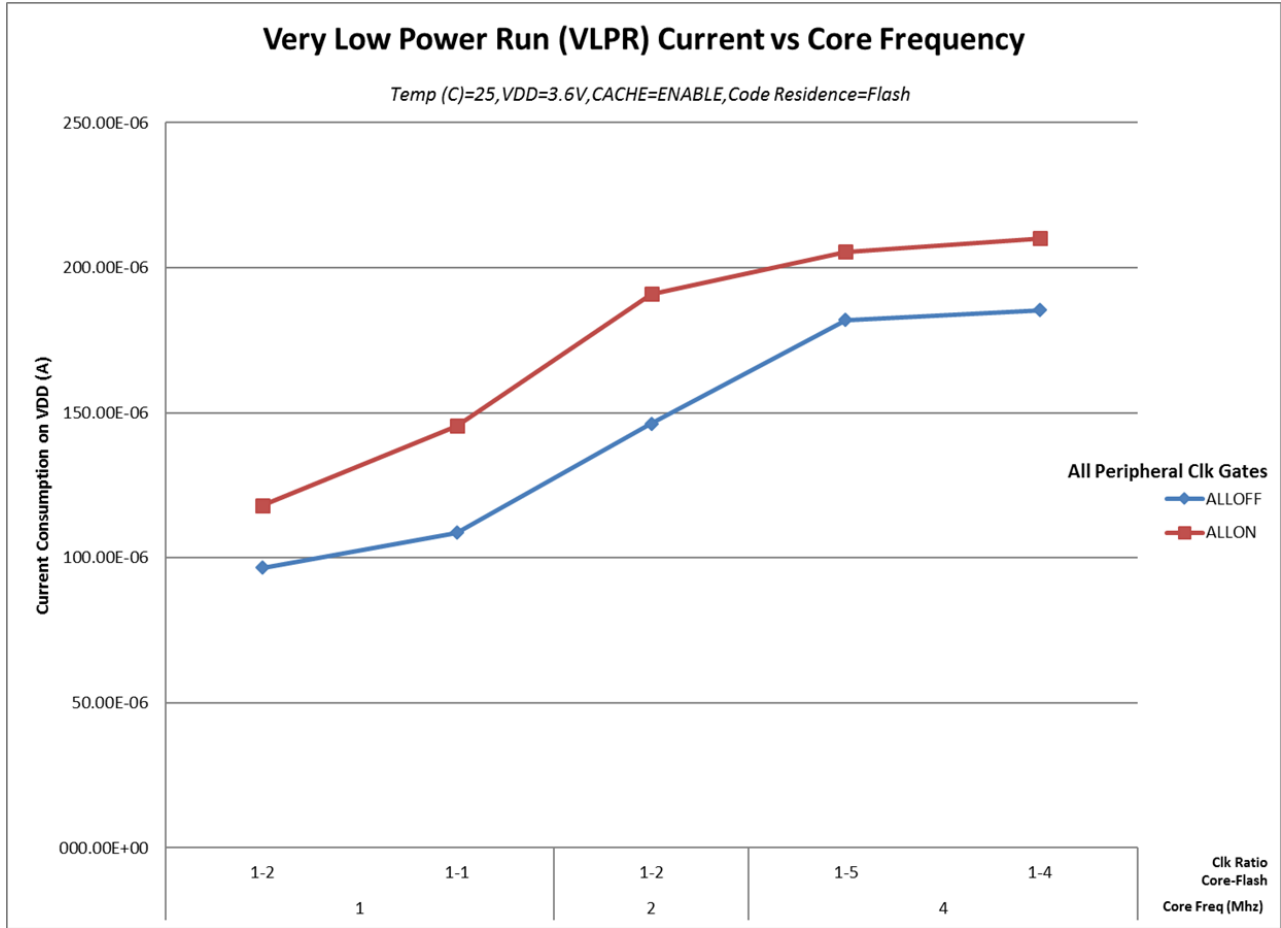


Figure 8. VLPR mode current vs. core frequency

### 6.2.7 SoC Power Consumption

Full KW36A/35A/34A system-on-chip (SoC) power consumption is a function of the many configurations possible for the MCU platform and its peripherals including the 2.4 GHz radio and the DC-DC converter. A few measured SoC configurations are as follows:

Table 16. SoC Power Consumption with default LDO-HF

| MCU State | Flash State | Radio State      | DC-DC State                        | Typical Average IC current | Unit |
|-----------|-------------|------------------|------------------------------------|----------------------------|------|
| STOP      | Doze        | Rx               | Buck (V <sub>DCDC_IN</sub> =3.6 V) | 8.5                        | mA   |
| STOP      | Doze        | Tx (at 0 dBm)    | Buck (V <sub>DCDC_IN</sub> =3.6 V) | 7.8                        | mA   |
| STOP      | Doze        | Tx (at +3.5 dBm) | Buck (V <sub>DCDC_IN</sub> =3.6 V) | 9.2                        | mA   |

Table continues on the next page...

**Table 16. SoC Power Consumption with default LDO-HF (continued)**

| MCU State | Flash State | Radio State      | DC-DC State                          | Typical Average IC current | Unit |
|-----------|-------------|------------------|--------------------------------------|----------------------------|------|
| RUN       | Enabled     | Rx               | Buck ( $V_{DCDC\_IN}=3.6\text{ V}$ ) | 10.4                       | mA   |
| RUN       | Enabled     | Tx (at 0 dBm)    | Buck ( $V_{DCDC\_IN}=3.6\text{ V}$ ) | 9.9                        | mA   |
| RUN       | Enabled     | Tx (at +3.5 dBm) | Buck ( $V_{DCDC\_IN}=3.6\text{ V}$ ) | 11.7                       | mA   |
| STOP      | Doze        | Rx               | Disabled/Bypass                      | 17.3                       | mA   |
| STOP      | Doze        | Tx (at 0 dBm)    | Disabled/Bypass                      | 15.9                       | mA   |
| STOP      | Doze        | Tx (at +3.5 dBm) | Disabled/Bypass                      | 18.3                       | mA   |
| RUN       | Enabled     | Rx               | Disabled/Bypass                      | 21.5                       | mA   |
| RUN       | Enabled     | Tx (at 0 dBm)    | Disabled/Bypass                      | 19.9                       | mA   |
| RUN       | Enabled     | Tx (at +3.5 dBm) | Disabled/Bypass                      | 22.4                       | mA   |

**Table 17. SoC Power Consumption with LDO-HF bumped**

| MCU State | Flash State | Radio State                | DC-DC State                          | Typical Average IC current | Unit |
|-----------|-------------|----------------------------|--------------------------------------|----------------------------|------|
| STOP      | Doze        | Rx (LDO-HF Bumped)         | Buck ( $V_{DCDC\_IN}=3.6\text{ V}$ ) | 8.7                        | mA   |
| STOP      | Doze        | Tx (LDO-HF Bumped, +5 dBm) | Buck ( $V_{DCDC\_IN}=3.6\text{ V}$ ) | 10.3                       | mA   |
| RUN       | Enabled     | Rx (LDO-HF Bumped)         | Buck ( $V_{DCDC\_IN}=3.6\text{ V}$ ) | 11.3                       | mA   |
| RUN       | Enabled     | Tx (LDO-HF Bumped, +5 dBm) | Buck ( $V_{DCDC\_IN}=3.6\text{ V}$ ) | 13.1                       | mA   |
| STOP      | Doze        | Rx (LDO-HF Bumped)         | Disabled/Bypass (3.6 V)              | 18.2                       | mA   |
| STOP      | Doze        | Tx (LDO-HF Bumped, +5 dBm) | Disabled/Bypass (3.6 V)              | 20.8                       | mA   |
| RUN       | Enabled     | Rx (LDO-HF Bumped)         | Disabled/Bypass (3.6 V)              | 22.6                       | mA   |
| RUN       | Enabled     | Tx (LDO-HF Bumped, +5 dBm) | Disabled/Bypass (3.6 V)              | 26.6                       | mA   |

## 6.2.8 Designing with radiated emissions in mind

To find application notes that provide guidance on designing your system to minimize interference from radiated emissions:

1. Go to [www.nxp.com](http://www.nxp.com)
2. Perform a keyword search for “EMC design.”

## 6.2.9 Capacitance attributes

Table 18. Capacitance attributes

| Symbol   | Description       | Min. | Max. | Unit |
|----------|-------------------|------|------|------|
| $C_{IN}$ | Input capacitance | —    | 7    | pF   |

## 6.3 Switching electrical specifications

### 6.3.1 Device clock specifications

Table 19. Device clock specifications

| Symbol                           | Description                    | Min. | Max. | Unit |
|----------------------------------|--------------------------------|------|------|------|
| Normal run mode                  |                                |      |      |      |
| $f_{SYS}$                        | System and core clock          | —    | 48   | MHz  |
| $f_{BUS}$                        | Bus clock                      | —    | 24   | MHz  |
| $f_{FLASH}$                      | Flash clock                    | —    | 24   | MHz  |
| $f_{LPTMR}$                      | LPTMR clock                    | —    | 24   | MHz  |
| VLPR and VLPS modes <sup>1</sup> |                                |      |      |      |
| $f_{SYS}$                        | System and core clock          | —    | 4    | MHz  |
| $f_{BUS}$                        | Bus clock                      | —    | 1    | MHz  |
| $f_{FLASH}$                      | Flash clock                    | —    | 1    | MHz  |
| $f_{LPTMR}$                      | LPTMR clock <sup>2</sup>       | —    | 24   | MHz  |
| $f_{ERCLK}$                      | External reference clock       | —    | 16   | MHz  |
| $f_{LPTMR\_ERCLK}$               | LPTMR external reference clock | —    | 16   | MHz  |
| $f_{TPM}$                        | TPM asynchronous clock         | —    | 8    | MHz  |
| $f_{LPUART0}$                    | LPUART0 asynchronous clock     | —    | 12   | MHz  |

1. The frequency limitations in VLPR and VLPS modes here override any frequency specification listed in the timing specification for any other module. These same frequency limits apply to VLPS, whether VLPS entered from RUN or from VLPR.
2. The LPTMR can be clocked at this speed in VLPR or VLPS only when the source is an external pin.

### 6.3.2 General switching specifications

These general-purpose specifications apply to all signals configured for GPIO, LPUART, CAN (for KW36A only), CMT and I<sup>2</sup>C signals.

**Table 20. General switching specifications**

| Description  | Min. | Max. | Unit             | Notes |
|--|------|------|------------------|-------|
| GPIO pin interrupt pulse width (digital glitch filter disabled)<br>— Synchronous path                          | 1.5  | —    | Bus clock cycles | 1, 2  |
| NMI_b pin interrupt pulse width (analog filter enabled) —<br>Asynchronous path                                 | 200  | —    | ns               | 3     |
| GPIO pin interrupt pulse width (digital glitch filter disabled,<br>analog filter disabled) — Asynchronous path | 20   | —    | ns               | 3     |
| External RESET_b input pulse width (digital glitch filter<br>disabled)   | 100  | —    | ns               |       |
| Port rise and fall time(high drive strength)   |      |      |                  | 4, 5  |
| • Slew enabled   | —    | 25   | ns               |       |
| • 1.71 ≤ VDD ≤ 2.7 V   | —    | 16   | ns               |       |
| • 2.7 ≤ VDD ≤ 3.6 V  |      |      |                  |       |
| • Slew disabled  | —    | 8    | ns               |       |
| • 1.71 ≤ VDD ≤ 2.7 V   | —    | 6    | ns               |       |
| • 2.7 ≤ VDD ≤ 3.6 V  |      |      |                  |       |
| Port rise and fall time(low drive strength)  |      |      |                  | 6, 7  |
| • Slew enabled   |      | 24   | ns               |       |
| • 1.71 ≤ VDD ≤ 2.7 V   | —    | 16   | ns               |       |
| • 2.7 ≤ VDD ≤ 3.6 V  |      |      |                  |       |
| • Slew disabled  |      | 10   | ns               |       |
| • 1.71 ≤ VDD ≤ 2.7 V   | —    | 6    | ns               |       |
| • 2.7 ≤ VDD ≤ 3.6 V  |      |      |                  |       |

1. This is the minimum pulse width that is guaranteed to pass through the pin synchronization circuitry in run modes.
2. The greater of synchronous and asynchronous timing must be met.
3. This is the minimum pulse width that is guaranteed to be recognized.
4. PTB0, PTB1, PTC0, PTC1, PTC2, PTC3, PTC6, PTC7, PTC17, PTC18.
5. 75 pF load.
6. Ports A, B, and C.
7. 25 pF load.

## 6.4 Thermal specifications

### 6.4.1 Thermal operating requirements

**Table 21. Thermal operating requirements**

| Symbol         | Description              | Min. | Max. | Unit | Notes |
|----------------|--------------------------|------|------|------|-------|
| T <sub>J</sub> | Die junction temperature | −40  | 125  | °C   |       |
| T <sub>A</sub> | Ambient temperature      | −40  | 105  | °C   | 1     |

1. Maximum T<sub>A</sub> can be exceeded only if the user ensures that T<sub>J</sub> does not exceed the maximum. The simplest method to determine T<sub>J</sub> is:  $T_J = T_A + R_{\theta JA} \times \text{chip power dissipation}$ .

## 6.4.2 Thermal attributes

**Table 22. Thermal attributes**

| Board type        | Symbol          | Description  | 48-pin LQFN | 40-pin "Wettable" HVQFN | 48-pin "Wettable" HVQFN | Unit | Notes |
|-------------------|-----------------|--|-------------|-------------------------|-------------------------|------|-------|
| Four-layer (2s2p) | $R_{\theta JA}$ | Thermal resistance, junction to ambient (natural convection)                     | 48.3        | 19.2                    | 21.6                    | °C/W | 1, 2  |
| —                 | $\Psi_{JT}$     | Thermal characterization parameter, junction to package top (natural convection) | 0.5         | 0.1                     | 0.2                     | °C/W | 1, 3  |

1. Junction temperature is a function of die size, on-chip power dissipation, package thermal resistance, mounting site (board) temperature, ambient temperature, air flow, power dissipation of other components on the board, and board construction.
2. Determined according to JEDEC Standard JESD51-2A.
3. Thermal characterization parameter indicating the temperature difference between the package top and the junction temperature per JEDEC JESD51-2A.

The thermal characterization parameter ( $\Psi_{JT}$ ) is used to determine the junction temperature with a measurement of the temperature at the top of the package case using the following equation:

$$T_J = T_T + \Psi_{JT} \times \text{chip power dissipation}$$

where  $T_T$  is the thermocouple temperature at the top of the package.

## 6.5 Peripheral operating requirements and behaviors

### 6.5.1 Core modules

#### 6.5.1.1 SWD electricals

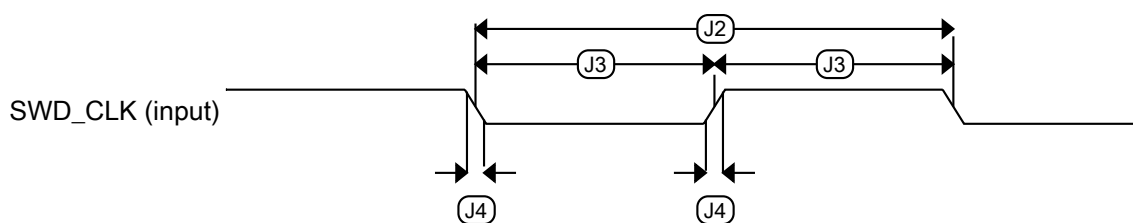
**Table 23. SWD full voltage range electricals**

| Symbol | Description  | Min. | Max. | Unit |
|--------|--|------|------|------|
|        | Operating voltage  | 1.71 | 3.6  | V    |
| J1     | SWD_CLK frequency of operation <ul style="list-style-type: none"> <li>• Serial wire debug</li> </ul> | 0    | 25   | MHz  |
| J2     | SWD_CLK cycle period   | 1/J1 | —    | ns   |

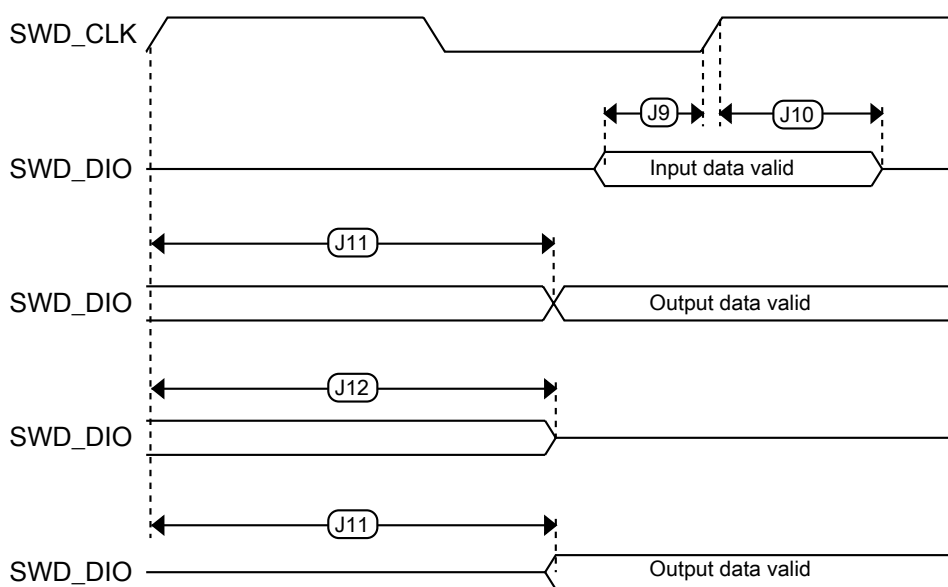
*Table continues on the next page...*

**Table 23. SWD full voltage range electricals (continued)**

| Symbol | Description                                      | Min. | Max. | Unit |
|--------|--|------|------|------|
| J3     | SWD_CLK clock pulse width<br>• Serial wire debug | 20   | —    | ns   |
| J4     | SWD_CLK rise and fall times                      | —    | 3    | ns   |
| J9     | SWD_DIO input data setup time to SWD_CLK rise    | 10   | —    | ns   |
| J10    | SWD_DIO input data hold time after SWD_CLK rise  | 0    | —    | ns   |
| J11    | SWD_CLK high to SWD_DIO data valid               | —    | 32   | ns   |
| J12    | SWD_CLK high to SWD_DIO high-Z                   | 5    | —    | ns   |



**Figure 9. Serial wire clock input timing**



**Figure 10. Serial wire data timing**



## 6.5.2 System modules

There are no specifications necessary for the device's system modules.

## 6.5.3 Clock modules

### 6.5.3.1 MCG specifications

Table 24. MCG specifications

| Symbol                   | Description   | Min.  | Typ.      | Max.    | Unit             | Notes |      |
|--------------------------|---|---|-----------|---------|------------------|-------|------|
| $f_{ints\_ft}$           | Internal reference frequency (slow clock) — factory trimmed at nominal $V_{DD}$ and 25 °C   | —   | 32.768    | —       | kHz              |       |      |
| $f_{ints\_t}$            | Internal reference frequency (slow clock) — user trimmed  | 31.25   | —         | 39.0625 | kHz              |       |      |
| $\Delta f_{dco\_res\_t}$ | Resolution of trimmed average DCO output frequency at fixed voltage and temperature — using C3[SCTRIM] and C4[SCFTRIM]                    | —   | ± 0.3     | ± 0.6   | % $f_{dco}$      | 1     |      |
| $\Delta f_{dco\_t}$      | Total deviation of trimmed average DCO output frequency over voltage and temperature  | —   | +0.5/−0.7 | ± 3     | % $f_{dco}$      | 1, 2  |      |
| $\Delta f_{dco\_t}$      | Total deviation of trimmed average DCO output frequency over fixed voltage and temperature range of 0–70 °C                               | —   | ± 0.4     | ± 1.5   | % $f_{dco}$      | 1, 2  |      |
| $f_{intf\_ft}$           | Internal reference frequency (fast clock) — factory trimmed at nominal $V_{DD}$ and 25 °C   | —   | 4         | —       | MHz              |       |      |
| $\Delta f_{intf\_ft}$    | Frequency deviation of internal reference clock (fast clock) over temperature and voltage — factory trimmed at nominal $V_{DD}$ and 25 °C | —   | +1/−2     | ± 3     | % $f_{intf\_ft}$ | 2     |      |
| $f_{intf\_t}$            | Internal reference frequency (fast clock) — user trimmed at nominal $V_{DD}$ and 25 °C  | 3   | —         | 5       | MHz              |       |      |
| $f_{loc\_low}$           | Loss of external clock minimum frequency — RANGE = 00   | $(3/5) \times f_{ints\_t}$                          | —         | —       | kHz              |       |      |
| $f_{loc\_high}$          | Loss of external clock minimum frequency — RANGE = 01, 10, or 11  | $(16/5) \times f_{ints\_t}$                         | —         | —       | kHz              |       |      |
| FLL                      |   |   |           |         |                  |       |      |
| $f_{fill\_ref}$          | FLL reference frequency range   | 31.25   | —         | 39.0625 | kHz              |       |      |
| $f_{dco}$                | DCO output frequency range  | Low range (DRS = 00)<br>$640 \times f_{fill\_ref}$  | 20        | 20.97   | 25               | MHz   | 3, 4 |
|                          |   | Mid range (DRS = 01)<br>$1280 \times f_{fill\_ref}$ | 40        | 41.94   | 48               | MHz   |      |
| $f_{dco\_t\_DMX3}$<br>2  | DCO output frequency  | Low range (DRS = 00)<br>$732 \times f_{fill\_ref}$  | —         | 23.99   | —                | MHz   | 5, 6 |
|                          |   | Mid range (DRS = 01)<br>$1464 \times f_{fill\_ref}$ | —         | 47.97   | —                | MHz   |      |

Table continues on the next page...

**Table 24. MCG specifications (continued)**

| Symbol             | Description                               | Min. | Typ. | Max. | Unit | Notes |
|--------------------|---|------|------|------|------|-------|
| $J_{cyc\_fll}$     | FLL period jitter<br>• $f_{VCO} = 48$ MHz | —    | 180  | —    | ps   | 7     |
| $t_{fll\_acquire}$ | FLL target frequency acquisition time     | —    | —    | 1    | ms   | 8     |

1. This parameter is measured with the internal reference (slow clock) being used as a reference to the FLL (FEI clock mode).
2. The deviation is relative to the factory trimmed frequency at nominal  $V_{DD}$  and 25 °C,  $f_{ints\_ft}$ .
3. These typical values listed are with the slow internal reference clock (FEI) using factory trim and DMX32 = 0.
4. The resulting system clock frequencies must not exceed their maximum specified values. The DCO frequency deviation ( $\Delta f_{dco\_t}$ ) over voltage and temperature must be considered.
5. These typical values listed are with the slow internal reference clock (FEI) using factory trim and DMX32 = 1.
6. The resulting clock frequency must not exceed the maximum specified clock frequency of the device.
7. This specification is based on standard deviation (RMS) of period or frequency.
8. This specification applies to any time the following changes: FLL reference source or reference divider, trim value, DMX32 bit, DRS bits, or FLL disabled (BLPE, BLPI) to FLL enabled (FEI, FEE, FBE, FBI). If a crystal/resonator is used as the reference, this specification assumes it is already running.

### 6.5.3.2 Reference Oscillator Specification

The KW36A/35A/34A has been designed to meet targeted standard specifications for frequency error over the life of the part, which includes the temperature, mechanical and aging effects.

The table below lists the recommended crystal specifications. Note that these are recommendations only and deviation may be allowed. However, deviations may result in degraded RF performance or possibly a failure to meet RF protocol certification standards. Designers must ensure that the crystal(s) they use meet the requirements of their application.

**Table 25. Recommended Crystal and Oscillator Specification**

| Symbol | Description                           | F0 = 32.0 MHz |     |     | F0 = 26.0 MHz |     |     | Unit | Notes |
|--------|---------------------------------------|---------------|-----|-----|---------------|-----|-----|------|-------|
|        |                                       | Min           | Typ | Max | Min           | Typ | Max |      |       |
| $T_A$  | Operating Temperature                 | -40           | —   | 105 | -40           | —   | 105 | °C   | 1     |
|        | Crystal initial frequency tolerance   | -10           | —   | 10  | -10           | —   | 10  | ppm  | 2,3   |
|        | Crystal frequency stability and aging | -25           | —   | 25  | -25           | —   | 24  | ppm  | 2,4   |
|        | Oscillator variation                  | -12           | —   | 15  | -12           | —   | 16  | ppm  | 5     |
|        | Total reference oscillator tolerance  | -50           | —   | 50  | -50           | —   | 50  | ppm  | 6     |

Table continues on the next page...

**Table 25. Recommended Crystal and Oscillator Specification (continued)**

| Symbol           | Description                   | F0 = 32.0 MHz |      |       | F0 = 26.0 MHz |      |       | Unit   | Notes |
|------------------|-------------------------------|---------------|------|-------|---------------|------|-------|--------|-------|
|                  |                               | Min           | Typ  | Max   | Min           | Typ  | Max   |        |       |
|                  | for Bluetooth LE applications |               |      |       |               |      |       |        |       |
| C <sub>L</sub>   | Load capacitance              | 7             | 10   | 13    | 7             | 10   | 13    | pF     | 2, 7  |
| C <sub>0</sub>   | Shunt capacitance             | 0.469         | 0.67 | 0.871 | 0.42          | 0.6  | 0.78  | pF     | 2,7   |
| C <sub>m1</sub>  | Motional capacitance          | 1.435         | 2.05 | 2.665 | 1.435         | 2.05 | 2.665 | fF     | 2,7   |
| L <sub>m1</sub>  | Motional inductance           | 8.47          | 12.1 | 15.73 | 12.81         | 18.3 | 23.79 | mH     | 2,7   |
| R <sub>m1</sub>  | Motional resistance           | —             | 25   | 50    | —             | 35   | 50    | Ohms   | 2     |
| ESR              | Equivalent series resistance  | —             | —    | 60    | —             | —    | 60    | Ohms   | 2,8   |
| P <sub>d</sub>   | Maximum crystal drive         | —             | 10   | 200   | —             | 10   | 200   | uW     | 2     |
| T <sub>S</sub>   | Trim sensitivity              | 6.30          | 9.00 | 11.70 | 6.39          | 9.12 | 11.86 | ppm/pF | 2,7   |
| T <sub>OSC</sub> | Oscillator Startup Time       | —             | 500  | —     | —             | 500  | —     | μs     | 9     |

1. Full temperature range of this device. A reduced range can be chosen to meet application needs.
2. Recommended crystal specification.
3. Measured at 25 °C.
4. Combination of frequency stability variation over desired temperature range and frequency variation due to aging over desired lifetime of system.
5. Variation due to temperature, process, and aging of MCU.
6. Sum of crystal initial frequency tolerance, crystal frequency stability and aging, oscillator variation, and PCB manufacturing variation must not exceed this value.
7. Typical is target. 30% tolerances shown.
8.  $ESR = R_{m1} * (1 + [C_0/C_L])^2$ .
9. Time from oscillator enable to clock ready. Dependent on the complete hardware configuration of the oscillator.

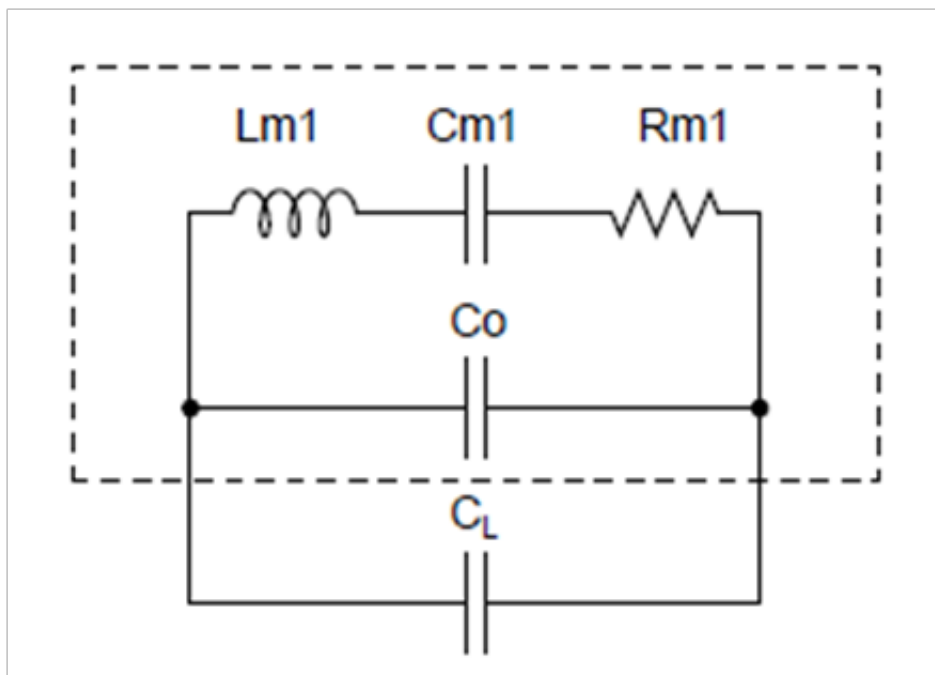


Figure 11. Crystal Electrical Model

### 6.5.3.3 32 kHz Oscillator Frequency Specifications

Table 26. 32 kHz Crystal and Oscillator Specifications

| Symbol            | Description                       | Min. | Typ.   | Max.     | Unit  | Notes |
|-------------------|-----------------------------------|------|--------|----------|-------|-------|
| $f_{osc\_lo}$     | Crystal frequency                 | —    | 32.768 | —        | kHz   |       |
| $T_A$             | Operating temperature             | -40  | —      | 105      | °C    | 1     |
|                   | Total crystal frequency tolerance | -500 | —      | 500      | ppm   | 2,3   |
| $C_L$             | Load capacitance                  | —    | 12.5   | —        | pF    | 2     |
| ESR               | Equivalent series resistance      | —    | —      | 80       | kOhms | 2     |
| $t_{start}$       | Crystal start-up time             | —    | 1000   | —        | ms    | 4     |
| $f_{ec\_extal32}$ | External input clock frequency    | —    | 32.768 | —        | kHz   | 5     |
| $V_{ec\_extal32}$ | External input clock amplitude    | 0.7  | —      | $V_{DD}$ | V     | 6     |

1. Full temperature range of this device. A reduced range can be chosen to meet application needs.
2. Recommended crystal specification.

3. Sum of crystal initial frequency tolerance, crystal frequency stability, and aging tolerances given by crystal vendor.
4. Time from oscillator enable to clock stable. Dependent on the complete hardware configuration of the oscillator.
5. External oscillator connected to EXTAL32K. XTAL32K must be unconnected.
6. The parameter specified is a peak-to-peak value and  $V_{IH}$  and  $V_{IL}$  specifications do not apply. The voltage of the applied clock must be within the range of VSS to VDD.

## 6.5.4 Memories and memory interfaces

### 6.5.4.1 Flash (FTFE) electrical specifications

This section describes the electrical characteristics of the FTFE module.

#### 6.5.4.1.1 Flash timing specifications — commands

Table 27. Flash command timing specifications

| Symbol           | Description <sup>1</sup>  | Min. | Typ. | Max. | Unit    | Notes |
|------------------|---|------|------|------|---------|-------|
| $t_{rd1blk256k}$ | Read 1s Block execution time<br>• 256 KB program/data flash     | —    | —    | 2    | ms      |       |
| $t_{rd1sec2k}$   | Read 1s Section execution time (2 KB flash)                     | —    | —    | 75   | $\mu$ s |       |
| $t_{pgmchk}$     | Program Check execution time                                    | —    | —    | 95   | $\mu$ s |       |
| $t_{rdsrc}$      | Read Resource execution time                                    | —    | —    | 40   | $\mu$ s |       |
| $t_{pgm8}$       | Program Phrase execution time                                   | —    | 90   | 225  | $\mu$ s |       |
| $t_{ersblk256k}$ | Erase Flash Block execution time<br>• 256 KB program/data flash | —    | 125  | 2125 | ms      | 2     |
| $t_{ersscr}$     | Erase Flash Sector execution time                               | —    | 12   | 130  | ms      | 2     |
| $t_{pgmsec2k}$   | Program Section execution time (2 KB flash)                     | —    | 10   | —    | ms      |       |
| $t_{rd1allx}$    | Read 1s All Blocks execution time<br>• FlexNVM devices          | —    | —    | 3.5  | ms      |       |
| $t_{rd1alln}$    | • Program flash only devices                                    | —    | —    | 3.5  | ms      |       |
| $t_{rdonce}$     | Read Once execution time  | —    | —    | 30   | $\mu$ s |       |
| $t_{pgmonce}$    | Program Once execution time                                     | —    | 90   | —    | $\mu$ s |       |
| $t_{ersall}$     | Erase All Blocks execution time                                 | —    | 262  | 4380 | ms      | 2     |
| $t_{vfykey}$     | Verify Backdoor Access Key execution time                       | —    | —    | 35   | $\mu$ s |       |
| $t_{ersallu}$    | Erase All Blocks Unsecure execution time                        | —    | 262  | 4380 | ms      | 2     |
| $t_{swapx01}$    | Swap Control execution time<br>• control code 0x01              | —    | 280  | —    | $\mu$ s |       |
| $t_{swapx02}$    | • control code 0x02   | —    | 100  | 235  | $\mu$ s |       |
| $t_{swapx04}$    | • control code 0x04   | —    | 100  | 235  | $\mu$ s |       |
| $t_{swapx08}$    |   | —    | —    | 35   | $\mu$ s |       |

Table continues on the next page...

**Table 27. Flash command timing specifications (continued)**

| Symbol                   | Description <sup>1</sup>  | Min. | Typ. | Max. | Unit          | Notes |
|--------------------------|---|------|------|------|---------------|-------|
| $t_{\text{swapx10}}$     | <ul style="list-style-type: none"> <li>control code 0x08</li> <li>control code 0x10</li> </ul>      | —    | 100  | 235  | $\mu\text{s}$ |       |
| $t_{\text{pgmpart32k}}$  | Program Partition for EEPROM execution time   | —    | 252  | —    | ms            |       |
| $t_{\text{pgmpart256k}}$ | <ul style="list-style-type: none"> <li>32 KB EEPROM backup</li> <li>256 KB EEPROM backup</li> </ul> | —    | 262  | —    | ms            |       |
| $t_{\text{setramff}}$    | Set FlexRAM Function execution time:  | —    | 115  | —    | $\mu\text{s}$ |       |
| $t_{\text{setram32k}}$   | <ul style="list-style-type: none"> <li>Control Code 0xFF</li> <li>32 KB EEPROM backup</li> </ul>    | —    | 0.8  | 1.2  | ms            |       |
| $t_{\text{setram256k}}$  | <ul style="list-style-type: none"> <li>256 KB EEPROM backup</li> </ul>                              | —    | 4.5  | 6.1  | ms            |       |
| $t_{\text{eewr8b32k}}$   | Byte-write to FlexRAM execution time:   | —    | 385  | 1700 | $\mu\text{s}$ | 3     |
| $t_{\text{eewr8b256k}}$  | <ul style="list-style-type: none"> <li>32 KB EEPROM backup</li> <li>256 KB EEPROM backup</li> </ul> | —    | 1015 | 3800 | $\mu\text{s}$ |       |
| $t_{\text{eewr16b32k}}$  | 16-bit write to FlexRAM execution time:   | —    | 385  | 1700 | $\mu\text{s}$ | 3     |
| $t_{\text{eewr16b256k}}$ | <ul style="list-style-type: none"> <li>32 KB EEPROM backup</li> <li>256 KB EEPROM backup</li> </ul> | —    | 1015 | 3800 | $\mu\text{s}$ |       |
| $t_{\text{eewr32bers}}$  | 32-bit write to erased FlexRAM location execution time  | —    | 360  | 2000 | $\mu\text{s}$ | 3     |
| $t_{\text{eewr32b32k}}$  | 32-bit write to FlexRAM execution time:   | —    | 630  | 2000 | $\mu\text{s}$ | 3     |
| $t_{\text{eewr32b256k}}$ | <ul style="list-style-type: none"> <li>32 KB EEPROM backup</li> <li>256 KB EEPROM backup</li> </ul> | —    | 1890 | 4100 | $\mu\text{s}$ |       |

1. All command times assume 25 MHz or greater flash clock frequency (for synchronization time between internal/external clocks).
2. Maximum times for erase parameters based on expectations at cycling end-of-life.
3. First time EERAM writes after a Reset or SETRAM command may incur additional overhead for EEE cleanup, resulting in up to 2x the times shown.

**NOTE**

Under certain circumstances maximum times for writes to FlexRAM may be exceeded. In this case the user or application may wait, or assert reset to the FTFE module to stop the operation.

**6.5.4.1.2 Reliability specifications****Table 28. NVM reliability specifications**

| Symbol        | Description | Min. | Typ. | Max. | Unit | Notes |
|---------------|-------------|------|------|------|------|-------|
| Program Flash |             |      |      |      |      |       |

*Table continues on the next page...*

**Table 28. NVM reliability specifications (continued)**

| Symbol                     | Description                                 | Min.  | Typ. | Max. | Unit   | Notes   |
|----------------------------|---|-------|------|------|--------|---------|
| $t_{\text{nvmet1k}}$       | Data retention after up to 1 K cycles       | 20    | —    | —    | years  | 1       |
| $n_{\text{nvmcyc}}$        | Cycling endurance                           | 1 K   | —    | —    | cycles | 2       |
| FlexRAM as Emulated EEPROM |   |       |      |      |        |         |
| $t_{\text{nvmetee}}$       | Data retention                              | 5     | —    | —    | years  | 1, 3    |
|                            | Write endurance                             |       |      |      |        | 4, 5, 6 |
| $n_{\text{nvmwree16}}$     | • EEPROM backup to FlexRAM used ratio = 16  | 100 K | —    | —    | writes |         |
| $n_{\text{nvmwree256}}$    | • EEPROM backup to FlexRAM used ratio = 256 | 1.6 M | —    | —    | writes |         |

1. Data retention period per block begins upon initial user factory programming or after each subsequent erase.
2. Program and Erase are supported across product temperature specification. Cycling endurance is per flash sector.
3. Background maintenance operations during normal FlexRAM usage extend effective data retention life beyond 5 years.
4. FlexMemory write endurance specified for 16-bit and/or 32-bit writes to FlexRAM and is supported across product temperature specification. Greater write endurance may be achieved with larger ratios of EEPROM backup to FlexRAM.
5. For usage of any EEE driver other than the FlexMemory feature, the endurance specification falls back to the Data Flash endurance value of 1 K.
6. [FlexMemory calculator tool](#) is available on the NXP web site for help in estimating the maximum write endurance achievable at specific EEPROM/FlexRAM ratios. The "In Spec" portions of the online calculator refer to the NVM reliability specifications section of the data sheet. This calculator only applies to the Kinetis FlexMemory feature.

#### 6.5.4.1.3 Write endurance to FlexRAM for EEPROM

When the FlexNVM partition code is not set to full data flash, the EEPROM data set size can be set to any of several non-zero values.

The bytes not assigned to data flash via the FlexNVM partition code are used by the FTFE to obtain an effective endurance increase for the EEPROM data. The built-in EEPROM record management system raises the number of program/erase cycles that can be attained prior to device wear-out by cycling the EEPROM data through a larger EEPROM NVM storage space.

While different partitions of the FlexNVM are available, the intention is that a single choice for the FlexNVM partition code and EEPROM data set size is used throughout the entire lifetime of a given application.

### 6.5.5 Security and integrity modules

There are no specifications necessary for the device's security and integrity modules.

## 6.5.6 Analog

### 6.5.6.1 ADC electrical specifications

All other ADC channels meet the 13-bit differential/12-bit single-ended accuracy specifications. The following specification is defined with the DC-DC converter operating in Bypass mode.

#### 6.5.6.1.1 16-bit ADC operating conditions

Table 29. 16-bit ADC operating conditions

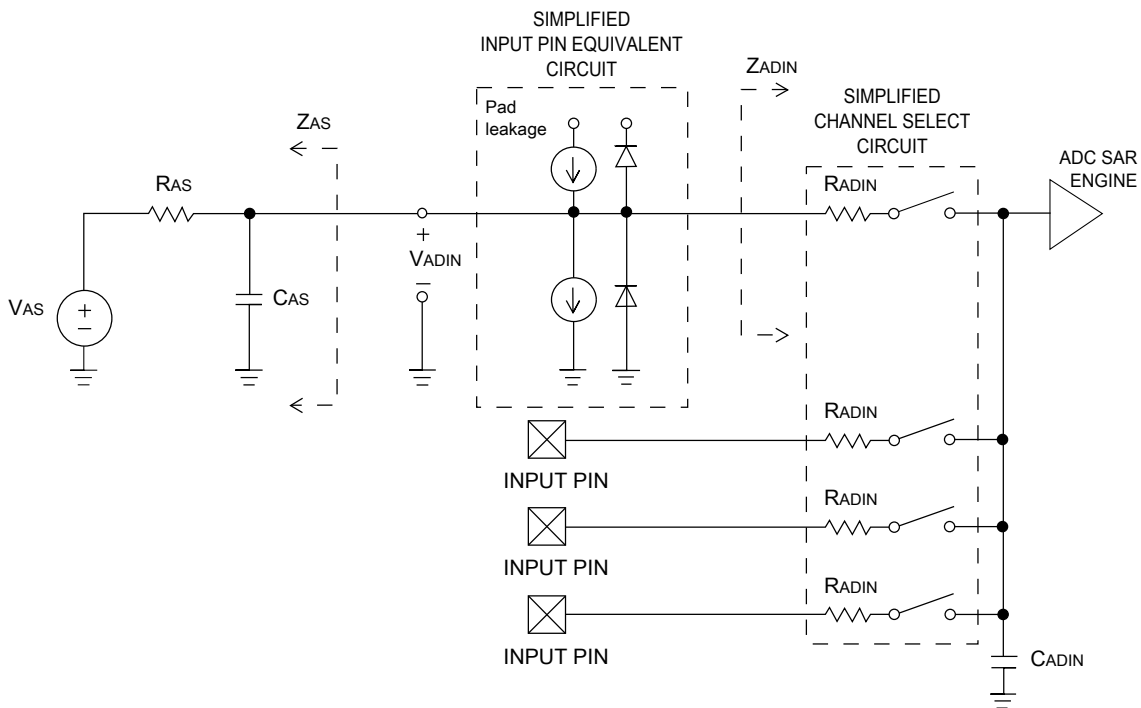
| Symbol            | Description                         | Conditions  | Min.                                 | Typ. <sup>1</sup> | Max.   | Unit | Notes |
|-------------------|-------------------------------------|---|--------------------------------------|-------------------|--|------|-------|
| V <sub>DDA</sub>  | Supply voltage                      | Absolute  | 1.71                                 | —                 | 3.6  | V    |       |
| ΔV <sub>DDA</sub> | Supply voltage                      | Delta to V <sub>DD</sub> (V <sub>DD</sub> – V <sub>DDA</sub> )  | –100                                 | 0                 | +100   | mV   | 2     |
| ΔV <sub>SSA</sub> | Ground voltage                      | Delta to V <sub>SS</sub> (V <sub>SS</sub> – V <sub>SSA</sub> )  | –100                                 | 0                 | +100   | mV   | 2     |
| V <sub>REFH</sub> | ADC reference voltage high          |   | 1.13                                 | V <sub>DDA</sub>  | V <sub>DDA</sub>                               | V    | 3     |
| V <sub>REFL</sub> | ADC reference voltage low           |   | V <sub>SSA</sub>                     | V <sub>SSA</sub>  | V <sub>SSA</sub>                               | V    | 3     |
| V <sub>ADIN</sub> | Input voltage                       | <ul style="list-style-type: none"> <li>16-bit differential mode</li> <li>All other modes</li> </ul>       | V <sub>SSA</sub><br>V <sub>SSA</sub> | —<br>—            | 31/32 × V <sub>REFH</sub><br>V <sub>REFH</sub> | V    |       |
| C <sub>ADIN</sub> | Input capacitance                   | <ul style="list-style-type: none"> <li>16-bit mode</li> <li>8-bit / 10-bit / 12-bit modes</li> </ul>      | —<br>—                               | 8<br>4            | 10<br>5  | pF   |       |
| R <sub>ADIN</sub> | Input series resistance             |   | —                                    | 2                 | 5  | kΩ   |       |
| R <sub>AS</sub>   | Analog source resistance (external) | 13-bit / 12-bit modes<br>f <sub>ADCK</sub> < 4 MHz  | —                                    | —                 | 5  | kΩ   | 4     |
| f <sub>ADCK</sub> | ADC conversion clock frequency      | ≤ 13-bit mode   | 1.0                                  | —                 | 18.0   | MHz  | 5     |
| f <sub>ADCK</sub> | ADC conversion clock frequency      | 16-bit mode   | 2.0                                  | —                 | 12.0   | MHz  | 5     |
| C <sub>rate</sub> | ADC conversion rate                 | ≤ 13-bit modes<br>No ADC hardware averaging<br>Continuous conversions enabled, subsequent conversion time | 20.000                               | —                 | 818.330  | kS/s | 6     |
| C <sub>rate</sub> | ADC conversion rate                 | 16-bit mode<br>No ADC hardware averaging  | 37.037                               | —                 | 461.467  | kS/s | 6     |



**Table 29. 16-bit ADC operating conditions**

| Symbol | Description | Conditions   | Min. | Typ. <sup>1</sup> | Max. | Unit | Notes |
|--------|-------------|--|------|-------------------|------|------|-------|
|        |             | Continuous conversions enabled, subsequent conversion time |      |                   |      |      |       |

1. Typical values assume  $V_{DDA} = 3.0\text{ V}$ ,  $\text{Temp} = 25\text{ }^\circ\text{C}$ ,  $f_{ADCK} = 1.0\text{ MHz}$ , unless otherwise stated. Typical values are for reference only, and are not tested in production.
2. DC potential difference.
3. For packages without dedicated  $V_{REFH}$  and  $V_{REFL}$  pins,  $V_{REFH}$  is internally tied to  $V_{DDA}$ , and  $V_{REFL}$  is internally tied to  $V_{SSA}$ .
4. This resistance is external to MCU. To achieve the best results, the analog source resistance must be kept as low as possible. The results in this data sheet are derived from a system that had  $< 8\ \Omega$  analog source resistance. The  $R_{AS}/C_{AS}$  time constant should be kept to  $< 1\text{ ns}$ .
5. To use the maximum ADC conversion clock frequency,  $\text{CFG2}[\text{ADHSC}]$  must be set and  $\text{CFG1}[\text{ADLPC}]$  must be clear.
6. For guidelines and examples of conversion rate calculation, download the [ADC calculator tool](#).



**Figure 12. ADC input impedance equivalency diagram**

### 6.5.6.1.2 16-bit ADC electrical characteristics

**Table 30. 16-bit ADC characteristics ( $V_{REFH} = V_{DDA}$ ,  $V_{REFL} = V_{SSA}$ )**

| Symbol                                | Description                     | Conditions <sup>1</sup>  | Min.               | Typ. <sup>2</sup> | Max.         | Unit             | Notes                             |
|---------------------------------------|---------------------------------|--|--------------------|-------------------|--------------|------------------|-----------------------------------|
| $I_{DDA\_ADC}$                        | Supply current                  |  | 0.215              | —                 | 1.7          | mA               | 3                                 |
| $f_{ADACK}$                           | ADC asynchronous clock source   | <ul style="list-style-type: none"> <li>• ADLPC=1, ADHSC=0</li> <li>• ADLPC=1, ADHSC=1</li> <li>• ADLPC=0, ADHSC=0</li> <li>• ADLPC=0, ADHSC=1</li> </ul> | 1.2                | 2.4               | 3.9          | MHz              | $t_{ADACK} = 1/f_{ADACK}$         |
|                                       | Sample Time                     | See Reference Manual chapter for sample times  |                    |                   |              |                  |                                   |
| TUE                                   | Total unadjusted error          | <ul style="list-style-type: none"> <li>• 12-bit modes</li> <li>• &lt;12-bit modes</li> </ul>   | —                  | ±4                | ±6.8         | LSB <sup>4</sup> | 5                                 |
| DNL                                   | Differential non-linearity      | • 12-bit mode; Buck Mode <sup>6</sup>  | —                  | ±0.7              | -1.1 to +1.9 | LSB <sup>4</sup> | 5                                 |
|                                       |                                 | • 12-bit mode; Bypass Mode   | —                  | ±0.5              | -1.1 to +1.9 |                  |                                   |
| INL                                   | Integral non-linearity          | • 12-bit mode; Buck Mode <sup>6</sup>  | —                  | ±1.0              | -2.7 to +1.9 | LSB <sup>4</sup> | 5                                 |
|                                       |                                 | • 12-bit mode; Bypass Mode   | —                  | ±0.6              | -2.7 to +1.9 |                  |                                   |
| $E_{FS}$                              | Full-scale error                | • 12-bit modes   | —                  | -4                | -5.4         | LSB <sup>4</sup> | $V_{ADIN} = V_{DDA}$ <sup>5</sup> |
|                                       |                                 | • <12-bit modes  | —                  | -1.4              | -1.8         |                  |                                   |
| $E_Q$                                 | Quantization error              | • 16-bit modes   | —                  | -1 to 0           | —            | LSB <sup>4</sup> |                                   |
|                                       |                                 | • ≤13-bit modes  | —                  | —                 | ±0.5         |                  |                                   |
| ENOB                                  | Effective number of bits        | 16-bit differential mode; Buck Mode <sup>6</sup>   |                    |                   |              | bits             | 7                                 |
|                                       |                                 | • Avg = 32   | 12                 | 12.75             | —            |                  |                                   |
|                                       |                                 | • Avg = 4  | 11.25              | 11.75             | —            |                  |                                   |
|                                       |                                 | 16-bit single-ended mode; Buck Mode <sup>6</sup>   |                    |                   |              |                  |                                   |
|                                       |                                 | • Avg = 32   | 11                 | 11.5              | —            |                  |                                   |
|                                       |                                 | • Avg = 4  | 9.5                | 10.5              | —            |                  |                                   |
|                                       |                                 | 16-bit differential mode; Bypass Mode  |                    |                   |              |                  |                                   |
|                                       |                                 | • Avg = 32   | 12.5               | 13                | —            |                  |                                   |
| • Avg = 4                             | 11.25                           | 12   | —                  |                   |              |                  |                                   |
| 16-bit single-ended mode; Bypass Mode |                                 |  |                    |                   |              |                  |                                   |
| • Avg = 32                            | 11                              | 11.75  | —                  |                   |              |                  |                                   |
| • Avg = 4                             | 10                              | 10.5   | —                  |                   |              |                  |                                   |
| SINAD                                 | Signal-to-noise plus distortion | See ENOB   | 6.02 × ENOB + 1.76 |                   |              | dB               |                                   |
| THD                                   | Total harmonic distortion       | 16-bit differential mode; Buck Mode <sup>6</sup>   |                    |                   |              |                  | 8                                 |

Table continues on the next page...

Table 30. 16-bit ADC characteristics ( $V_{REFH} = V_{DDA}$ ,  $V_{REFL} = V_{SSA}$ ) (continued)

| Symbol              | Description                            | Conditions <sup>1</sup>  | Min.                   | Typ. <sup>2</sup> | Max. | Unit  | Notes   |
|---------------------|--|--|------------------------|-------------------|------|-------|---|
|                     |  | <ul style="list-style-type: none"> <li>Avg = 32</li> </ul> 16-bit single-ended mode;<br>Buck Mode <sup>6</sup> | —                      | –90               | —    | dB    |   |
|                     |  | <ul style="list-style-type: none"> <li>Avg = 32</li> </ul> 16-bit differential mode;<br>Bypass Mode            | —                      | –88               | —    |       |   |
|                     |  | <ul style="list-style-type: none"> <li>Avg = 32</li> </ul> 16-bit single-ended mode;<br>Bypass Mode            | —                      | –89               | —    |       |   |
|                     |  | <ul style="list-style-type: none"> <li>Avg = 32</li> </ul> 16-bit single-ended mode;<br>Bypass Mode            | —                      | –87               | —    |       |   |
| SINAD               | Signal-to-noise plus distortion        | See ENOB   | 6.02 × ENOB + 1.76     |                   |      | dB    |   |
| SFDR                | Spurious free dynamic range distortion | 16-bit differential mode; Buck Mode <sup>6</sup> <ul style="list-style-type: none"> <li>Avg = 32</li> </ul>    | 85                     | 89                | —    | dB    | 8   |
|                     |  | 16-bit single-ended mode; Buck Mode <sup>6</sup> <ul style="list-style-type: none"> <li>Avg = 32</li> </ul>    | 85                     | 87                | —    |       |   |
|                     |  | 16-bit differential mode; Bypass Mode <ul style="list-style-type: none"> <li>Avg = 32</li> </ul>               | 87                     | 94                | —    |       |   |
|                     |  | 16-bit single-ended mode; Bypass Mode <ul style="list-style-type: none"> <li>Avg = 32</li> </ul>               | 85                     | 88                | —    |       |   |
| E <sub>IL</sub>     | Input leakage error                    |  | $I_{in} \times R_{AS}$ |                   |      | mV    | I <sub>in</sub> = leakage current (see Voltage and current operating ratings) |
|                     | Temp sensor slope                      | Across the full temperature range of the device  | 1.67                   | 1.74              | 1.81 | mV/°C | 9   |
| V <sub>TEMP25</sub> | Temp sensor voltage                    | 25 °C  | 706                    | 716               | 726  | mV    | 9   |

1. All accuracy numbers assume that the ADC is calibrated with  $V_{REFH} = V_{DDA}$ .

2. Typical values assume  $V_{DDA} = 3.0$  V, Temp = 25 °C,  $f_{ADCK} = 2.0$  MHz unless otherwise stated. Typical values are for reference only and are not tested in production.

## KW36A/35A/34A Electrical Characteristics

- The ADC supply current depends on the ADC conversion clock speed, conversion rate and ADC\_CFG1[ADLPC] (low-power). For lowest power operation, ADC\_CFG1[ADLPC] must be set, the ADC\_CFG2[ADHSC] bit must be clear with 1 MHz ADC conversion clock speed.
- $1 \text{ LSB} = (V_{\text{REFH}} - V_{\text{REFL}})/2^N$ .
- ADC conversion clock < 16 MHz, maximum hardware averaging (AVGE = %1, AVGS = %11).
- VREFH = Output of Voltage Reference(VREF).
- Input data is 100 Hz sine wave. ADC conversion clock < 12 MHz.
- Input data is 1 kHz sine wave. ADC conversion clock < 12 MHz.
- ADC conversion clock < 3 MHz.

### 6.5.6.2 Voltage reference electrical specifications

**Table 31. VREF full-range operating requirements**

| Symbol           | Description             | Min.       | Max. | Unit | Notes |
|------------------|-------------------------|------------|------|------|-------|
| V <sub>DDA</sub> | Supply voltage          | 1.71       | 3.6  | V    |       |
| T <sub>A</sub>   | Temperature             | -40 to 105 |      | °C   |       |
| C <sub>L</sub>   | Output load capacitance | 100        |      | nF   | 1, 2  |

- C<sub>L</sub> must be connected to VREF\_OUT if the VREF\_OUT functionality is being used for either an internal or external reference.
- The load capacitance should not exceed +/-25% of the nominal specified C<sub>L</sub> value over the operating temperature range of the device.

**Table 32. VREF full-range operating behaviors**

| Symbol                          | Description  | Min.   | Typ.   | Max.   | Unit | Notes |
|---------------------------------|--|--------|--------|--------|------|-------|
| V <sub>out</sub>                | Voltage reference output with factory trim at nominal V <sub>DDA</sub> and temperature=25 °C | 1.190  | 1.1950 | 1.2    | V    | 1     |
| V <sub>out</sub>                | Voltage reference output with user trim at nominal V <sub>DDA</sub> and temperature=25 °C    | 1.1945 | 1.1950 | 1.1955 | V    | 1     |
| V <sub>step</sub>               | Voltage reference trim step  | —      | 0.5    | —      | mV   | 1     |
| V <sub>tdrift</sub>             | Temperature drift (V <sub>max</sub> -V <sub>min</sub> across the full temperature range)     | —      | —      | 20     | mV   | 1     |
| I <sub>bg</sub>                 | Bandgap only current   | —      | —      | 80     | µA   |       |
| I <sub>lp</sub>                 | Low-power buffer current   | —      | —      | 360    | µA   | 1     |
| I <sub>hp</sub>                 | High-power buffer current  | —      | —      | 1      | mA   | 1     |
| ΔV <sub>LOAD</sub>              | Load regulation<br>• current = ± 1.0 mA  | —      | 200    | —      | µV   | 1, 2  |
| T <sub>stup</sub>               | Buffer startup time  | —      | —      | 100    | µs   |       |
| T <sub>chop_osc_st<br/>up</sub> | Internal bandgap start-up delay with chop oscillator enabled                                 | —      | —      | 35     | ms   |       |
| V <sub>vdrift</sub>             | Voltage drift (V <sub>max</sub> -V <sub>min</sub> across the full voltage range)             | —      | 2      | —      | mV   | 1     |

- See the chip's Reference Manual for the appropriate settings of the VREF Status and Control register.
- Load regulation voltage is the difference between the VREF\_OUT voltage with no load vs. voltage with defined load

**Table 33. VREF limited-range operating requirements**

| Symbol | Description | Min. | Max. | Unit | Notes |
|--------|-------------|------|------|------|-------|
| $T_A$  | Temperature | 0    | 70   | °C   |       |

**Table 34. VREF limited-range operating behaviors**

| Symbol       | Description   | Min. | Max. | Unit | Notes |
|--------------|---|------|------|------|-------|
| $V_{tdrift}$ | Temperature drift ( $V_{max} - V_{min}$ across the limited temperature range) | —    | 15   | mV   |       |

### 6.5.6.3 CMP and 6-bit DAC electrical specifications

**Table 35. Comparator and 6-bit DAC electrical specifications**

| Symbol      | Description  | Min.           | Typ.                | Max.     | Unit                 |
|-------------|--|----------------|---------------------|----------|----------------------|
| $V_{DD}$    | Supply voltage   | 1.71           | —                   | 3.6      | V                    |
| $I_{DDHS}$  | Supply current, High-speed mode (EN=1, PMODE=1)  | —              | —                   | 200      | μA                   |
| $I_{DDL S}$ | Supply current, low-speed mode (EN=1, PMODE=0)   | —              | —                   | 20       | μA                   |
| $V_{AIN}$   | Analog input voltage   | $V_{SS} - 0.3$ | —                   | $V_{DD}$ | V                    |
| $V_{AIO}$   | Analog input offset voltage  | —              | —                   | 20       | mV                   |
| $V_H$       | Analog comparator hysteresis <sup>1</sup> <ul style="list-style-type: none"> <li>• CR0[HYSTCTR] = 00</li> <li>• CR0[HYSTCTR] = 01</li> <li>• CR0[HYSTCTR] = 10</li> <li>• CR0[HYSTCTR] = 11</li> </ul> | —              | 5<br>10<br>20<br>30 | —        | mV<br>mV<br>mV<br>mV |
| $V_{CMPOh}$ | Output high  | $V_{DD} - 0.5$ | —                   | —        | V                    |
| $V_{CMPOl}$ | Output low   | —              | —                   | 0.5      | V                    |
| $t_{DHS}$   | Propagation delay, high-speed mode (EN=1, PMODE=1)   | 20             | 50                  | 200      | ns                   |
| $t_{DLS}$   | Propagation delay, low-speed mode (EN=1, PMODE=0)  | 80             | 250                 | 600      | ns                   |
|             | Analog comparator initialization delay <sup>2</sup>  | —              | —                   | 40       | μs                   |
| $I_{DAC6b}$ | 6-bit DAC current adder (enabled)  | —              | 7                   | —        | μA                   |
| INL         | 6-bit DAC integral non-linearity   | -0.5           | —                   | 0.5      | LSB <sup>3</sup>     |
| DNL         | 6-bit DAC differential non-linearity   | -0.3           | —                   | 0.3      | LSB                  |

1. Typical hysteresis is measured with input voltage range limited to 0.6 to  $V_{DD}-0.6$  V.
2. Comparator initialization delay is defined as the time between software writes to change control inputs (Writes to CMP\_DACCR[DACEN], CMP\_DACCR[VRSEL], CMP\_DACCR[VOSEL], CMP\_MUXCR[PSEL], and CMP\_MUXCR[MSEL]) and the comparator output settling to a stable level.
3. 1 LSB =  $V_{reference}/64$

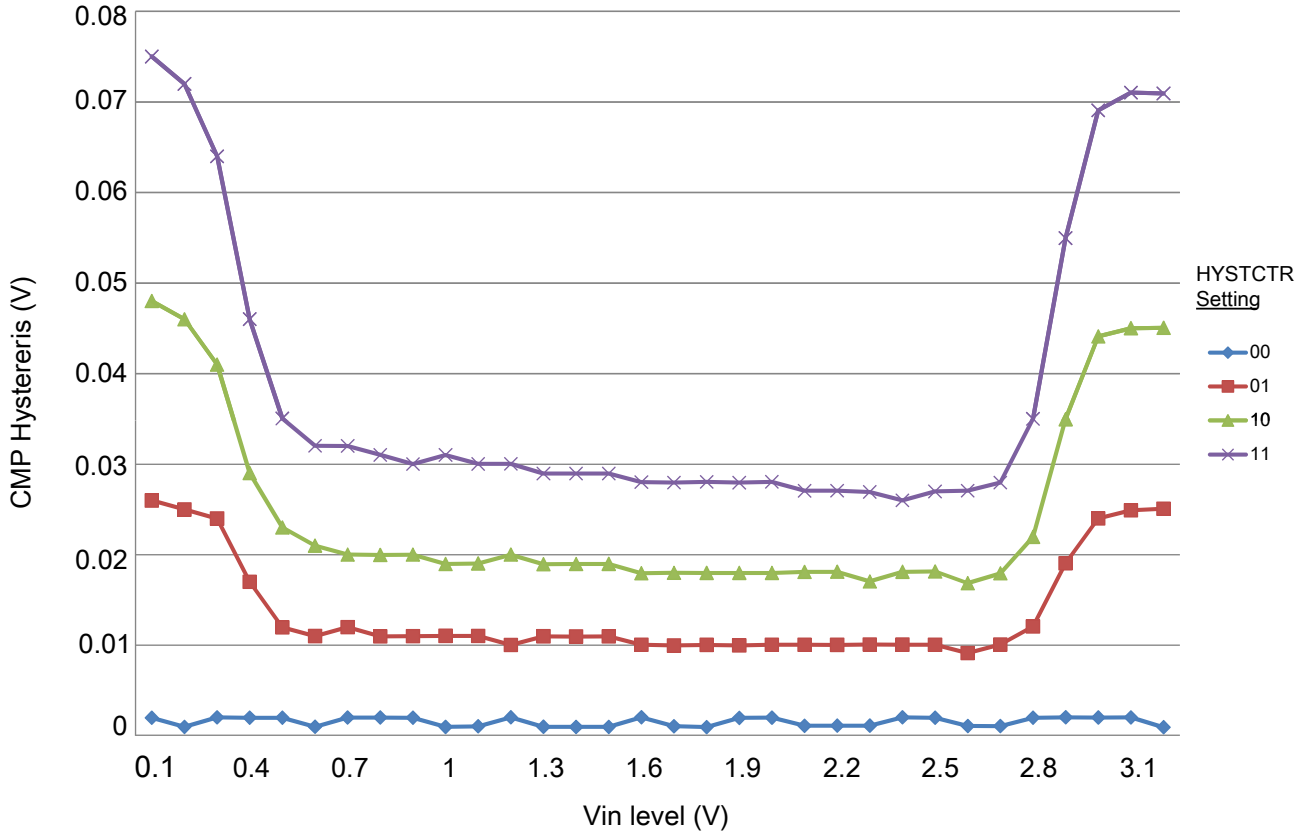


Figure 13. Typical hysteresis vs. Vin level (VDD = 3.3 V, PMODE = 0)

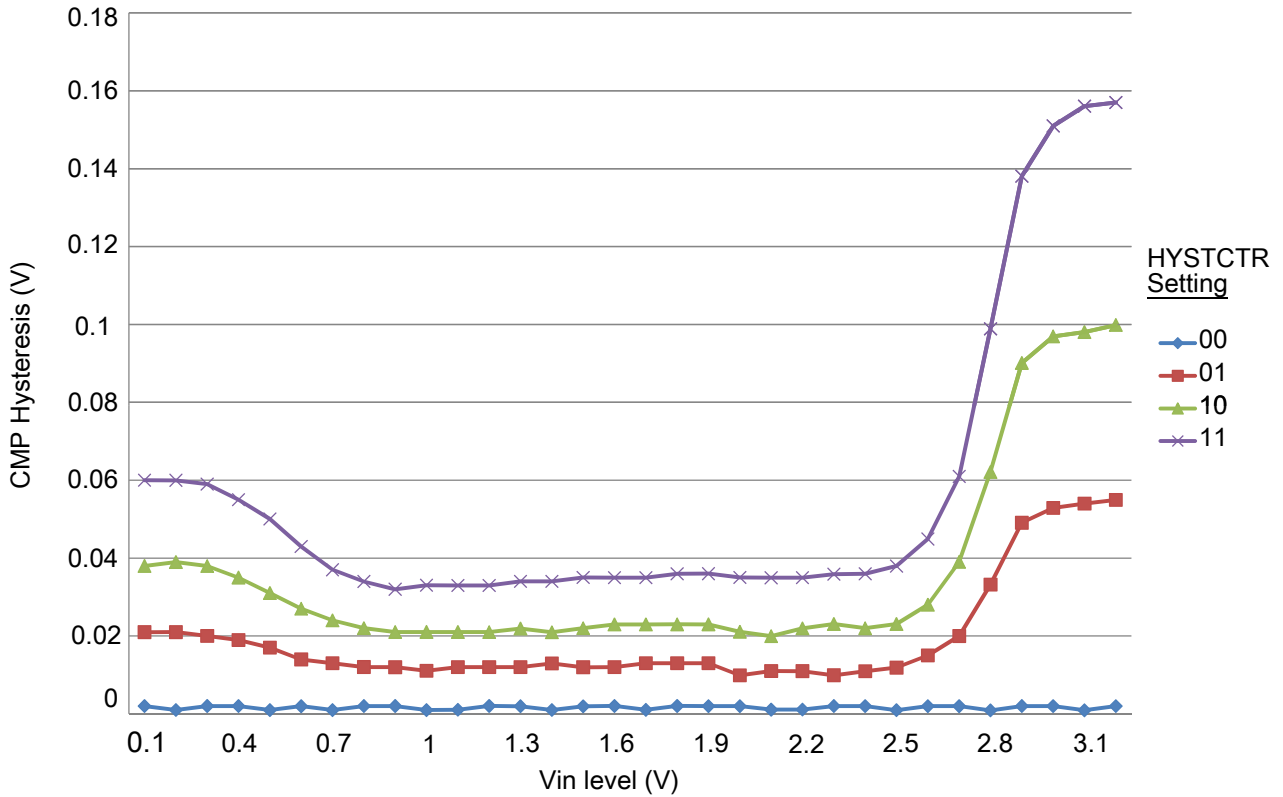


Figure 14. Typical hysteresis vs. Vin level (VDD = 3.3 V, PMODE = 1)

## 6.5.7 Timers

See [General switching specifications](#).

## 6.5.8 Communication interfaces

### 6.5.8.1 CAN switching specifications

See [General switching specifications](#).

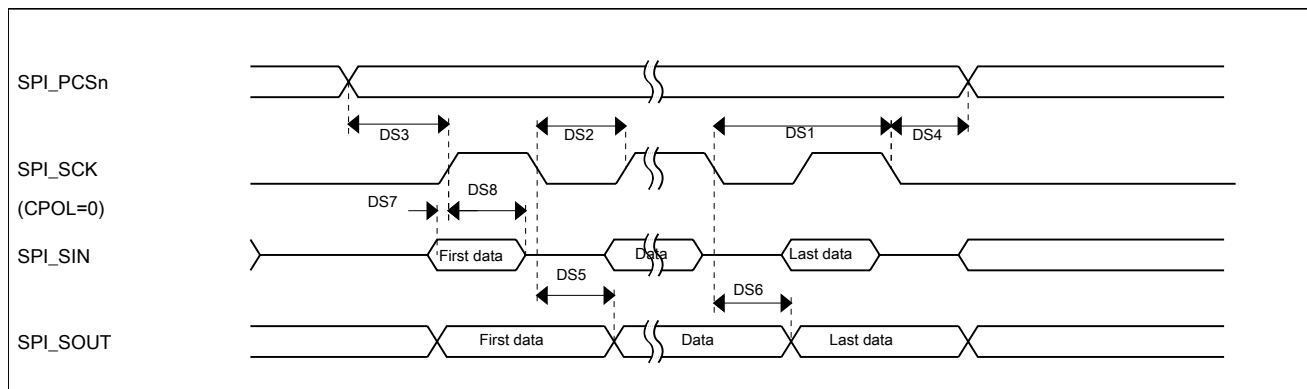
### 6.5.8.2 DSPI switching specifications (limited voltage range)

The DMA Serial Peripheral Interface (DSPI) provides a synchronous serial bus with master and slave operations. Many of the transfer attributes are programmable. The tables below provide DSPI timing characteristics for classic SPI timing modes. See the DSPI chapter of the Reference Manual for information on the modified transfer formats used for communicating with slower peripheral devices.

**Table 36. Master mode DSPI timing (limited voltage range)**

| Num | Description                         | Min.                     | Max.              | Unit | Notes |
|-----|-------------------------------------|--------------------------|-------------------|------|-------|
|     | Operating voltage                   | 2.7                      | 3.6               | V    |       |
|     | Frequency of operation              | —                        | 12                | MHz  |       |
| DS1 | DSPI_SCK output cycle time          | $2 \times t_{BUS}$       | —                 | ns   |       |
| DS2 | DSPI_SCK output high/low time       | $(t_{SCK}/2) - 2$        | $(t_{SCK}/2) + 2$ | ns   |       |
| DS3 | DSPI_PCSn valid to DSPI_SCK delay   | $(t_{BUS} \times 2) - 2$ | —                 | ns   | 1     |
| DS4 | DSPI_SCK to DSPI_PCSn invalid delay | $(t_{BUS} \times 2) - 2$ | —                 | ns   | 2     |
| DS5 | DSPI_SCK to DSPI_SOUT valid         | —                        | 8.5               | ns   |       |
| DS6 | DSPI_SCK to DSPI_SOUT invalid       | -2                       | —                 | ns   |       |
| DS7 | DSPI_SIN to DSPI_SCK input setup    | 16.2                     | —                 | ns   |       |
| DS8 | DSPI_SCK to DSPI_SIN input hold     | 0                        | —                 | ns   |       |

1. The delay is programmable in SPIx\_CTARn[PCSSCK] and SPIx\_CTARn[CSSCK].
2. The delay is programmable in SPIx\_CTARn[PASC] and SPIx\_CTARn[ASC].



**Figure 15. DSPI classic SPI timing — master mode**

**Table 37. Slave mode DSPI timing (limited voltage range)**

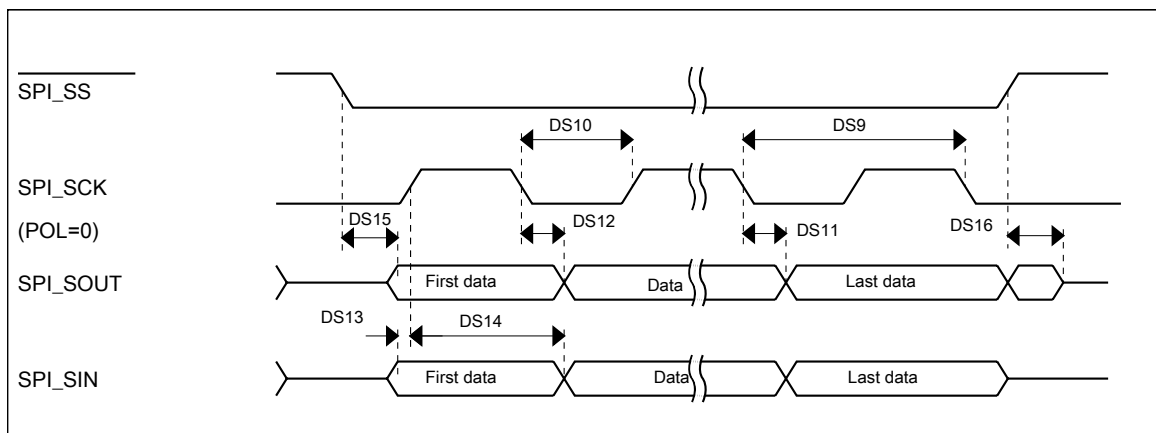
| Num | Description            | Min. | Max. | Unit |
|-----|------------------------|------|------|------|
|     | Operating voltage      | 2.7  | 3.6  | V    |
|     | Frequency of operation |      | 6    | MHz  |

Table continues on the next page...



**Table 37. Slave mode DSPI timing (limited voltage range) (continued)**

| Num  | Description   | Min.                      | Max.                     | Unit |
|------|---|---------------------------|--------------------------|------|
| DS9  | DSPI_SCK input cycle time                                     | $4 \times t_{\text{BUS}}$ | —                        | ns   |
| DS10 | DSPI_SCK input high/low time                                  | $(t_{\text{SCK}/2}) - 2$  | $(t_{\text{SCK}/2}) + 2$ | ns   |
| DS11 | DSPI_SCK to DSPI_SOUT valid                                   | —                         | 21.4                     | ns   |
| DS12 | DSPI_SCK to DSPI_SOUT invalid                                 | 0                         | —                        | ns   |
| DS13 | DSPI_SIN to DSPI_SCK input setup                              | 2.6                       | —                        | ns   |
| DS14 | DSPI_SCK to DSPI_SIN input hold                               | 7.0                       | —                        | ns   |
| DS15 | $\overline{\text{DSPI\_SS}}$ active to DSPI_SOUT driven       | —                         | 14                       | ns   |
| DS16 | $\overline{\text{DSPI\_SS}}$ inactive to DSPI_SOUT not driven | —                         | 14                       | ns   |

**Figure 16. DSPI classic SPI timing — slave mode**

### 6.5.8.3 DSPI switching specifications (full voltage range)

The DMA Serial Peripheral Interface (DSPI) provides a synchronous serial bus with master and slave operations. Many of the transfer attributes are programmable. The tables below provide DSPI timing characteristics for classic SPI timing modes. See the DSPI chapter of the Reference Manual for information on the modified transfer formats used for communicating with slower peripheral devices.

**Table 38. Master mode DSPI timing (full voltage range)**

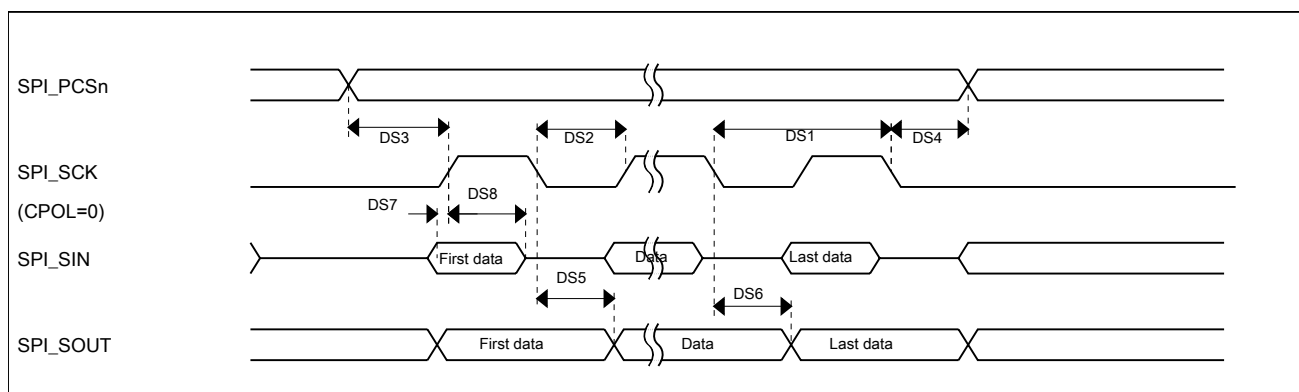
| Num | Description                   | Min.                      | Max.                     | Unit | Notes |
|-----|-------------------------------|---------------------------|--------------------------|------|-------|
|     | Operating voltage             | 1.71                      | 3.6                      | V    | 1     |
|     | Frequency of operation        | —                         | 12                       | MHz  |       |
| DS1 | DSPI_SCK output cycle time    | $2 \times t_{\text{BUS}}$ | —                        | ns   |       |
| DS2 | DSPI_SCK output high/low time | $(t_{\text{SCK}/2}) - 4$  | $(t_{\text{SCK}/2}) + 4$ | ns   |       |

Table continues on the next page...

**Table 38. Master mode DSPI timing (full voltage range) (continued)**

| Num | Description                         | Min.                     | Max. | Unit | Notes |
|-----|-------------------------------------|--------------------------|------|------|-------|
| DS3 | DSPI_PCSn valid to DSPI_SCK delay   | $(t_{BUS} \times 2) - 4$ | —    | ns   | 2     |
| DS4 | DSPI_SCK to DSPI_PCSn invalid delay | $(t_{BUS} \times 2) - 4$ | —    | ns   | 3     |
| DS5 | DSPI_SCK to DSPI_SOUT valid         | —                        | 10   | ns   |       |
| DS6 | DSPI_SCK to DSPI_SOUT invalid       | -1.2                     | —    | ns   |       |
| DS7 | DSPI_SIN to DSPI_SCK input setup    | 23.3                     | —    | ns   |       |
| DS8 | DSPI_SCK to DSPI_SIN input hold     | 0                        | —    | ns   |       |

1. The DSPI module can operate across the entire operating voltage for the processor, but to run across the full voltage range the maximum frequency of operation is reduced.
2. The delay is programmable in SPIx\_CTARn[PCSSCK] and SPIx\_CTARn[CSSCK].
3. The delay is programmable in SPIx\_CTARn[PASC] and SPIx\_CTARn[ASC].



**Figure 17. DSPI classic SPI timing — master mode**

**Table 39. Slave mode DSPI timing (full voltage range)**

| Num  | Description  | Min.               | Max.              | Unit |
|------|--|--------------------|-------------------|------|
|      | Operating voltage                                      | 1.71               | 3.6               | V    |
|      | Frequency of operation                                 | —                  | 6                 | MHz  |
| DS9  | DSPI_SCK input cycle time                              | $4 \times t_{BUS}$ | —                 | ns   |
| DS10 | DSPI_SCK input high/low time                           | $(t_{SCK}/2) - 4$  | $(t_{SCK}/2) + 4$ | ns   |
| DS11 | DSPI_SCK to DSPI_SOUT valid                            | —                  | 29.1              | ns   |
| DS12 | DSPI_SCK to DSPI_SOUT invalid                          | 0                  | —                 | ns   |
| DS13 | DSPI_SIN to DSPI_SCK input setup                       | 3.2                | —                 | ns   |
| DS14 | DSPI_SCK to DSPI_SIN input hold                        | 7.0                | —                 | ns   |
| DS15 | $\overline{DSPI\_SS}$ active to DSPI_SOUT driven       | —                  | 25                | ns   |
| DS16 | $\overline{DSPI\_SS}$ inactive to DSPI_SOUT not driven | —                  | 25                | ns   |

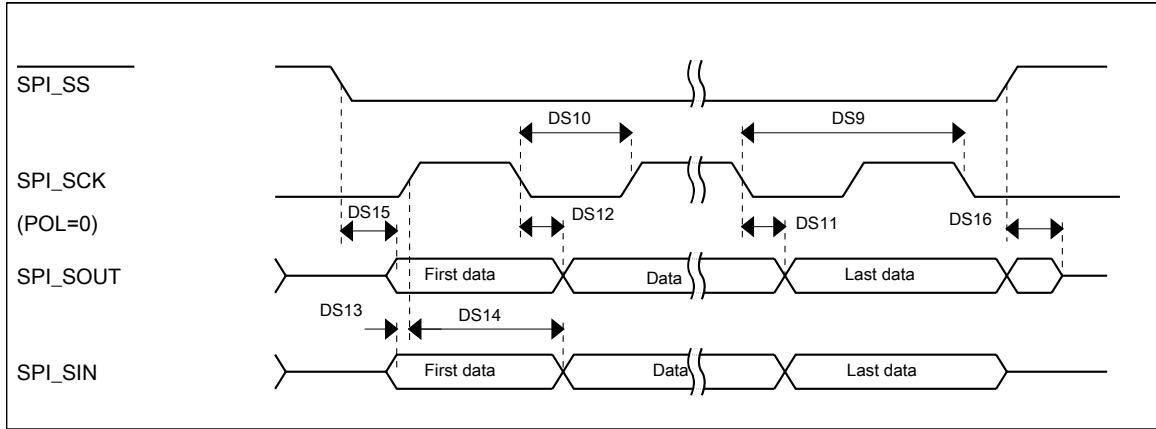


Figure 18. DSPI classic SPI timing — slave mode

### 6.5.8.4 Inter-Integrated Circuit Interface (I<sup>2</sup>C) timing

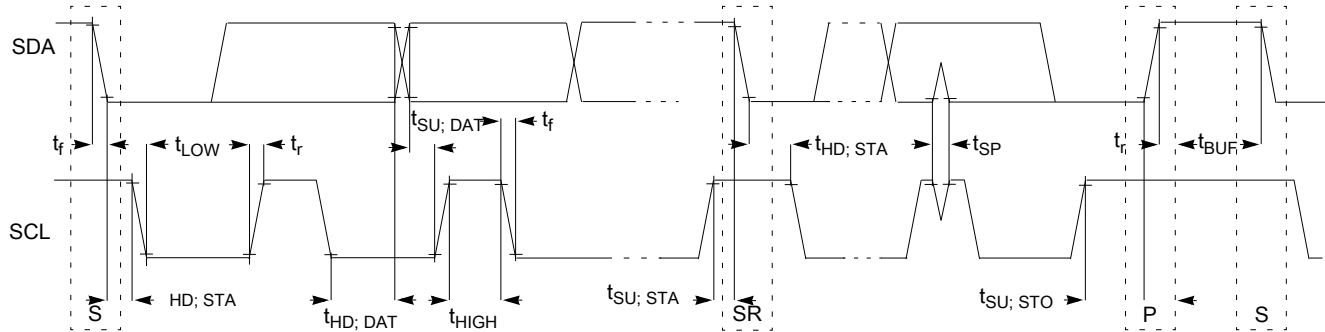
Table 40. I<sup>2</sup>C timing

| Characteristic   | Symbol                | Standard Mode    |                   | Fast Mode                              |                  | Unit |
|--|-----------------------|------------------|-------------------|--|------------------|------|
|  |                       | Minimum          | Maximum           | Minimum                                | Maximum          |      |
| SCL Clock Frequency  | f <sub>SCL</sub>      | 0                | 100               | 0                                      | 400              | kHz  |
| Hold time (repeated) START condition. After this period, the first clock pulse is generated. | t <sub>HD</sub> ; STA | 4                | —                 | 0.6                                    | —                | μs   |
| LOW period of the SCL clock  | t <sub>LOW</sub>      | 4.7              | —                 | 1.3                                    | —                | μs   |
| HIGH period of the SCL clock   | t <sub>HIGH</sub>     | 4                | —                 | 0.6                                    | —                | μs   |
| Set-up time for a repeated START condition   | t <sub>SU</sub> ; STA | 4.7              | —                 | 0.6                                    | —                | μs   |
| Data hold time for I <sup>2</sup> C bus devices  | t <sub>HD</sub> ; DAT | 0 <sup>1</sup>   | 3.45 <sup>2</sup> | 0 <sup>3</sup>                         | 0.9 <sup>1</sup> | μs   |
| Data set-up time   | t <sub>SU</sub> ; DAT | 250 <sup>4</sup> | —                 | 100 <sup>2, 5</sup>                    | —                | ns   |
| Rise time of SDA and SCL signals   | t <sub>r</sub>        | —                | 1000              | 20 + 0.1C <sub>b</sub> <sup>5, 6</sup> | 300              | ns   |
| Fall time of SDA and SCL signals   | t <sub>f</sub>        | —                | 300               | 20 + 0.1C <sub>b</sub> <sup>5, 6</sup> | 300              | ns   |
| Set-up time for STOP condition   | t <sub>SU</sub> ; STO | 4                | —                 | 0.6                                    | —                | μs   |
| Bus free time between STOP and START condition   | t <sub>BUF</sub>      | 4.7              | —                 | 1.3                                    | —                | μs   |
| Pulse width of spikes that must be suppressed by the input filter                            | t <sub>SP</sub>       | N/A              | N/A               | 0                                      | 50               | ns   |

1. The master mode I<sup>2</sup>C deasserts ACK of an address byte simultaneously with the falling edge of SCL. If no slaves acknowledge this address byte, then a negative hold time can result, depending on the edge rates of the SDA and SCL lines.
2. The maximum t<sub>HD</sub>; DAT must be met only if the device does not stretch the LOW period (t<sub>LOW</sub>) of the SCL signal.
3. Input signal Slew = 10 ns and Output Load = 50 pF.
4. Set-up time in slave-transmitter mode is 1 IP Bus clock period, if the TX FIFO is empty.

## KW36A/35A/34A Electrical Characteristics

- A Fast mode I<sup>2</sup>C bus device can be used in a Standard mode I<sup>2</sup>C bus system, but the requirement  $t_{SU; DAT} \geq 250$  ns must then be met. This is automatically the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, then it must output the next data bit to the SDA line  $t_{rmax} + t_{SU; DAT} = 1000 + 250 = 1250$  ns (according to the Standard mode I<sup>2</sup>C bus specification) before the SCL line is released.
- $C_b$  = total capacitance of the one bus line in pF.



**Figure 19. Timing definition for fast and standard mode devices on the I<sup>2</sup>C bus**

### 6.5.8.5 LPUART

See [General switching specifications](#).

## 6.5.9 Human-machine interfaces (HMI)

### 6.5.9.1 GPIO

The maximum input voltage on PTC0/1/2/3 is  $V_{DD} + 0.3V$ . For rest of the GPIO specification, see [General switching specifications](#).

## 6.6 DC-DC Converter Operating Requirements

**Table 41. DC-DC Converter operating conditions**

| Characteristic                             | Symbol  | Min   | Typ | Max | Unit    |
|--|---|-------|-----|-----|---------|
| Bypass Mode Supply Voltage (RF and Analog) | $V_{DD_{RF1}}$ ,<br>$V_{DD_{RF2}}$ ,<br>$V_{DD_{RF3}}$ , $V_{DD_{1P5}}$ | 1.425 | —   | 3.6 | Vdc     |
| Bypass Mode Supply Voltage (Digital)       | $V_{DD_X}$ , $V_{DCDC\_IN}$ ,<br>$V_{DD_A}$                             | 1.71  | —   | 3.6 | Vdc     |
| Buck Mode Supply Voltage <sup>1, 2</sup>   | $V_{DCDC\_IN}$  | 2.1   | —   | 3.6 | Vdc     |
| DC-DC Inductor                             |   |       |     |     |         |
| Value                                      |   | —     | 10  | —   | $\mu H$ |

*Table continues on the next page...*

**Table 41. DC-DC Converter operating conditions (continued)**

| Characteristic            | Symbol                  | Min | Typ  | Max  | Unit |
|---------------------------|-------------------------|-----|------|------|------|
| ESR                       |                         | —   | <0.2 | <0.5 | Ohms |
| DC-DC internal oscillator | DCDC <sub>Int_Osc</sub> | —   | 26   | —    | MHz  |

- In Buck mode, DC-DC converter needs 2.1 V minimum to start, the supply can drop to 1.8 V after DC-DC converter settles.
- In Buck mode, DC-DC converter generates 1.8 V at VDD\_1P8OUT and 1.5 V at VDD\_1P5OUT\_PMCIN pins. VDD\_1P8OUT should supply to VDD<sub>1</sub>, VDD<sub>2</sub> and VDD<sub>A</sub>. VDD\_1P5OUT\_PMCIN should supply to VDD\_RF<sub>1</sub> and VDD\_RF<sub>2</sub>. VDD\_RF<sub>3</sub> can be either supplied by 1.5 V or 1.8 V.

**Table 42. DC-DC Converter Specifications**

| Characteristics  | Conditions   | Symbol        | Min  | Typ  | Max                                     | Unit |
|--|--|---------------|------|--|---|------|
| DC-DC Converter Output Power (total power output of 1p8V and 1p5V) | V <sub>DCDC_IN</sub> above 2.7 V   | Pdcdc_out1    | —    | —  | 195 <sup>1</sup>                        | mW   |
|  | V <sub>DCDC_IN</sub> below 2.7 V   | Pdcdc_out2    | —    | —  | 140 <sup>1</sup>                        | mW   |
| Switching Frequency <sup>2</sup>                                   |  | DCDC_FREQ     | —    | DC-DC reference frequency divided by 16 <sup>3</sup> | —                                       | MHz  |
| Half FET Threshold   |  | I_half_FET    | —    | 5  | —                                       | mA   |
| Double FET Threshold   |  | I_double_FET  | —    | 40   | —                                       | mA   |
| Buck Mode  |  |               |      |  |   |      |
| DC-DC Conversion Efficiency  |  | DCDC_EFF_buck | —    | 90%  | —                                       | —    |
| 1.8 V Output Voltage   |  | VDD_1P8_buck  | 1.71 | —  | min(VDCDC_IN_buck, 3.5) <sup>4, 5</sup> | Vdc  |
| 1.8 V Output Current <sup>6, 7</sup>                               | VDD_1P8 = 3.0 V<br>1.5 V ≤ VDC_1P5 ≤ 1.7 V<br>V <sub>DCDC_IN</sub> =3.1 V  | IDD_1P8_buck1 | —    | —  | 39                                      | mA   |
|  | VDD_1P8 = 2.65 V<br>1.5 V ≤ VDC_1P5 ≤ 1.7 V<br>V <sub>DCDC_IN</sub> =2.7 V | IDD_1P8_buck2 | —    | —  | 45                                      | mA   |
|  | VDD_1P8 = 1.8 V<br>1.5 V ≤ VDC_1P5 ≤ 1.7 V<br>V <sub>DCDC_IN</sub> =2.1 V  | IDD_1P8_buck3 | —    | —  | 35                                      | mA   |
| 1.5 V Output Voltage   | Consumed by Radio for P <sub>out</sub> ≤+3.5 dBm                           | VDD_1P5_buck  | 1.45 | 1.5 <sup>8</sup>                                     | 1.8                                     | Vdc  |
| 1.5 V Output Voltage   | Consumed by Radio for P <sub>out</sub> =+5 dBm                             | VDD_1P5_buck  | 1.55 | 1.625 <sup>9</sup>                                   | 1.8                                     | Vdc  |

Table continues on the next page...

**Table 42. DC-DC Converter Specifications (continued)**

| Characteristics                            | Conditions   | Symbol                        | Min | Typ                        | Max | Unit |
|--|--|-------------------------------|-----|----------------------------|-----|------|
| 1.5 V Output Current <sup>6, 10</sup>      |  | IDD_1P5_buck                  | —   | —                          | 45  | mA   |
| DC-DC Transition Operating Behavior        | LSS→Run  | t_DCDCbuck_LSS→RUN            | —   | 50                         | —   | μs   |
| DC-DC Turn on Time                         |  | T <sub>DCDC_ON</sub>          | —   | 2.2 <sup>11</sup>          | —   | ms   |
| DC-DC Settling Time for increasing voltage |  | T <sub>DCDC_SETTLE_buck</sub> | —   | 3.11                       | —   | ms/V |
| DC-DC Settling Time for decreasing voltage | C = capacitance attached to the DC-DC V1P8 output rail.<br><br>V1 = the initial output voltage of the DC-DC<br><br>V2 = the final output voltage of the DC-DC<br><br>I2 = the load on the DC-DC output expressed in Amperes. | T <sub>DCDC_SETTLE_buck</sub> | —   | $(C \cdot (V1 - V2) / I2)$ | —   | s    |
| VDD_1P8 ripple                             | Typical ripple based on NXP recommended hardware configuration and typical loading (MCU only; no extra loads placed on DC-DC outputs)  | VDD_1P8 <sub>ripple</sub>     | —   | 30                         | —   | mV   |
| VDD_1P5 ripple                             | Typical ripple based on NXP recommended hardware configuration and typical loading (MCU only; no extra loads placed on DC-DC outputs)  | VDD_1P5 <sub>ripple</sub>     | —   | 30                         | —   | mV   |

1. This is the steady state DC output power. Excessive transient current load from external device causes 1p8V and 1P5 output voltage unregulated temporary.
2. This is the frequency that is observed at LN and LP pins.
3. DC-DC reference frequency derives from the RF oscillator or the DC-DC internal oscillator.
4. The voltage output level can be controlled by programming DCDC\_VDD1P8CTRL\_TRG field in DCDC\_REG3.
5. In Buck mode, the maximum VDD\_1P8 output is the minimum of either VDCDC\_IN\_BUCK minus 50 mV or 3.5 V. For example, if VDCDC\_IN = 2.1 V, maximum VDD\_1P8 is 2.05 V. If VDCDC\_IN = 3.6 V, maximum VDD\_1P8 is 3.5 V.
6. The output current specification in buck mode represents the maximum current the DC-DC converter can deliver. The KW36A/35A/34A radio and MCU blocks current consumption is not excluded. The maximum output power of the DC-DC converter is 140 mW when V<sub>DCDC\_IN</sub> is below 2.7 V and 195 mW when V<sub>DCDC\_IN</sub> is above 2.7 V. The available supply current for external device depends on the energy consumed by the internal peripherals in KW36A/35A/34A.
7. When using DC-DC in low-power mode (pulsed mode), current load must be less than 1 mA.
8. User needs to program DCDC\_VDD1P5CTRL\_TRG\_BUCK field in DCDC\_REG3 register to ensure that a worst case minimum of 1.45 V is available as VDD\_1P5\_buck. VDD\_1P5 must not be programmed higher than VDD\_1P8.

9. User needs to program DCDC\_VDD1P5CTRL\_TRG\_BUCK field in DCDC\_REG3 register to ensure that a worst case minimum of 1.55 V is available as VDD\_1P5\_buck. VDD\_1P5 must not be programmed higher than VDD\_1P8.
10. 1.5 V is intended to supply power to KW36A/35A/34A. It is not designed to supply power to an external device.
11. Turn on time is measured from the application of power (to DCDC\_IN) till the DCDC\_REG0[DCDC\_STS\_DC\_OK] bit is set. Code execution may begin before the DCDC\_REG0[DCDC\_STS\_DC\_OK] bit is set. The full device specification is not guaranteed until the bit sets.

## 6.7 Ratings

### 6.7.1 Thermal handling ratings

Table 43. Thermal handling ratings

| Symbol           | Description                   | Min. | Max. | Unit | Notes |
|------------------|-------------------------------|------|------|------|-------|
| T <sub>STG</sub> | Storage temperature           | -55  | 150  | °C   | 1     |
| T <sub>SDR</sub> | Solder temperature, lead-free | —    | 260  | °C   | 2     |

1. Determined according to JEDEC Standard JESD22-A103, *High Temperature Storage Life*.
2. Determined according to IPC/JEDEC Standard J-STD-020, *Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices*.

### 6.7.2 Moisture handling ratings

Table 44. Moisture handling ratings

| Symbol | Description                | Min. | Max. | Unit | Notes |
|--------|----------------------------|------|------|------|-------|
| MSL    | Moisture sensitivity level | —    | 3    | —    | 1     |

1. Determined according to IPC/JEDEC Standard J-STD-020, *Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices*.

### 6.7.3 ESD handling ratings

Table 45. ESD handling ratings

| Symbol           | Description   | Min.  | Max.  | Unit | Notes |
|------------------|---|-------|-------|------|-------|
| V <sub>HBM</sub> | Electrostatic discharge voltage, human body model     | -2000 | +2000 | V    | 1     |
| V <sub>CDM</sub> | Electrostatic discharge voltage, charged-device model |       |       |      | 2     |
|                  | All pins except the corner pins                       | -500  | 500   | V    |       |
|                  | Corner pins only                                      | -750  | 750   | V    |       |
| I <sub>LAT</sub> | Latch-up current at ambient temperature of 105 °C     | -100  | +100  | mA   | 3     |

1. Determined according to JEDEC Standard JESD22-A114, *Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)*.

## Pin Diagrams and Pin Assignments

2. Determined according to JEDEC Standard JESD22-C101, *Field-Induced Charged-Device Model Test Method for Electrostatic-Discharge-Withstand Thresholds of Microelectronic Components*.
3. Determined according to JEDEC Standard JESD78, *IC Latch-Up Test*.

### 6.7.4 Voltage and current operating ratings

**Table 46. Voltage and current operating ratings**

| Symbol         | Description   | Min.           | Max.           | Unit |
|----------------|---|----------------|----------------|------|
| $V_{DD}$       | Digital supply voltage  | -0.3           | 3.8            | V    |
| $I_{DD}$       | Digital supply current  | —              | 120            | mA   |
| $V_{IO}$       | IO pin input voltage  | -0.3           | $V_{DD} + 0.3$ | V    |
| $I_D$          | Instantaneous maximum current single pin limit (applies to all port pins) | -25            | 25             | mA   |
| $V_{DDA}$      | Analog supply voltage   | $V_{DD} - 0.3$ | $V_{DD} + 0.3$ | V    |
| $V_{IO\_DCDC}$ | IO pins in the DC-DC voltage domain (DCDC_CFG and PSWITCH)                | GND            | VDCDC          | V    |

## 7 Pin Diagrams and Pin Assignments

### 7.1 KW36A Signal Multiplexing and Pin Assignments

The following table shows the signals available on each pin and the locations of these pins on the devices supported by this document. The Port Control and Interrupt Module is used to select the functionality for each GPIO pin. ALT0 is reserved for analog functions on some GPIO pins. ALT1 – ALT9 are assigned to the available digital functions on each GPIO pin. GPIO pins with a default of “disabled” are high impedance after reset – their input and output buffers are disabled.

| 40<br>"Wettable"<br>HVQ<br>FN | 48<br>"Wettable"<br>HVQ<br>FN | 48<br>LQFN | Pin Name | Default  | ALT0 | ALT1              | ALT2          | ALT3              | ALT4    | ALT5           | ALT6 | ALT7 | ALT8 | ALT9 |
|-------------------------------|-------------------------------|------------|----------|----------|------|-------------------|---------------|-------------------|---------|----------------|------|------|------|------|
| —                             | 4                             | 4          | PTA16    | DISABLED |      | PTA16/<br>LLWU_P4 | SPI1_<br>SOUT | LPUART1_<br>RTS_b |         | TPM0_<br>CH0   |      |      |      |      |
| —                             | 5                             | 5          | PTA17    | DISABLED |      | PTA17/<br>LLWU_P5 | SPI1_<br>SIN  | LPUART1_<br>RX    | CAN0_TX | TPM_<br>CLKIN1 |      |      |      |      |
| —                             | 6                             | 6          | PTA18    | DISABLED |      | PTA18/<br>LLWU_P6 | SPI1_<br>SCK  | LPUART1_<br>TX    | CAN0_RX | TPM2_<br>CH0   |      |      |      |      |



## Pin Diagrams and Pin Assignments

| 40<br>"Wett<br>able"<br>HVQ<br>FN | 48<br>"Wett<br>able"<br>HVQ<br>FN | 48<br>LQF<br>N | Pin Name   | Default                   | ALT0                      | ALT1   | ALT2          | ALT3              | ALT4              | ALT5         | ALT6 | ALT7          | ALT8              | ALT9 |
|-----------------------------------|-----------------------------------|----------------|------------|---------------------------|---------------------------|--|---------------|-------------------|-------------------|--------------|------|---------------|-------------------|------|
| —                                 | 7                                 | 7              | PTA19      | ADC0_SE5                  | ADC0_SE5                  | PTA19/<br>LLWU_P7                              | SPI1_<br>PCS0 | LPUART1_<br>CTS_b |                   | TPM2_<br>CH1 |      |               |                   |      |
| —                                 | 24                                | 24             | ADC0_DPO   | ADC0_<br>DPO/<br>CMP0_IN0 | ADC0_<br>DPO/<br>CMP0_IN0 |  |               |                   |                   |              |      |               |                   |      |
| —                                 | 25                                | 25             | ADC0_DM0   | ADC0_<br>DM0/<br>CMP0_IN1 | ADC0_<br>DM0/<br>CMP0_IN1 |  |               |                   |                   |              |      |               |                   |      |
| —                                 | 41                                | 41             | PTC5       | DISABLED                  |                           | PTC5/<br>LLWU_<br>P13/<br>RF_NOT_<br>ALLOWED   |               | LPTMR0_<br>ALT2   | LPUART0_<br>RTS_b | TPM1_<br>CH1 |      | BSM_CLK       |                   |      |
| —                                 | 42                                | 42             | PTC6       | DISABLED                  |                           | PTC6/<br>LLWU_<br>P14/<br>RF_<br>RFOSC_<br>EN  |               | I2C1_SCL          | LPUART0_<br>RX    | TPM2_<br>CH0 |      | BSM_<br>FRAME |                   |      |
| —                                 | 43                                | 43             | PTC7       | DISABLED                  |                           | PTC7/<br>LLWU_P15                              | SPI0_<br>PCS2 | I2C1_SDA          | LPUART0_<br>TX    | TPM2_<br>CH1 |      | BSM_<br>DATA  |                   |      |
| 1                                 | 48                                | 48             | PTC19      | DISABLED                  |                           | PTC19/<br>LLWU_P3/<br>RF_<br>EARLY_<br>WARNING | SPI0_<br>PCS0 | I2C0_SCL          | LPUART0_<br>CTS_b | BSM_CLK      |      |               | LPUART1_<br>CTS_b |      |
| 2                                 | 1                                 | 1              | PTA0       | SWD_DIO                   |                           | PTA0   | SPI0_<br>PCS1 |                   |                   | TPM1_<br>CH0 |      | SWD_DIO       |                   |      |
| 3                                 | 2                                 | 2              | PTA1       | SWD_CLK                   |                           | PTA1   | SPI1_<br>PCS0 |                   |                   | TPM1_<br>CH1 |      | SWD_CLK       |                   |      |
| 4                                 | 3                                 | 3              | PTA2       | RESET_b                   |                           | PTA2   |               |                   |                   | TPM0_<br>CH3 |      | RESET_b       |                   |      |
| 5                                 | 8                                 | 8              | PSWITCH    | PSWITCH                   | PSWITCH                   |  |               |                   |                   |              |      |               |                   |      |
| 6                                 | 9                                 | 9              | DCDC_CFG   | DCDC_CFG                  | DCDC_CFG                  |  |               |                   |                   |              |      |               |                   |      |
| 7                                 | 9                                 | 10             | VDCDC_IN   | VDCDC_IN                  | VDCDC_IN                  |  |               |                   |                   |              |      |               |                   |      |
| 8                                 | 10                                | 11             | DCDC_LP    | DCDC_LP                   | DCDC_LP                   |  |               |                   |                   |              |      |               |                   |      |
| 9                                 | 11                                | 13             | DCDC_GND   | DCDC_GND                  | DCDC_GND                  |  |               |                   |                   |              |      |               |                   |      |
| 10                                | 12                                | 12             | DCDC_LN    | DCDC_LN                   | DCDC_LN                   |  |               |                   |                   |              |      |               |                   |      |
| 11                                | 13                                | 14             | VDD_1P8OUT | VDD_1P8OUT                | VDD_1P8OUT                |  |               |                   |                   |              |      |               |                   |      |
| 12                                | 14                                | —              | DCDC_LN    | DCDC_LN                   | DCDC_LN                   |  |               |                   |                   |              |      |               |                   |      |

## Pin Diagrams and Pin Assignments

| 40<br>"Wett<br>able"<br>HVQ<br>FN | 48<br>"Wett<br>able"<br>HVQ<br>FN | 48<br>LQF<br>N | Pin Name         | Default           | ALT0              | ALT1                     | ALT2          | ALT3     | ALT4          | ALT5     | ALT6     | ALT7    | ALT8       | ALT9    |
|-----------------------------------|-----------------------------------|----------------|------------------|-------------------|-------------------|--------------------------|---------------|----------|---------------|----------|----------|---------|------------|---------|
| 13                                | 15                                | 15             | VDD_1P5OUT_PMCIN | VDD_1P5OUT_PMCIN  | VDD_1P5OUT_PMCIN  |                          |               |          |               |          |          |         |            |         |
| 14                                | 16                                | 16             | PTB0             | DISABLED          |                   | PTB0/LLWU_P8/RF_RFOSC_EN |               | I2C0_SCL | CMP0_OUT      | TPM0_CH1 |          | CLKOUT  | CAN0_TX    |         |
| 15                                | 17                                | 17             | PTB1             | ADC0_SE1/CMP0_IN5 | ADC0_SE1/CMP0_IN5 | PTB1/RF_PRIORITY         | DTM_RX        | I2C0_SDA | LPTMR0_ALT1   | TPM0_CH2 |          | CMT_IRO | CAN0_RX    |         |
| 16                                | 18                                | 18             | PTB2             | ADC0_SE3/CMP0_IN3 | ADC0_SE3/CMP0_IN3 | PTB2/RF_NOT_ALLOWED      |               | DTM_TX   |               | TPM1_CH0 |          |         |            |         |
| 17                                | 19                                | 19             | PTB3             | ADC0_SE2/CMP0_IN4 | ADC0_SE2/CMP0_IN4 | PTB3/ERCLK32K            | LPUART1_RTS_b |          |               | CLKOUT   | TPM1_CH1 |         | RTC_CLKOUT |         |
| 18                                | 20                                | 20             | VDD_0            | VDD_0             | VDD_0             |                          |               |          |               |          |          |         |            |         |
| 19                                | 21                                | 21             | PTB16            | EXTAL32K          | EXTAL32K          | PTB16                    | LPUART1_RX    | I2C1_SCL |               | TPM2_CH0 |          |         |            |         |
| 20                                | 22                                | 22             | PTB17            | XTAL32K           | XTAL32K           | PTB17                    | LPUART1_TX    | I2C1_SDA |               | TPM2_CH1 |          | BSM_CLK |            |         |
| 21                                | 23                                | 23             | PTB18            | NMI_b             | ADC0_SE4/CMP0_IN2 | PTB18                    | LPUART1_CTS_b | I2C1_SCL | TPM_CLKIN0    | TPM0_CH0 |          | NMI_b   |            |         |
| 22                                | 26                                | 26             | VREFL/VSSA       | VREFL/VSSA        | VREFL/VSSA        |                          |               |          |               |          |          |         |            |         |
| 23                                | 27                                | 27             | VREFH/VREF_OUT   | VREFH/VREF_OUT    | VREFH/VREF_OUT    |                          |               |          |               |          |          |         |            |         |
| 24                                | 28                                | 28             | VDDA             | VDDA              | VDDA              |                          |               |          |               |          |          |         |            |         |
| 25                                | 29                                | 29             | XTAL_OUT         | XTAL_OUT          | XTAL_OUT          |                          |               |          |               |          |          |         |            |         |
| 26                                | 30                                | 30             | EXTAL            | EXTAL             | EXTAL             |                          |               |          |               |          |          |         |            |         |
| 27                                | 31                                | 31             | XTAL             | XTAL              | XTAL              |                          |               |          |               |          |          |         |            |         |
| 28                                | 32                                | 32             | VDD_RF3          | VDD_RF3           | VDD_RF3           |                          |               |          |               |          |          |         |            |         |
| 29                                | 33                                | 33             | ANT              | ANT               | ANT               |                          |               |          |               |          |          |         |            |         |
| 30                                | 34                                | 34             | GANT             | GANT              | GANT              |                          |               |          |               |          |          |         |            |         |
| 31                                | 35                                | 35             | VDD_RF2          | VDD_RF2           | VDD_RF2           |                          |               |          |               |          |          |         |            |         |
| 32                                | 36                                | 36             | VDD_RF1          | VDD_RF1           | VDD_RF1           |                          |               |          |               |          |          |         |            |         |
| 33                                | 37                                | 37             | PTC1             | DISABLED          |                   | PTC1/RF_EARLY_WARNING    |               | I2C0_SDA | LPUART0_RTS_b | TPM0_CH2 |          |         | SPI1_SCK   | BSM_CLK |

| 40<br>"Wett<br>able"<br>HVQ<br>FN | 48<br>"Wett<br>able"<br>HVQ<br>FN | 48<br>LQF<br>N | Pin Name | Default  | ALT0  | ALT1  | ALT2          | ALT3     | ALT4              | ALT5          | ALT6 | ALT7         | ALT8              | ALT9          |
|-----------------------------------|-----------------------------------|----------------|----------|----------|-------|---|---------------|----------|-------------------|---------------|------|--------------|-------------------|---------------|
| 34                                | 38                                | 38             | PTC2     | DISABLED |       | PTC2/<br>LLWU_P10                           | TX_<br>SWITCH | I2C1_SCL | LPUART0_<br>RX    | CMT_IRO       |      | DTM_RX       | SPI1_<br>SOUT     | BSM_<br>FRAME |
| 35                                | 39                                | 39             | PTC3     | DISABLED |       | PTC3/<br>LLWU_P11                           | RX_<br>SWITCH | I2C1_SDA | LPUART0_<br>TX    | TPM0_<br>CH1  |      | DTM_TX       | SPI1_SIN          | CAN0_TX       |
| 36                                | 40                                | 40             | PTC4     | DISABLED |       | PTC4/<br>LLWU_<br>P12/<br>BLE_RF_<br>ACTIVE |               | EXTRG_IN | LPUART0_<br>CTS_b | TPM1_<br>CH0  |      | BSM_<br>DATA | SPI1_<br>PCS0     | CAN0_RX       |
| 37                                | 44                                | 44             | VDD_1    | VDD_1    | VDD_1 |   |               |          |                   |               |      |              |                   |               |
| 38                                | 45                                | 45             | PTC16    | DISABLED |       | PTC16/<br>LLWU_P0/<br>RF_<br>STATUS         | SPI0_SCK      | I2C0_SDA | LPUART0_<br>RTS_b | TPM0_<br>CH3  |      |              | LPUART1_<br>RTS_b |               |
| 39                                | 46                                | 46             | PTC17    | DISABLED |       | PTC17/<br>LLWU_P1/<br>RF_EXT_<br>OSC_EN     | SPI0_<br>SOUT | I2C1_SCL | LPUART0_<br>RX    | BSM_<br>FRAME |      | DTM_RX       | LPUART1_<br>RX    |               |
| 40                                | 47                                | 47             | PTC18    | DISABLED |       | PTC18/<br>LLWU_P2                           | SPI0_SIN      | I2C1_SDA | LPUART0_<br>TX    | BSM_<br>DATA  |      | DTM_TX       | LPUART1_<br>TX    |               |
| 41                                | 49                                | 49-64          | Ground   | NA       |       |   |               |          |                   |               |      |              |                   |               |

## 7.2 KW36A Pinouts

KW36A device pinouts are shown in the figures below.

Pin Diagrams and Pin Assignments

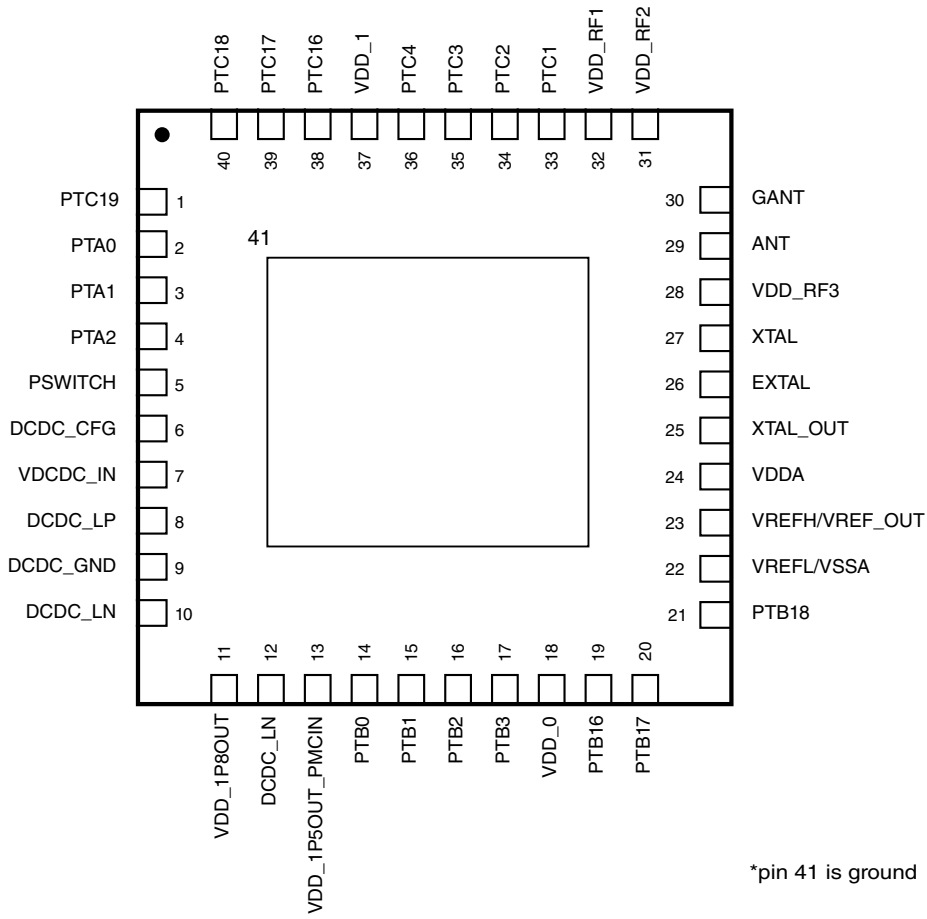


Figure 20. 40-pin "Wettable" HVQFN pinout diagram

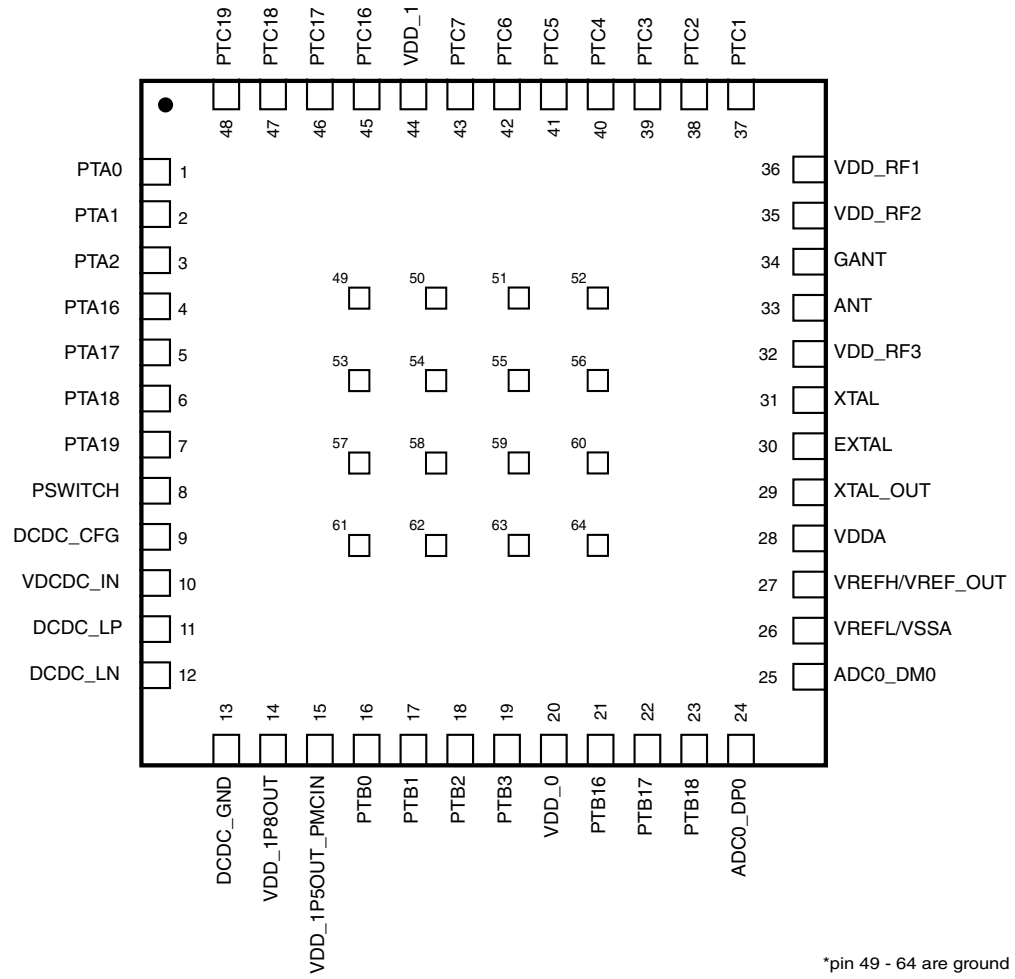


Figure 21. 48-pin LQFN pinout diagram

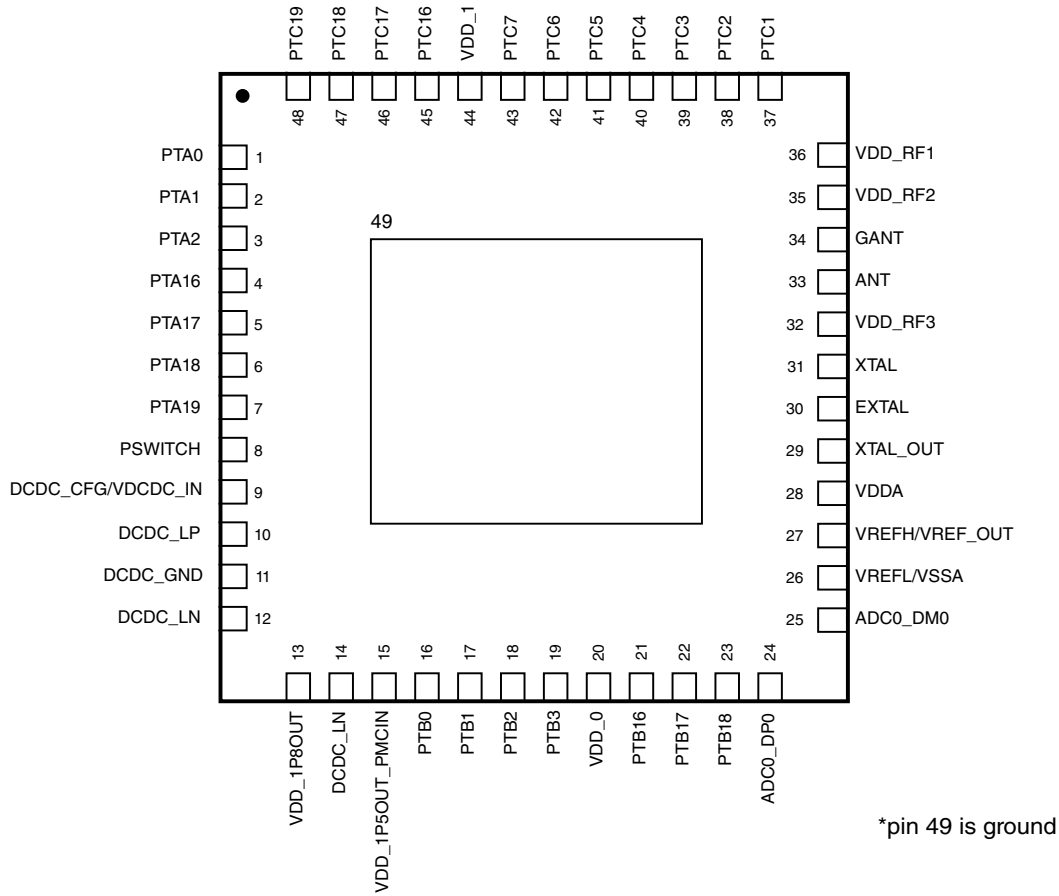


Figure 22. 48-pin "Wettable" HVQFN pinout diagram

### 7.3 KW35A Signal Multiplexing and Pin Assignments

The following table shows the signals available on each pin and the locations of these pins on the devices supported by this document. The Port Control and Interrupt Module is used to select the functionality for each GPIO pin. ALT0 is reserved for analog functions on some GPIO pins. ALT1 – ALT9 are assigned to the available digital functions on each GPIO pin. GPIO pins with a default of “disabled” are high impedance after reset – their input and output buffers are disabled.

## Pin Diagrams and Pin Assignments

| 40<br>"Wett<br>able"<br>HVQ<br>FN | 48<br>"Wett<br>able"<br>HVQ<br>FN | Pin Name       | Default                   | ALT0                      | ALT1   | ALT2          | ALT3            | ALT4              | ALT5           | ALT6 | ALT7          | ALT8 | ALT9 |
|-----------------------------------|-----------------------------------|----------------|---------------------------|---------------------------|--|---------------|-----------------|-------------------|----------------|------|---------------|------|------|
| —                                 | 4                                 | PTA16          | DISABLED                  |                           | PTA16/<br>LLWU_P4                              | SPI1_<br>SOUT |                 |                   | TPM0_CH0       |      |               |      |      |
| —                                 | 5                                 | PTA17          | DISABLED                  |                           | PTA17/<br>LLWU_P5                              | SPI1_SIN      |                 |                   | TPM_<br>CLKIN1 |      |               |      |      |
| —                                 | 6                                 | PTA18          | DISABLED                  |                           | PTA18/<br>LLWU_P6                              | SPI1_SCK      |                 |                   | TPM2_CH0       |      |               |      |      |
| —                                 | 7                                 | PTA19          | ADC0_SE5                  | ADC0_SE5                  | PTA19/<br>LLWU_P7                              | SPI1_PCS0     |                 |                   | TPM2_CH1       |      |               |      |      |
| —                                 | 24                                | ADC0_DP0       | ADC0_<br>DP0/<br>CMP0_IN0 | ADC0_<br>DP0/<br>CMP0_IN0 |  |               |                 |                   |                |      |               |      |      |
| —                                 | 25                                | ADC0_DM0       | ADC0_<br>DM0/<br>CMP0_IN1 | ADC0_<br>DM0/<br>CMP0_IN1 |  |               |                 |                   |                |      |               |      |      |
| —                                 | 41                                | PTC5           | DISABLED                  |                           | PTC5/<br>LLWU_P13/<br>RF_NOT_<br>ALLOWED       |               | LPTMR0_<br>ALT2 | LPUART0_<br>RTS_b | TPM1_CH1       |      | BSM_CLK       |      |      |
| —                                 | 42                                | PTC6           | DISABLED                  |                           | PTC6/<br>LLWU_P14/<br>RF_<br>RFOSC_<br>EN      |               | I2C1_SCL        | LPUART0_<br>RX    | TPM2_CH0       |      | BSM_<br>FRAME |      |      |
| —                                 | 43                                | PTC7           | DISABLED                  |                           | PTC7/<br>LLWU_P15                              | SPI0_PCS2     | I2C1_SDA        | LPUART0_<br>TX    | TPM2_CH1       |      | BSM_DATA      |      |      |
| 1                                 | 48                                | PTC19          | DISABLED                  |                           | PTC19/<br>LLWU_P3/<br>RF_<br>EARLY_<br>WARNING | SPI0_PCS0     | I2C0_SCL        | LPUART0_<br>CTS_b | BSM_CLK        |      |               |      |      |
| 2                                 | 1                                 | PTA0           | SWD_DIO                   |                           | PTA0   | SPI0_PCS1     |                 |                   | TPM1_CH0       |      | SWD_DIO       |      |      |
| 3                                 | 2                                 | PTA1           | SWD_CLK                   |                           | PTA1   | SPI1_PCS0     |                 |                   | TPM1_CH1       |      | SWD_CLK       |      |      |
| 4                                 | 3                                 | PTA2           | RESET_b                   |                           | PTA2   |               |                 |                   | TPM0_CH3       |      | RESET_b       |      |      |
| 5                                 | 8                                 | PSWITCH        | PSWITCH                   | PSWITCH                   |  |               |                 |                   |                |      |               |      |      |
| 6                                 | 9                                 | DCDC_<br>CFG   | DCDC_<br>CFG              | DCDC_<br>CFG              |  |               |                 |                   |                |      |               |      |      |
| 7                                 | 9                                 | VDCDC_IN       | VDCDC_IN                  | VDCDC_IN                  |  |               |                 |                   |                |      |               |      |      |
| 8                                 | 10                                | DCDC_LP        | DCDC_LP                   | DCDC_LP                   |  |               |                 |                   |                |      |               |      |      |
| 9                                 | 11                                | DCDC_<br>GND   | DCDC_<br>GND              | DCDC_<br>GND              |  |               |                 |                   |                |      |               |      |      |
| 10                                | 12                                | DCDC_LN        | DCDC_LN                   | DCDC_LN                   |  |               |                 |                   |                |      |               |      |      |
| 11                                | 13                                | VDD_<br>1P8OUT | VDD_<br>1P8OUT            | VDD_<br>1P8OUT            |  |               |                 |                   |                |      |               |      |      |
| 12                                | 14                                | DCDC_LN        | DCDC_LN                   | DCDC_LN                   |  |               |                 |                   |                |      |               |      |      |

## Pin Diagrams and Pin Assignments

| 40<br>"Wett<br>able"<br>HVQ<br>FN | 48<br>"Wett<br>able"<br>HVQ<br>FN | Pin Name         | Default           | ALT0              | ALT1                     | ALT2      | ALT3     | ALT4          | ALT5     | ALT6 | ALT7       | ALT8      | ALT9      |
|-----------------------------------|-----------------------------------|------------------|-------------------|-------------------|--------------------------|-----------|----------|---------------|----------|------|------------|-----------|-----------|
| 13                                | 15                                | VDD_1P5OUT_PMCIN | VDD_1P5OUT_PMCIN  | VDD_1P5OUT_PMCIN  |                          |           |          |               |          |      |            |           |           |
| 14                                | 16                                | PTB0             | DISABLED          |                   | PTB0/LLWU_P8/RF_RFOSC_EN |           | I2C0_SCL | CMP0_OUT      | TPM0_CH1 |      | CLKOUT     |           |           |
| 15                                | 17                                | PTB1             | ADC0_SE1/CMP0_IN5 | ADC0_SE1/CMP0_IN5 | PTB1/RF_PRIORITY         | DTM_RX    | I2C0_SDA | LPTMR0_ALT1   | TPM0_CH2 |      | CMT_IRO    |           |           |
| 16                                | 18                                | PTB2             | ADC0_SE3/CMP0_IN3 | ADC0_SE3/CMP0_IN3 | PTB2/RF_NOT_ALLOWED      |           | DTM_TX   |               | TPM1_CH0 |      |            |           |           |
| 17                                | 19                                | PTB3             | ADC0_SE2/CMP0_IN4 | ADC0_SE2/CMP0_IN4 | PTB3/ERCLK32K            |           |          | CLKOUT        | TPM1_CH1 |      | RTC_CLKOUT |           |           |
| 18                                | 20                                | VDD_0            | VDD_0             | VDD_0             |                          |           |          |               |          |      |            |           |           |
| 19                                | 21                                | PTB16            | EXTAL32K          | EXTAL32K          | PTB16                    |           | I2C1_SCL |               | TPM2_CH0 |      |            |           |           |
| 20                                | 22                                | PTB17            | XTAL32K           | XTAL32K           | PTB17                    |           | I2C1_SDA |               | TPM2_CH1 |      | BSM_CLK    |           |           |
| 21                                | 23                                | PTB18            | NMI_b             | ADC0_SE4/CMP0_IN2 | PTB18                    |           | I2C1_SCL | TPM_CLKIN0    | TPM0_CH0 |      | NMI_b      |           |           |
| 22                                | 26                                | VREFL/VSSA       | VREFL/VSSA        | VREFL/VSSA        |                          |           |          |               |          |      |            |           |           |
| 23                                | 27                                | VREFH/VREF_OUT   | VREFH/VREF_OUT    | VREFH/VREF_OUT    |                          |           |          |               |          |      |            |           |           |
| 24                                | 28                                | VDDA             | VDDA              | VDDA              |                          |           |          |               |          |      |            |           |           |
| 25                                | 29                                | XTAL_OUT         | XTAL_OUT          | XTAL_OUT          |                          |           |          |               |          |      |            |           |           |
| 26                                | 30                                | EXTAL            | EXTAL             | EXTAL             |                          |           |          |               |          |      |            |           |           |
| 27                                | 31                                | XTAL             | XTAL              | XTAL              |                          |           |          |               |          |      |            |           |           |
| 28                                | 32                                | VDD_RF3          | VDD_RF3           | VDD_RF3           |                          |           |          |               |          |      |            |           |           |
| 29                                | 33                                | ANT              | ANT               | ANT               |                          |           |          |               |          |      |            |           |           |
| 30                                | 34                                | GANT             | GANT              | GANT              |                          |           |          |               |          |      |            |           |           |
| 31                                | 35                                | VDD_RF2          | VDD_RF2           | VDD_RF2           |                          |           |          |               |          |      |            |           |           |
| 32                                | 36                                | VDD_RF1          | VDD_RF1           | VDD_RF1           |                          |           |          |               |          |      |            |           |           |
| 33                                | 37                                | PTC1             | DISABLED          |                   | PTC1/RF_EARLY_WARNING    |           | I2C0_SDA | LPUART0_RTS_b | TPM0_CH2 |      |            | SPI1_SCK  | BSM_CLK   |
| 34                                | 38                                | PTC2             | DISABLED          |                   | PTC2/LLWU_P10            | TX_SWITCH | I2C1_SCL | LPUART0_RX    | CMT_IRO  |      | DTM_RX     | SPI1_SOUT | BSM_FRAME |
| 35                                | 39                                | PTC3             | DISABLED          |                   | PTC3/LLWU_P11            | RX_SWITCH | I2C1_SDA | LPUART0_TX    | TPM0_CH1 |      | DTM_TX     | SPI1_SIN  |           |



| 40<br>"Wettable"<br>HVQFN | 48<br>"Wettable"<br>HVQFN | Pin Name | Default  | ALT0  | ALT1                                    | ALT2          | ALT3     | ALT4              | ALT5          | ALT6 | ALT7     | ALT8      | ALT9 |
|---------------------------|---------------------------|----------|----------|-------|---|---------------|----------|-------------------|---------------|------|----------|-----------|------|
| 36                        | 40                        | PTC4     | DISABLED |       | PTC4/<br>LLWU_P12/<br>BLE_RF_<br>ACTIVE |               | EXTRG_IN | LPUART0_<br>CTS_b | TPM1_CH0      |      | BSM_DATA | SPI1_PCS0 |      |
| 37                        | 44                        | VDD_1    | VDD_1    | VDD_1 |   |               |          |                   |               |      |          |           |      |
| 38                        | 45                        | PTC16    | DISABLED |       | PTC16/<br>LLWU_P0/<br>RF_<br>STATUS     | SPI0_SCK      | I2C0_SDA | LPUART0_<br>RTS_b | TPM0_CH3      |      |          |           |      |
| 39                        | 46                        | PTC17    | DISABLED |       | PTC17/<br>LLWU_P1/<br>RF_EXT_<br>OSC_EN | SPI0_<br>SOUT | I2C1_SCL | LPUART0_<br>RX    | BSM_<br>FRAME |      | DTM_RX   |           |      |
| 40                        | 47                        | PTC18    | DISABLED |       | PTC18/<br>LLWU_P2                       | SPI0_SIN      | I2C1_SDA | LPUART0_<br>TX    | BSM_DATA      |      | DTM_TX   |           |      |
| 41                        | 49                        | Ground   | NA       |       |   |               |          |                   |               |      |          |           |      |

## 7.4 KW35A Pinouts

KW35A device pinouts are shown in the figures below.

Pin Diagrams and Pin Assignments

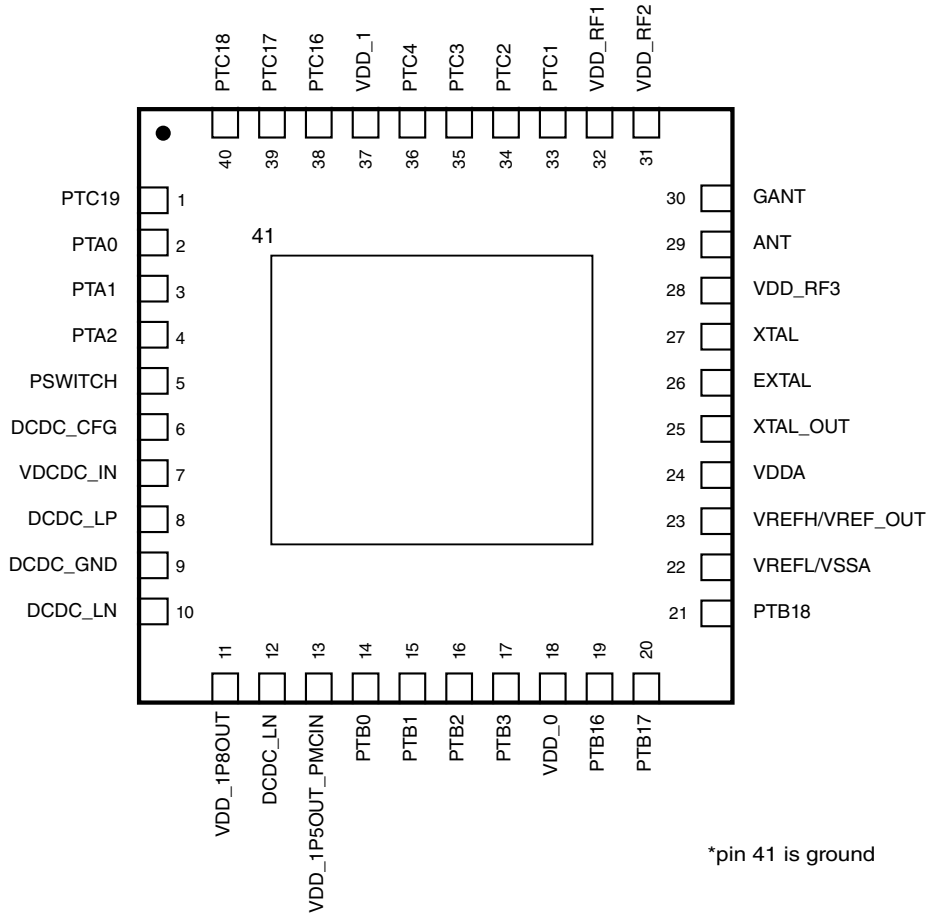


Figure 23. 40-pin "Wettable" HVQFN pinout diagram

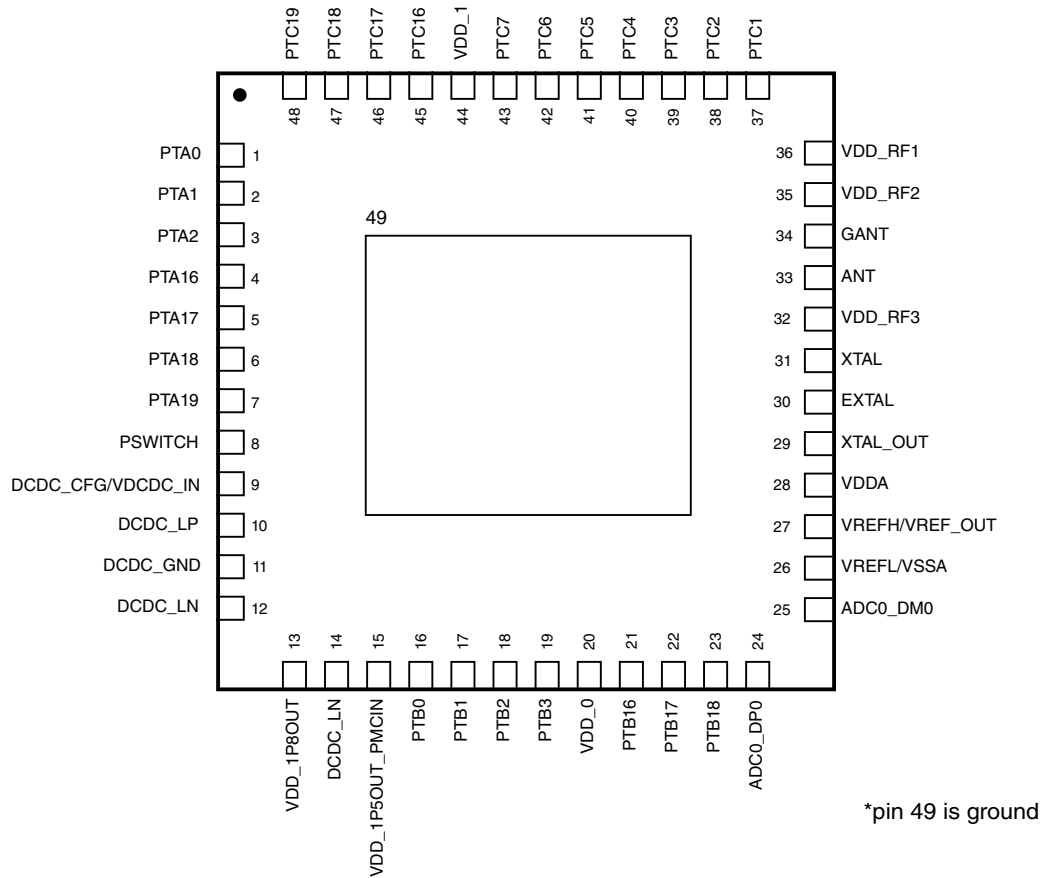


Figure 24. 48-pin "Wetable" HVQFN pinout diagram

## 7.5 KW34A Signal Multiplexing and Pin Assignments

The following table shows the signals available on each pin and the locations of these pins on the devices supported by this document. The Port Control and Interrupt Module is used to select the functionality for each GPIO pin. ALT0 is reserved for analog functions on some GPIO pins. ALT1 – ALT9 are assigned to the available digital functions on each GPIO pin. GPIO pins with a default of “disabled” are high impedance after reset – their input and output buffers are disabled.

## Pin Diagrams and Pin Assignments

| 48<br>"Wett<br>able"<br>HVQ<br>FN | Pin Name                  | Default                   | ALT0                      | ALT1                                 | ALT2      | ALT3     | ALT4            | ALT5           | ALT6 | ALT7           | ALT8 | ALT9 |
|-----------------------------------|---------------------------|---------------------------|---------------------------|--------------------------------------|-----------|----------|-----------------|----------------|------|----------------|------|------|
| 1                                 | PTA0                      | SWD_DIO                   |                           | PTA0                                 | SPI0_PCS1 |          |                 | TPM1_CH0       |      | SWD_DIO        |      |      |
| 2                                 | PTA1                      | SWD_CLK                   |                           | PTA1                                 | SPI1_PCS0 |          |                 | TPM1_CH1       |      | SWD_CLK        |      |      |
| 3                                 | PTA2                      | RESET_b                   |                           | PTA2                                 |           |          |                 | TPM0_CH3       |      | RESET_b        |      |      |
| 4                                 | PTA16                     | DISABLED                  |                           | PTA16/<br>LLWU_P4                    | SPI1_SOUT |          |                 | TPM0_CH0       |      |                |      |      |
| 5                                 | PTA17                     | DISABLED                  |                           | PTA17/<br>LLWU_P5                    | SPI1_SIN  |          |                 | TPM_<br>CLKIN1 |      |                |      |      |
| 6                                 | PTA18                     | DISABLED                  |                           | PTA18/<br>LLWU_P6                    | SPI1_SCK  |          |                 | TPM2_CH0       |      |                |      |      |
| 7                                 | PTA19                     | ADC0_SE5                  | ADC0_SE5                  | PTA19/<br>LLWU_P7                    | SPI1_PCS0 |          |                 | TPM2_CH1       |      |                |      |      |
| 8                                 | PSWITCH                   | PSWITCH                   | PSWITCH                   |                                      |           |          |                 |                |      |                |      |      |
| 9                                 | DCDC_CFG/<br>VDCDC_IN     | DCDC_CFG/<br>VDCDC_IN     | DCDC_CFG/<br>VDCDC_IN     |                                      |           |          |                 |                |      |                |      |      |
| 10                                | DCDC_LP                   | DCDC_LP                   | DCDC_LP                   |                                      |           |          |                 |                |      |                |      |      |
| 11                                | DCDC_GND                  | DCDC_GND                  | DCDC_GND                  |                                      |           |          |                 |                |      |                |      |      |
| 12                                | DCDC_LN                   | DCDC_LN                   | DCDC_LN                   |                                      |           |          |                 |                |      |                |      |      |
| 13                                | VDD_<br>1P8OUT            | VDD_<br>1P8OUT            | VDD_<br>1P8OUT            |                                      |           |          |                 |                |      |                |      |      |
| 14                                | DCDC_LN                   | DCDC_LN                   | DCDC_LN                   |                                      |           |          |                 |                |      |                |      |      |
| 15                                | VDD_<br>1P5OUT_<br>PM CIN | VDD_<br>1P5OUT_<br>PM CIN | VDD_<br>1P5OUT_<br>PM CIN |                                      |           |          |                 |                |      |                |      |      |
| 16                                | PTB0                      | DISABLED                  |                           | PTB0/<br>LLWU_P8/<br>RF_<br>RFOSC_EN |           | I2C0_SCL | CMP0_OUT        | TPM0_CH1       |      | CLKOUT         |      |      |
| 17                                | PTB1                      | ADC0_SE1/<br>CMP0_IN5     | ADC0_SE1/<br>CMP0_IN5     | PTB1/<br>RF_<br>PRIORITY             | DTM_RX    | I2C0_SDA | LPTMR0_<br>ALT1 | TPM0_CH2       |      | CMT_IRO        |      |      |
| 18                                | PTB2                      | ADC0_SE3/<br>CMP0_IN3     | ADC0_SE3/<br>CMP0_IN3     | PTB2/<br>RF_NOT_<br>ALLOWED          |           | DTM_TX   |                 | TPM1_CH0       |      |                |      |      |
| 19                                | PTB3                      | ADC0_SE2/<br>CMP0_IN4     | ADC0_SE2/<br>CMP0_IN4     | PTB3/<br>ERCLK32K                    |           |          | CLKOUT          | TPM1_CH1       |      | RTC_<br>CLKOUT |      |      |
| 20                                | VDD_0                     | VDD_0                     | VDD_0                     |                                      |           |          |                 |                |      |                |      |      |
| 21                                | PTB16                     | EXTAL32K                  | EXTAL32K                  | PTB16                                |           | I2C1_SCL |                 | TPM2_CH0       |      |                |      |      |
| 22                                | PTB17                     | XTAL32K                   | XTAL32K                   | PTB17                                |           | I2C1_SDA |                 | TPM2_CH1       |      | BSM_CLK        |      |      |
| 23                                | PTB18                     | NMI_b                     | ADC0_SE4/<br>CMP0_IN2     | PTB18                                |           | I2C1_SCL | TPM_<br>CLKIN0  | TPM0_CH0       |      | NMI_b          |      |      |
| 24                                | ADC0_DP0                  | ADC0_DP0/<br>CMP0_IN0     | ADC0_DP0/<br>CMP0_IN0     |                                      |           |          |                 |                |      |                |      |      |

## Pin Diagrams and Pin Assignments

| 48<br>"Wett<br>able"<br>HVQ<br>FN | Pin Name           | Default               | ALT0                  | ALT1                                     | ALT2          | ALT3            | ALT4              | ALT5          | ALT6 | ALT7          | ALT8      | ALT9          |
|-----------------------------------|--------------------|-----------------------|-----------------------|--|---------------|-----------------|-------------------|---------------|------|---------------|-----------|---------------|
| 25                                | ADC0_DM0           | ADC0_DM0/<br>CMP0_IN1 | ADC0_DM0/<br>CMP0_IN1 |  |               |                 |                   |               |      |               |           |               |
| 26                                | VREFL/<br>VSSA     | VREFL/<br>VSSA        | VREFL/<br>VSSA        |  |               |                 |                   |               |      |               |           |               |
| 27                                | VREFH/<br>VREF_OUT | VREFH/<br>VREF_OUT    | VREFH/<br>VREF_OUT    |  |               |                 |                   |               |      |               |           |               |
| 28                                | VDDA               | VDDA                  | VDDA                  |  |               |                 |                   |               |      |               |           |               |
| 29                                | XTAL_OUT           | XTAL_OUT              | XTAL_OUT              |  |               |                 |                   |               |      |               |           |               |
| 30                                | EXTAL              | EXTAL                 | EXTAL                 |  |               |                 |                   |               |      |               |           |               |
| 31                                | XTAL               | XTAL                  | XTAL                  |  |               |                 |                   |               |      |               |           |               |
| 32                                | VDD_RF3            | VDD_RF3               | VDD_RF3               |  |               |                 |                   |               |      |               |           |               |
| 33                                | ANT                | ANT                   | ANT                   |  |               |                 |                   |               |      |               |           |               |
| 34                                | GANT               | GANT                  | GANT                  |  |               |                 |                   |               |      |               |           |               |
| 35                                | VDD_RF2            | VDD_RF2               | VDD_RF2               |  |               |                 |                   |               |      |               |           |               |
| 36                                | VDD_RF1            | VDD_RF1               | VDD_RF1               |  |               |                 |                   |               |      |               |           |               |
| 37                                | PTC1               | DISABLED              |                       | PTC1/<br>RF_EARLY_<br>WARNING            |               | I2C0_SDA        | LPUART0_<br>RTS_b | TPM0_CH2      |      |               | SPI1_SCK  | BSM_CLK       |
| 38                                | PTC2               | DISABLED              |                       | PTC2/<br>LLWU_P10                        | TX_SWITCH     | I2C1_SCL        | LPUART0_<br>RX    | CMT_IRO       |      | DTM_RX        | SPI1_SOUT | BSM_<br>FRAME |
| 39                                | PTC3               | DISABLED              |                       | PTC3/<br>LLWU_P11                        | RX_<br>SWITCH | I2C1_SDA        | LPUART0_<br>TX    | TPM0_CH1      |      | DTM_TX        | SPI1_SIN  |               |
| 40                                | PTC4               | DISABLED              |                       | PTC4/<br>LLWU_P12/<br>BLE_RF_<br>ACTIVE  |               | EXTRG_IN        | LPUART0_<br>CTS_b | TPM1_CH0      |      | BSM_DATA      | SPI1_PCS0 |               |
| 41                                | PTC5               | DISABLED              |                       | PTC5/<br>LLWU_P13/<br>RF_NOT_<br>ALLOWED |               | LPTMR0_<br>ALT2 | LPUART0_<br>RTS_b | TPM1_CH1      |      | BSM_CLK       |           |               |
| 42                                | PTC6               | DISABLED              |                       | PTC6/<br>LLWU_P14/<br>RF_<br>RFOSC_EN    |               | I2C1_SCL        | LPUART0_<br>RX    | TPM2_CH0      |      | BSM_<br>FRAME |           |               |
| 43                                | PTC7               | DISABLED              |                       | PTC7/<br>LLWU_P15                        | SPI0_PCS2     | I2C1_SDA        | LPUART0_<br>TX    | TPM2_CH1      |      | BSM_DATA      |           |               |
| 44                                | VDD_1              | VDD_1                 | VDD_1                 |  |               |                 |                   |               |      |               |           |               |
| 45                                | PTC16              | DISABLED              |                       | PTC16/<br>LLWU_P0/<br>RF_STATUS          | SPI0_SCK      | I2C0_SDA        | LPUART0_<br>RTS_b | TPM0_CH3      |      |               |           |               |
| 46                                | PTC17              | DISABLED              |                       | PTC17/<br>LLWU_P1/<br>RF_EXT_<br>OSC_EN  | SPI0_SOUT     | I2C1_SCL        | LPUART0_<br>RX    | BSM_<br>FRAME |      | DTM_RX        |           |               |

## Pin Diagrams and Pin Assignments

| 48<br>"Wettable"<br>HVQFN | Pin Name | Default  | ALT0 | ALT1                                       | ALT2      | ALT3     | ALT4              | ALT5     | ALT6 | ALT7   | ALT8 | ALT9 |
|---------------------------|----------|----------|------|--|-----------|----------|-------------------|----------|------|--------|------|------|
| 47                        | PTC18    | DISABLED |      | PTC18/<br>LLWU_P2                          | SPI0_SIN  | I2C1_SDA | LPUART0_<br>TX    | BSM_DATA |      | DTM_TX |      |      |
| 48                        | PTC19    | DISABLED |      | PTC19/<br>LLWU_P3/<br>RF_EARLY_<br>WARNING | SPI0_PCS0 | I2C0_SCL | LPUART0_<br>CTS_b | BSM_CLK  |      |        |      |      |
| 49                        | Ground   | NA       |      |  |           |          |                   |          |      |        |      |      |

## 7.6 KW34A Pinouts

KW34A device pinouts are shown in the figure below.

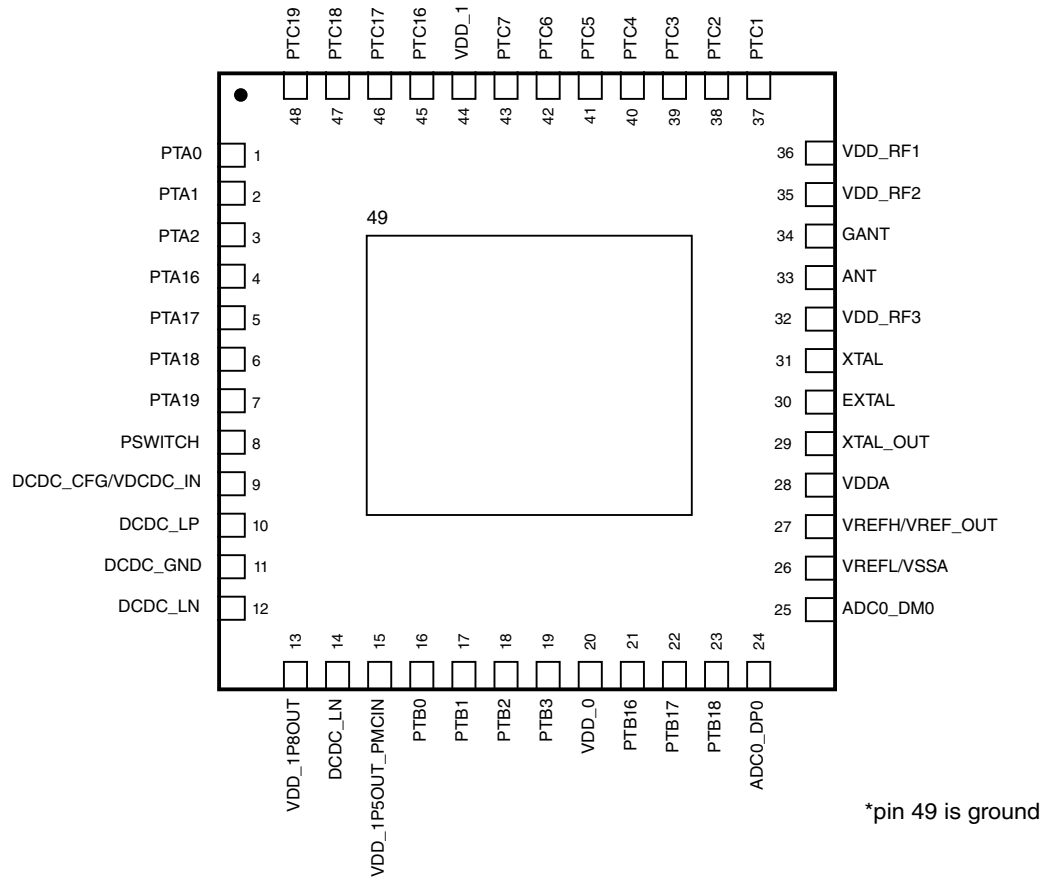


Figure 25. 48-pin "Wettable" HVQFN pinout diagram

## 7.7 Module Signal Description Tables

The following sections correlate the chip-level signal name with the signal name used in the chapter of the module. They also briefly describe the signal function and direction.

## 7.7.1 Core Modules

This section contains tables describing the core module signal descriptions.

**Table 47. SWD Module Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description                                      | I/O |
|-----------------|--------------------|--|-----|
| SWD_DIO         | SWD_DIO            | Serial Wire Debug Data Input/Output <sup>1</sup> | I/O |
| SWD_CLK         | SWD_CLK            | Serial Wire Clock <sup>2</sup>                   | I   |

1. Pulled up internally by default

2. Pulled down internally by default

## 7.7.2 Radio Modules

This section contains tables describing the radio signals.

**Table 48. Radio Module Signal Descriptions**

| Module Signal Name | Pin Direction | Pin Name         | Pin Description   |
|--------------------|---------------|------------------|---|
| ANT                | O             | ANT              | Antenna   |
| BLE_RF_ACTIVE      | O             | BLE_RF_ACTIVE    | An output which is asserted prior to any Radio event and remains asserted for the duration of the event.  |
| BSM_CLK            | O             | BSM_CLK          | Bit Streaming Mode (BSM) clock signal. 1 MHz bit rate clock. BSM_DATA and BSM_FRAME are synchronized to BSM_CLK. External device should capture BSM_FRAME and BSM_DATA on rising edge of BSM_CLK. |
| BSM_DATA           | O             | BSM_DATA         | Serial Bluetooth LE packet bit stream, LSB-first. Valid on rising edge of BSM_CLK.  |
| BSM_FRAME          | O             | BSM_FRAME        | Framing signal to indicate the start of reception. Active high.   |
| DTM_RX             | I             | DTM_RX           | Direct Test Mode Receive  |
| DTM_TX             | O             | DTM_TX           | Direct Test Mode Transmit   |
| GANT               | I             | GANT             | Antenna ground  |
| RF_STATUS          | O             | RF_STATUS        | An output which indicates when the Radio is in an Rx or Tx event; software can also control this signal directly.   |
| RF_PRIORITY        | O             | RF_PRIORITY      | An output which indicates to the external WiFi device that the Radio event is a high priority and it needs access to the 2.4 GHz antenna.   |
| RF_EARLY_WARNING   | O             | RF_EARLY_WARNING | Bluetooth LE LL generated signal which can be used to wake an external sensor to make a measurement before a Bluetooth LE event.  |
| RF_NOT_ALLOWED     | I             | RF_NOT_ALLOWED   | External signal which causes the internal Radio to cease radio activity.  |

*Table continues on the next page...*



**Table 48. Radio Module Signal Descriptions (continued)**

| Module Signal Name | Pin Direction | Pin Name   | Pin Description   |
|--------------------|---------------|------------|---|
| RF_TX_CONF         | I             | RF_TX_CONF | Signal from an external Radio which indicates the availability of the 2.4 GHz antenna to the internal Radio.<br><b>NOTE:</b> This is a GPIO, not a dedicated PIN. |
| RX_SWITCH          | O             | RX_SWITCH  | Front End Module receive mode signal.   |
| TX_SWITCH          | O             | TX_SWITCH  | Front End Module transmit mode signal.  |

**Table 49. Radio Module Miscellaneous Pin Descriptions**

| Pin Name      | Pad Direction | Pin Name      | Pin Description   |
|---------------|---------------|---------------|---|
| RF_INT_OSC_EN | I             | RF_RFOSC_EN   | External request to turn on the Radio's internal RF oscillator.   |
| RF_EXT_OSC_EN | O             | RF_EXT_OSC_EN | Internal request to turn on an External oscillator for use by the internal Radio. The request can also be from the SoC if it is using the RF oscillator as its clock. |

### 7.7.3 System Modules

This section contains tables describing the system signals.

**Table 50. System Module Signal Descriptions**

| SoC Signal Name  | Module Signal Name | Description  | I/O |
|------------------|--------------------|--|-----|
| NMI_b            | —                  | Non-maskable interrupt                             | I   |
| RESET_b          | —                  | Reset bidirectional signal                         | I/O |
| VDD_[1:0]        | VDD                | Power supply                                       | I   |
| Ground           | VSS                | Ground   | I   |
| VDD_RF[3:1]      | VDD_RF             | Radio power supply                                 | I   |
| VDCDC_IN         | VDCDC_IN           | VDCDC_IN   | I   |
| VDD_1P8OUT       | VDD_1P8            | DC-DC 1.8 V Regulated Output / Input in bypass     | I/O |
| VDD_1P5OUT_PMCIN | VDD_1P5/VDD_PMC    | DC-DC 1.5 V Regulated Output / PMC Input in bypass | I/O |
| PSWITCH          | PSWITCH            | DC-DC enable switch                                | I   |
| DCDC_CFG         | DCDC_CFG           | DC-DC switch mode select                           | I   |
| DCDC_LP          | DCDC_LP            | DC-DC inductor input positive                      | I/O |

*Table continues on the next page...*

**Table 50. System Module Signal Descriptions (continued)**

| SoC Signal Name | Module Signal Name | Description                   | I/O |
|-----------------|--------------------|-------------------------------|-----|
| DCDC_LN         | DCDC_LN            | DC-DC inductor input negative | I/O |
| DCDC_GND        | DCDC_GND           | DC-DC ground                  | I   |

**Table 51. LLWU Module Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description    | I/O |
|-----------------|--------------------|----------------|-----|
| LLWU_P[15:0]    | LLWU_P[15:0]       | Wake-up inputs | I   |

## 7.7.4 Clock Modules

This section contains tables for Clock signal descriptions.

**Table 52. Clock Module Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description                                    | I/O |
|-----------------|--------------------|--|-----|
| EXTAL           | EXTAL              | 26 MHz/32 MHz External clock/Oscillator input  | I   |
| XTAL            | XTAL               | 26 MHz/32 MHz Oscillator input                 | I   |
| XTAL_OUT        | XTAL_OUT           | 26 MHz/32 MHz Clock output                     | O   |
| XTAL_OUT_EN     | XTAL_OUT_ENABLE    | 26 MHz/32 MHz Clock output enable for XTAL_OUT | I   |
| EXTAL32K        | EXTAL32K           | 32 kHz External clock/Oscillator input         | I   |
| XTAL32K         | XTAL32K            | 32 kHz Oscillator input                        | I   |
| CLKOUT          | CLKOUT             | Internal clocks monitor                        | O   |

## 7.7.5 Analog Modules

This section contains tables for Analog signal descriptions.

**Table 53. ADC0 Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description                               | I/O |
|-----------------|--------------------|---|-----|
| ADC0_DM0        | DADM0              | ADC Channel 0 Differential Input Negative | I   |

*Table continues on the next page...*

**Table 53. ADC0 Signal Descriptions (continued)**

| SoC Signal Name | Module Signal Name | Description                               | I/O |
|-----------------|--------------------|---|-----|
| ADC0_DP0        | DADP0              | ADC Channel 0 Differential Input Positive | I   |
| ADC0_SE[5:1]    | AD[5:1]            | ADC Channel 0 Single-ended Input n        | I   |
| VREFH           | V <sub>REFSH</sub> | Voltage Reference Select High             | I   |
| VDDA            | V <sub>DDA</sub>   | Analog Power Supply                       | I   |
| VSSA            | V <sub>SSA</sub>   | Analog Ground                             | I   |

**Table 54. CMP0 Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description           | I/O |
|-----------------|--------------------|-----------------------|-----|
| CMP0_IN[5:0]    | IN[5:0]            | Analog voltage inputs | I   |
| CMP0_OUT        | CMP0               | Comparator output     | O   |

**Table 55. VREF Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description                                   | I/O |
|-----------------|--------------------|---|-----|
| VREF_OUT        | VREF_OUT           | Internally generated voltage reference output | O   |

## 7.7.6 Timer Modules

This section contains tables describing timer module signals.

**Table 56. TPM0 Module Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description    | I/O |
|-----------------|--------------------|----------------|-----|
| TPM_CLKIN[1:0]  | TPM_EXTCLK         | External clock | I   |
| TPM0_CH[3:0]    | TPM_CH[3:0]        | TPM channel    | I/O |

**Table 57. TPM1 Module Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description    | I/O |
|-----------------|--------------------|----------------|-----|
| TPM_CLKIN[1:0]  | TPM_EXTCLK         | External clock | I   |
| TPM1_CH[1:0]    | TPM_CH[1:0]        | TPM channel    | I/O |

**Table 58. TPM2 Module Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description    | I/O |
|-----------------|--------------------|----------------|-----|
| TPM_CLKIN[1:0]  | TPM_EXTCLK         | External clock | I   |
| TPM2_CH[1:0]    | TPM_CH[1:0]        | TPM channel    | I/O |

**Table 59. LPTMR0 Module Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description             | I/O |
|-----------------|--------------------|-------------------------|-----|
| LPTMR0_ALT[2:1] | LPTMR0_ALT[2:1]    | Pulse counter input pin | I   |

**Table 60. RTC Module Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description             | I/O |
|-----------------|--------------------|-------------------------|-----|
| RTC_CLKOUT      | RTC_CLKOUT         | 1 Hz square-wave output | O   |

## 7.7.7 Communication Interfaces

This section contains tables for the signal descriptions for the communication modules.

**Table 61. SPI0 Module Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description              | I/O |
|-----------------|--------------------|--------------------------|-----|
| SPI0_PCS0       | PCS0/SS            | Chip Select/Slave Select | I/O |
| SPI0_PCS[2:1]   | PCS[2:1]           | Chip Select              | O   |
| SPI0_SCK        | SCK                | Serial Clock             | I/O |
| SPI0_SIN        | SIN                | Data In                  | I   |
| SPI0_SOUT       | SOUT               | Data Out                 | O   |

**Table 62. SPI1 Module Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description              | I/O |
|-----------------|--------------------|--------------------------|-----|
| SPI1_PCS0       | SPI1_PCS0          | Chip Select/Slave Select | I/O |
| SPI1_SCK        | SCK                | Serial Clock             | I/O |
| SPI1_SIN        | SIN                | Data In                  | I   |
| SPI1_SOUT       | SOUT               | Data Out                 | O   |

**Table 63. I2C0 Module Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description           | I/O |
|-----------------|--------------------|-----------------------|-----|
| I2C0_SCL        | SCL                | I2C serial clock line | I/O |
| I2C0_SDA        | SDA                | I2C serial data line  | I/O |

**Table 64. I2C1 Module Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description           | I/O |
|-----------------|--------------------|-----------------------|-----|
| I2C1_SCL        | SCL                | I2C serial clock line | I/O |
| I2C1_SDA        | SDA                | I2C serial data line  | I/O |

**Table 65. CAN0 Signal Descriptions (KW36 only)**

| SoC Signal Name | Module Signal Name | Description      | I/O |
|-----------------|--------------------|------------------|-----|
| CAN0_RX         | CAN RX             | CAN Receive Pin  | I   |
| CAN0_TX         | CAN TX             | CAN Transmit Pin | O   |

**Table 66. LPUART0 Module Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description                | I/O |
|-----------------|--------------------|----------------------------|-----|
| LPUART0_CTS_b   | LPUART CTS         | Clear To Send              | I   |
| LPUART0_RTS_b   | LPUART RTS         | Request To Send            | O   |
| LPUART0_RX      | LPUART RxD         | Receive Data               | I   |
| LPUART0_TX      | LPUART TxD         | Transmit Data <sup>1</sup> | I/O |

1. This pin is normally an output, but is an input (tristated) in single wire mode whenever the transmitter is disabled or transmit direction is configured for receive data

**Table 67. LPUART1 Module Signal Descriptions (KW36 only)**

| SoC Signal Name | Module Signal Name | Description                | I/O |
|-----------------|--------------------|----------------------------|-----|
| LPUART1_CTS_b   | LPUART CTS         | Clear To Send              | I   |
| LPUART1_RTS_b   | LPUART RTS         | Request To Send            | O   |
| LPUART1_RX      | LPUART RxD         | Receive Data               | I   |
| LPUART1_TX      | LPUART TxD         | Transmit Data <sup>1</sup> | I/O |

1. This pin is normally an output, but is an input (tristated) in single wire mode whenever the transmitter is disabled or transmit direction is configured for receive data

## 7.7.8 Human-Machine Interfaces(HMI)

This section contains tables describing the HMI signals.

**Table 68. GPIO Module Signal Descriptions**

| SoC Signal Name | Module Signal Name | Description                      | I/O |
|-----------------|--------------------|----------------------------------|-----|
| PTA[19:16][2:0] | PORTA19-16, 2-0    | General Purpose Input/<br>Output | I/O |
| PTB[18:16][3:0] | PORTB18-16, 3-0    | General Purpose Input/<br>Output | I/O |
| PTC[19:16][7:1] | PORTC19-16, 7-1    | General Purpose Input/<br>Output | I/O |

## 8 Package Information

### 8.1 Obtaining package dimensions

Package dimensions are available in package drawings.

To find a package drawing, go to [nxp.com](http://nxp.com) and perform a keyword search for the document number of the drawing:

**Table 69. Packaging Dimensions**

| If you want the drawing for this package | Then use this document number |
|--|-------------------------------|
| 40-pin "Wettable" HVQFN (6x6)            | 98ASA01025D                   |
| 48-pin LQFN (7x7)                        | 98ASA00694D                   |
| 48-pin "Wettable" HVQFN (7x7)            | 98ASA01307D                   |

## 9 Part identification

### 9.1 Description

Part numbers for the chip have fields that identify the specific part. You can use the values of these fields to determine the specific part you have received.

## 9.2 Format

Part numbers for this device have the following format:

Q KW## A FFF R T PP CC N

## 9.3 Fields

This table lists the possible values for each field in the part number (not all combinations are valid):

**Table 70. Part number fields descriptions**

| Field | Description                 | Values   |
|-------|-----------------------------|--|
| Q     | Qualification status        | <ul style="list-style-type: none"> <li>M = Fully qualified, general market flow</li> <li>P = Prequalification</li> </ul>   |
| KW##  | Kinetis Wireless family     | <ul style="list-style-type: none"> <li>KW34</li> <li>KW35</li> <li>KW36</li> </ul>   |
| A     | Key attribute               | <ul style="list-style-type: none"> <li>A = Automotive Qualification</li> </ul>   |
| FFF   | Program flash memory size   | <ul style="list-style-type: none"> <li>512 = 512 KB</li> </ul>   |
| T     | Temperature range (°C)      | <ul style="list-style-type: none"> <li>V = -40 to 105</li> <li>C = -40 to 85</li> </ul>  |
| PP    | Package identifier          | <ul style="list-style-type: none"> <li>HT = 48 LQFN (7 mm x 7 mm)</li> <li>FP = 40 "Wettable" HVQFN (6 mm x 6 mm)</li> <li>FT = 48 "Wettable" HVQFN (7 mm x 7 mm)</li> </ul> |
| CC    | Maximum CPU frequency (MHz) | <ul style="list-style-type: none"> <li>4 = 48 MHz</li> </ul>   |
| N     | Packaging type              | <ul style="list-style-type: none"> <li>(Blank) = Tray</li> <li>R = Tape and reel</li> </ul>  |

## 9.4 Example

This is an example part number:

MKW36A512VFT4

## 10 Revision History

**Table 71. Revision History**

| Rev. No. | Date    | Substantial Changes  |
|----------|---------|--|
| Rev 8    | 05/2020 | <ul style="list-style-type: none"> <li>• Updated Tx output power to 5 dBm from 3.5 dBm throughout. Also preceded 5 dBm with a plus "+" sign.</li> <li>• Replaced VDD_XTAL with VDD_RF3.</li> <li>• Appended the second row 'Supply current Rx On with DC-DC converter enable' with the following text: <b>VDD_1P5_buck=1.5 V</b> in <a href="#">Receiver Feature Summary</a>.</li> <li>• In Top level Transmitter Specifications - <a href="#">Table 5</a> : <ul style="list-style-type: none"> <li>• Appended the rows for supply current Tx On with P<sub>RF</sub> and DC-DC converter enabled for 0 dBm with <b>VDD_1P5_buck=1.5 V</b>.</li> <li>• Added rows related to supply current Tx On with PRF = +3.5 dBm and 5dBm along with associated footnotes.</li> <li>• Updated symbol of Output RF Frequency to f<sub>RFout</sub> from f<sub>in</sub>.</li> <li>• Added row for maximum RF Output Power; LDO-HF bumped along with an associated footnote.</li> </ul> </li> <li>• Added <a href="#">Figure 5</a>.</li> <li>• Added <a href="#">Table 7</a>. Also modified title of <a href="#">Table 6</a>.</li> <li>• Added VDD_1P5 specification in <a href="#">Voltage and current operating requirements</a>.</li> <li>• Added VPOR_VDD_1P5 specification in <a href="#">LVD and POR operating requirements</a></li> <li>• Added V<sub>OH</sub> performance for normal drive pad at 1.71 V ≤ V<sub>DD</sub> ≤ 2.7 V, I<sub>OH</sub> = -1 mA in <a href="#">Voltage and current operating behaviors</a>.</li> <li>• Added <a href="#">Table 17</a>. Also updated title of <a href="#">Table 16</a>.</li> <li>• Updated V<sub>CDM</sub> ratings in <a href="#">ESD handling ratings</a>.</li> <li>• Added VDD_1P5 symbol to "Bypass Mode Supply Voltage (RF and Analog)" in <a href="#">Table 41</a>.</li> <li>• In <a href="#">Table 42</a> : <ul style="list-style-type: none"> <li>• Updated specifications of <b>DC-DC Converter Output Power</b>. Added conditions, V<sub>DCDC_IN</sub> above 2.7 V and below 2.7 V.</li> <li>• Updated specifications of <b>1.8 V Output Current</b>.</li> <li>• Updated minimum value to 1.45 V in "1.5 V Voltage Output" for P<sub>out</sub>≤+3.5 dBm. Updated the corresponding footnote with the correct value of 1.45 V.</li> <li>• Added a separate row for "1.5 V Voltage Output" for P<sub>out</sub>=+5 dBm along with a footnote.</li> <li>• Updated maximum value of <b>1.5 V Output Current</b> to 45.</li> </ul> </li> </ul> |
| Rev 7    | 09/2019 | <ul style="list-style-type: none"> <li>• Removed flash access control feature from <a href="#">Security Features</a>.</li> <li>• Added the following footnote to <a href="#">Table 14</a> : "The device was configured in buck mode auto-start to perform the measurements. The DCDC_IN was powered with 3.0 V. VDD_1P8OUT was configured to output 1.8 V and VDD_1P5OUT_PMCIN was configured to output 1.5 V."</li> <li>• Added the following footnote to VLPS, LLSx and VLLSx modes: "DCDC configured in pulsed mode." in <a href="#">Table 14</a>.</li> <li>• Added thermal attributes for 48-pin "Wettable" HVQFN package, and replaced standard JESD51-2 with JESD51-2A in the footnotes in <a href="#">Thermal attributes</a>.</li> <li>• Removed "Flash timing specifications – program and erase" and "Flash high voltage current behaviors" tables.</li> <li>• Added <i>DCDC internal oscillator</i> row in <a href="#">Table 41</a>.</li> <li>• Updated <a href="#">Table 42</a> as follows: <ul style="list-style-type: none"> <li>• In <i>Switching Frequency</i> row, updated the Typical value to <i>DCDC reference frequency divided by 16</i> and added the following footnote to it: "DCDC reference frequency is derived from the RF oscillator or the DCDC internal oscillator".</li> <li>• Added <i>VDD_1P8 ripple</i> and <i>VDD_1P5 ripple</i> rows.</li> </ul> </li> </ul>  |

Table continues on the next page...



Table 71. Revision History (continued)

| Rev. No.      | Date    | Substantial Changes  |
|---------------|---------|--|
|               |         | <ul style="list-style-type: none"> <li>Updated introductory text beginning "The Port Control and Interrupt Module is used to select the functionality for...." in <a href="#">KW36A Signal Multiplexing and Pin Assignments</a>. Same update done for KW35A and KW34A as well.</li> <li>Updated "DEFAULT" column to correct "DISABLED" status of PTA19, PTB1/2/3 pin names in KW36/35/34 pinouts.</li> </ul>   |
| Rev 7 Draft B | 04/2019 | <ul style="list-style-type: none"> <li>Added "Top Line Marking" column to the Orderable parts details table.</li> <li>Removed "Galois counter mode (AES-GCM)" and "DES modes" features of LTC from <a href="#">Security Features</a>.</li> <li>Removed "Logic Input Voltage Low/High" rows from <a href="#">Table 2</a>.</li> <li>Removed the following footnote from <a href="#">Table 13</a> : "Supported through the connectivity software in its pre-defined Deep Sleep Modes."</li> <li>Updated Typical value of I<sub>DD_RUN</sub> at 70 °C to 5.92 in <a href="#">Table 14</a>.</li> <li>Added "48-pin Wettable HVQFN" column to <a href="#">Thermal attributes</a>.</li> <li>Corrected name of V<sub>ec_xtal32</sub> to V<sub>ec_extal32</sub> in <a href="#">32 kHz Oscillator Frequency Specifications</a>.</li> <li>Updated minimum and maximum values of "1.5V Output Voltage" in <a href="#">Table 42</a>. Also specified the condition as "Consumed by radio".</li> <li>Corrected location of ground pins in 48-pin LQFN pinout diagram - <a href="#">Figure 21</a>.</li> <li>Removed CAN0 and LPUART1 references from <a href="#">KW34A Signal Multiplexing and Pin Assignments</a>.</li> </ul> |
| Rev 7 Draft A | 11/2018 | <ul style="list-style-type: none"> <li>Added following part numbers: MKW36A512VFT4, MKW35A512VFT4, and MKW34A512VFT4</li> <li>Added 48 "Wettable" QFN package details including pin diagrams and assignments.</li> <li>Changed 40-pin "Wettable" QFN and 48-pin "Wettable" QFN to 40-pin "Wettable" HVQFN and 48-pin "Wettable" HVQFN throughout.</li> <li>Applied new NXP Brand Guidelines for Bluetooth Low Energy. Removed references of BLE and replaced with Bluetooth LE.</li> <li>Added the following footnote in <a href="#">Table 6</a> : "TX continuous wave power output at the RF pins with the recommended matching components mounted on PCB."</li> <li>Corrected maximum value of VDD_1P8 output in the footnote 6, in <a href="#">Table 42</a>. DC-DC Converter Specifications, from 3 V to 3.5 V.</li> <li>Removed silicon revision (R) field from <a href="#">Table 68</a>. Part number fields descriptions.</li> </ul>  |
| Rev 6         | 09/2018 | <ul style="list-style-type: none"> <li>Changed ARM to Arm and applied registered trademark to Cortex on first instance.</li> <li>Updated Related Resources table for Web release.</li> <li>Updated Introduction section to remove industrial details.</li> <li>Added space between value and unit throughout.</li> <li>Removed SPI Clock Rate row from <a href="#">Radio Operating Conditions</a>.</li> <li>Added figure title to Figure 3 in the topic <a href="#">Transmit and PLL Feature Summary</a>.</li> <li>Updated max values of IDD_STOP, IDD_LLS3/LLS2, IDD_VLLS0 (POR PO = ) in <a href="#">Table 13</a></li> <li>Updated <a href="#">Table 25</a> and <a href="#">Table 26</a>.</li> <li>Updated <a href="#">Table 27</a> - Flash command timing specifications.</li> <li>Updated <a href="#">Table 28</a> - NVM reliability specifications.</li> <li>Backpage was also updated.</li> </ul>  |
| Rev 5         | 07/2018 | <ul style="list-style-type: none"> <li>Updated title of the document to 'MKW36A/35A Data Sheet' from 'MKW35A/36A Data Sheet'.</li> <li>Updated SoC name KW35A with KW36A/35A throughout.</li> <li>Replaced QFN with "Wettable" QFN throughout</li> <li>Added package drawings on front page and updated features under Multi-Standard Radio section as follows: Modulation index: added 1.0 to the list.</li> <li>Updated Typical Rx Current and Typical Tx current values to 6.3 mA and 5.7 mA respectively.</li> <li>Updated Low Power Mode (VLLS0) Current value to 258 nA from 182 nA.</li> <li>Replaced column name "Tier" with "Qualification" in <a href="#">this table</a>.</li> </ul>   |

Table continues on the next page...

**Table 71. Revision History (continued)**

| Rev. No. | Date    | Substantial Changes  |
|----------|---------|--|
|          |         | <ul style="list-style-type: none"> <li>• Updated <a href="#">Introduction</a> section.</li> <li>• Removed Radio version number "V2.1" from <a href="#">Block Diagram</a>.</li> <li>• Updated <a href="#">Radio features</a>, <a href="#">Microcontroller features</a>, and <a href="#">System features</a>.</li> <li>• Appended "(Zero IF)" to Direct Conversion Receiver in <a href="#">Transceiver Description</a>.</li> <li>• Edited <a href="#">Key Specifications</a>.</li> <li>• Updated Receiver Sensitivity to –99 from –100 dBm in <a href="#">Radio features</a>. Also added support of 1 Mbps PHY to BLE link Layer hardware.</li> <li>• Updated typical and minimum values in <a href="#">Table 3</a>. Also updated footnote 7 to "BLE adjacent and alternate selectivity performance is measured with modulated interference signals."</li> <li>• In <a href="#">Table 4</a> :             <ul style="list-style-type: none"> <li>• updated and added receiver specifications with GFSK modulations, and</li> <li>• updated footnote as follows: "Selectivity measured with an unmodulated blocker except for GFSK BT=0.5, h=0.5 1mbps and GFSK BT=0.5, h=0.32 1mbps. The desired signal is set at –85 dBm."</li> </ul> </li> <li>• Updated typical and maximum values in <a href="#">Table 5</a>. Also updated footnote for TXH2 and TXH3 symbols as follows: "Harmonic Levels based on recommended 2 component match. Transmit harmonic levels depend on the quality of matching components. Additional harmonic margin using a 3<sup>rd</sup> matching component (1x shunt capacitor) is possible."</li> <li>• Updated typical and maximum values in <a href="#">Table 13</a> and <a href="#">Table 14</a>.</li> <li>• Updated typical values in <a href="#">Table 16</a>. Also added specifications of STOP and RUN modes of radio state Tx (at +3.5 dBm).</li> <li>• Updated 48-pin LQFN and 40-pin QFN values in <a href="#">Thermal attributes</a> table. Removed thermal metrics and kept thermal attributes <math>R_{\theta JA}</math> and <math>\Psi_{JT}</math>. Also updated notes and added information about how to use the thermal characterization parameter, <math>\Psi_{JT}</math>.</li> <li>• Added following text in <a href="#">Reference Oscillator Specification</a> : "The table below shows the recommended crystal specifications. Note that these are recommendations.....". Also updated 32M/26M typical values of Oscillator Startup Time to 500 <math>\mu</math>s.</li> <li>• Updated typical and maximum values in <a href="#">Table 1</a></li> <li>• Updated minimum, typical and maximum value of Temp sensor slope in <a href="#">Table 30</a></li> <li>• Updated <a href="#">Table 1</a>.</li> <li>• Added a footnote under Buck Mode Supply Voltage in <a href="#">Table 41</a>.</li> <li>• Corrected spec name of Buck mode in DC-DC configuration to <math>V_{DCDC\_IN}</math> from <math>VDD_{DCDC\_IN}</math> throughout.</li> <li>• In <a href="#">Table 42</a>,             <ul style="list-style-type: none"> <li>• added a footnote for maximum value of DC-DC Converter Output Power,</li> <li>• updated footnote example corresponding to '1.8V Output Voltage',</li> <li>• updated maximum value in '1.8V Output Voltage' from "min(VDCDC_IN_buck, 3)" to "min(VDCDC_IN_buck, 3.5)",</li> <li>• added <math>VDD\_1P8 = 1.8V</math> and <math>VDD\_1P5 = 1.5V</math> conditions in 1.8V Output Current, and</li> <li>• added the following information to the footnote corresponding to '1.5V Output Voltage': "<math>VDD\_1P5</math> must not be programmed higher than <math>VDD\_1P8</math>."</li> </ul> </li> <li>• Added <math>V_{IO\_DCDC}</math> row in <a href="#">Voltage and current operating ratings</a>.</li> <li>• Removed 48-pin LQFN pinout diagram and signal names from <a href="#">KW35A Signal Multiplexing and Pin Assignments</a>. Also updated signal name at pin 17 and pin 19 of 40 "Wettable" QFN and 48 LQFN in ALT1 functionality to PTB3/ERCLK32K in <a href="#">KW36A Signal Multiplexing and Pin Assignments</a> and <a href="#">KW35A Signal Multiplexing and Pin Assignments</a>.</li> </ul> |
| Rev 4    | 10/2017 | <ul style="list-style-type: none"> <li>• BLE version 4.2 updated to 5.0.</li> <li>• Updated maximum value of voltage range to 3.6 V.</li> <li>• Updated Generic FSK modulation BT and receiver sensitivity from –100 dBm to –99 dBm.</li> <li>• Added support of up to 26 devices by Whitelist and 8 private resolvable addresses in hardware in the section <a href="#">Radio features</a>.</li> <li>• Updated number of GPIO digital pins in the 48-pin package to 25 in <a href="#">Peripheral features</a>.</li> </ul>   |

Table continues on the next page...

Table 71. Revision History (continued)

| Rev. No. | Date    | Substantial Changes   |
|----------|---------|---|
|          |         | <ul style="list-style-type: none"> <li>Updated note text in <a href="#">Radio operating conditions</a> as follows: "The recommended crystal accuracy is <math>\pm 40</math> ppm including initial accuracy, mechanical, temperature and aging factors."</li> <li>Updated maximum values in <a href="#">Power mode transition operating behaviors</a>.</li> <li>Updated Typical values in <a href="#">Table 13</a> and <a href="#">Table 14</a>. Also added the following note to the tables for Run mode: "Radio is off".</li> <li>Minor updates in introductory text of <a href="#">Reference Oscillator Specification</a> section. Also updated typical value of <math>T_{OSC}</math> to 680 <math>\mu s</math> in .</li> <li>Added <a href="#">32 kHz Oscillator Frequency Specifications</a> section.</li> <li>Updated <a href="#">Table 42</a> section. <ul style="list-style-type: none"> <li>Added the following parameters: Switching Frequency, Half FET Threshold, Double FET Threshold, DC-DC Conversion Efficiency, DCDC Settling Time for increasing voltage and DCDC Settling Time for decreasing voltage.</li> <li>Updated Typ. value of the 'DCDC Turn on Time' parameter and added a footnote.</li> </ul> </li> </ul>  |
| Rev 3    | 06/2017 | Updated Typical values in <a href="#">Table 13</a> and <a href="#">Table 14</a> .   |
| Rev 2    | 03/2017 | <ul style="list-style-type: none"> <li>Modified structure of the document to include orderable part numbers and Related Resources table after the features list.</li> <li>Specified all supported part numbers on the front page.</li> <li>Specified the baudrate supported by FlexCAN in the features list.</li> <li>Updated value of minimum input voltage to 1.71 V and output voltage to 1.8 V from 2.7 V. Also updated minimum voltage value in DCDC buck mode to 2.1 V from 2.7 V.</li> <li>Changed RSSI Range maximum value to 5 dBm in <a href="#">Table 3</a> and added the following footnote: "With RSSI_CTRL_0.RSSI_ADJ field calibrated to account for antenna to RF input losses."</li> <li>Added <a href="#">Table 6</a> to show mapping relationship between TX_POWER and DBM. Also added the corresponding graph.</li> <li>Added DCDC Inductor specifications in <a href="#">Table 41</a>.</li> <li>Updated <a href="#">Table 42</a> : <ul style="list-style-type: none"> <li>Removed repetitive fields from the table.</li> <li>Specified Typ. value of "DCDC Transition Operating Behavior" as 50 <math>\mu s</math>.</li> <li>Updated footnote 3 as follows: "In Buck mode, the maximum VDD_1P8 output is the minimum of either VDCDC_IN_BUCK minus 50 mV or 3 V. For example, if VDCDC_IN = 1.85 V, maximum VDD_1P8 is 1.8 V. If VDCDC_IN = 4.2 V, maximum VDD_1P8 is 3 V."</li> </ul> </li> <li>Replaced Laminate QFN with LQFN throughout.</li> <li>Added radio signals in <a href="#">Table 48</a>.</li> <li>Added document numbers of the supported package drawings in <a href="#">Table 69</a>.</li> <li>Added <a href="#">Part identification</a> section.</li> </ul> |
| Rev 1    | 01/2017 | <ul style="list-style-type: none"> <li>Updated maximum supply voltage from 4.2 to 4.25 V.</li> <li>Corrected MBAN Channel numbering in <a href="#">Channel Plan for Bluetooth Low Energy</a>.</li> <li>Corrected "Radio" description for VLLS1 and VLLS0 power modes in <a href="#">Table 8</a>.</li> <li>Updated <a href="#">Section 9 Pin Diagrams and Pin Assignments</a>. <ul style="list-style-type: none"> <li>Corrected pin name from VDD_1P45OUT_PMCIN to VDD_1P5OUT_PMCIN</li> <li>Added ground pads in the pin diagrams</li> </ul> </li> <li>Put Typ. values as TBDs in <a href="#">Table 14</a>, Power consumption operating behaviors - Buck Mode.</li> <li>Added the following note in <a href="#">Diagram: Typical IDD_RUN operating behavior</a> : "The results in the following graphs are obtained using the device in Bypass mode."</li> <li>Put Typ. values as TBDs in <a href="#">Table 16</a>, SoC Power Consumption.</li> <li>Added <math>T_{OSC}</math> row in , Reference Crystal Specification.</li> <li>Added DCDC Transition Operating Behavior and DCDC Turn on Time in <a href="#">Table 42</a>, DC-DC Converter Specifications.</li> <li>Added the following note in <a href="#">Table 48</a> for the RF_TX_CONF pin: "This is a GPIO, not a dedicated PIN."</li> </ul>   |

Table continues on the next page...

Revision History

**Table 71. Revision History (continued)**

| Rev. No. | Date    | Substantial Changes      |
|----------|---------|--------------------------|
| Rev 0    | 11/2016 | Initial Internal Release |

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